

DAQ

NI-DAQ™ User Manual for PC Compatibles

Version 6.0

Data Acquisition Software for the PC

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About This Manual

How to Use the NI-DAQ Documentation Set	xiii
Organization of This Manual	xiii
Conventions Used in This Manual.....	xiv
MIO and AI Device Terminology	xvii
National Instruments Documentation	xix
Related Documentation.....	xx
Customer Communication	xx

Chapter 1 Introduction to NI-DAQ

About the NI-DAQ Software for PC Compatibles	1-1
How to Set up Your DAQ System.....	1-2
NI-DAQ Overview	1-4
NI-DAQ Hardware Support	1-4
NI-DAQ Language Support	1-6
Device Configuration.....	1-6
Configuring PC Cards (PCMCIA)	1-7
Configuring PC Cards for Windows NT 4.0.....	1-7
Configuring PC Cards for Windows 95	1-8
Configuring Parallel Port DAQ Devices	1-8
Configuring Plug and Play Devices	1-8
Configuring Plug and Play Devices in Windows NT 4.0	1-9
ISA Devices	1-9
PCI/PXI Devices.....	1-9
Configuring Plug and Play Devices in Windows 95.....	1-10
Configuring Non-Plug and Play Devices on ISA (PC AT/XT) or EISA Computers.....	1-11
Using the NI-DAQ Configuration Utility.....	1-11

Chapter 2 Fundamentals of Building Windows Applications

The NI-DAQ Libraries	2-1
Creating a Windows Application Using Borland C++	2-2
Example Programs	2-2
Special Considerations	2-3
Buffer Allocation	2-3
String Passing	2-3
Parameter Passing	2-3
Creating a Windows Application Using Microsoft Visual C++	2-3
Example Programs	2-5
Creating a Windows Application Using Microsoft Visual Basic	2-5
Example Programs	2-6
Special Considerations	2-6
Buffer Allocation	2-6
String Passing	2-7
Parameter Passing	2-7
Using Borland Delphi with NI-DAQ	2-7
NI-DAQ Examples	2-8

Chapter 3 Software Overview

Initialization and General-Configuration Functions	3-2
Software-Calibration and Device-Specific Functions	3-3
Event Message Functions	3-5
Event Messaging Application Hints	3-5
NI-DAQ Events in Visual Basic for Windows	3-6
Visual Basic Custom Controls	3-6
General DAQ Event	3-7
Analog Trigger Event	3-10
Analog Alarm Event	3-11
Using Multiple Controls	3-13
General DAQ Event Example	3-14
Analog Input Function Group	3-16
One-Shot Analog Input Functions	3-16
Single-Channel Analog Input Functions	3-16
Single-Channel Analog Input Application Hints	3-18
Data Acquisition Functions	3-21
High-Level Data Acquisition Functions	3-21
Low-Level Data Acquisition Functions	3-23
Low-Level Double-Buffered Data Acquisition Functions	3-25
Data Acquisition Application Hints	3-26

Lab and 1200 Device Counter/Timer Signals	3-26
DAQCard-500/700, 516 Device, and LPM Device	
Counter/Timer Signals.....	3-26
External Multiplexer Support (AMUX-64T)	3-26
Basic Building Blocks	3-27
Building Block 1: Configuration	3-27
Building Block 2: Start.....	3-29
Building Block 3: Checking	3-32
Building Block 4: Cleaning up	3-33
Double-Buffered Data Acquisition.....	3-33
Multirate Scanning.....	3-34
Analog Output Function Group	3-37
One-Shot Analog Output Functions	3-37
Analog Output Application Hints	3-38
Simple Analog Output Application	3-39
Analog Output with Software Update Application	3-39
Waveform Generation Functions	3-41
High-Level Waveform Generation Functions.....	3-41
Low-Level Waveform Generation Functions	3-41
Waveform Generation Application Hints	3-43
Basic Waveform Generation Applications	3-43
Staging-Based Arbitrary Waveform Generation	
(For DAQArb 5411 Devices Only).....	3-51
Reference Voltages for Analog Output Devices	3-54
Minimum Update Intervals.....	3-55
AT-MIO-16F-5 Notes on DMA Waveform Generation ...	3-55
Counter Usage	3-57
Restrictions on Delay Rate Use on the AT-MIO-16X	
and AT-MIO-64F-5	3-58
FIFO Lag Effect on the MIO, E Series, AT-AO-6/10,	
AT-MIO-16X, AT-MIO-64F-5, PCI-4451, and	
PCI-4551	3-58
Externally Triggering Your Waveform Generation	
Operation	3-59
Digital I/O Function Group.....	3-59
DIO-24, AT-MIO-16D, AT-MIO-16DE-10, DIO-96, and	
Lab and 1200 Device Groups	3-62
DIO-32F and DIO 6533 (DIO-32HS) Device Groups	3-62
Digital I/O Functions	3-63
Group Digital I/O Functions.....	3-64
Double-Buffered Digital I/O Functions.....	3-65
Digital I/O Application Hints	3-66
Handshaking Versus No-Handshaking Digital I/O.....	3-66

Digital Port I/O Applications.....	3-66
Digital Line I/O Applications	3-68
Digital Group I/O Applications.....	3-70
Digital Group Block I/O Applications.....	3-71
Digital Double-Buffered Group Block I/O Applications.....	3-73
Pattern Generation I/O with the DIO-32F and DIO 6533 (DIO-32HS)	
Devices.....	3-76
Double-Buffered I/O.....	3-77
The Counter/Timer Function Group.....	3-78
Device Support for the Counter/Timer and Interval Counter/Timer	
Functions.....	3-78
Counter/Timer Functions.....	3-79
Counter/Timer Operation for the CTR Functions	3-80
Programmable Frequency Output Operation.....	3-83
Counter/Timer Application Hints.....	3-84
Event-Counting Applications.....	3-88
Period and Continuous Pulse-Width Measurement	
Applications.....	3-91
The Interval Counter/Timer Functions	3-93
Interval Counter/Timer Operation for the ICTR Functions.....	3-93
Interval Counter/Timer Application Hints	3-94
The General-Purpose Counter/Timer Functions.....	3-94
The General-Purpose Counter/Timer Application Hints.....	3-95
The RTSI Bus Trigger Functions	3-95
The RTSI Bus.....	3-96
MIO-16/16D RTSI Connections.....	3-97
MIO-F-5/16X RTSI Connections	3-98
E Series, DSA, and DAQArb RTSI Connections	3-99
AT-AO-6/10 RTSI Connections	3-99
DIO-32F RTSI Connections	3-100
DIO 6533 (DIO-32HS) RTSI Connections.....	3-100
RTSI Bus Application Hints	3-102
The SCXI Functions.....	3-103
SCXI Application Hints.....	3-107
Building Analog Input Applications in Multiplexed Mode.....	3-108
Building Analog Input Applications in Parallel Mode.....	3-115
SCXI Data Acquisition Rates	3-119
Analog Output Applications	3-121
Digital Applications	3-122
The Transducer Conversion Functions.....	3-122
Transducer Conversion Function Descriptions.....	3-124
RTD_Convert	3-124
RTD_Buf_Convert	3-124

Strain_Convert	3-126
Strain_Buf_Convert	3-126
Thermistor_Convert	3-129
Thermistor_Buf_Convert	3-129
Thermocouple_Convert	3-131
Thermocouple_Buf_Convert	3-131

Chapter 4

DMA and Programmed I/O Performance Limitations

Explanation of Programmed I/O and DMA Transfers	4-1
Programmed I/O or DMA	4-2
Using DMA on AT Bus Computers	4-2
Page Boundaries in AT Bus Computers	4-2
Using Physical Memory above 16 MB on ISA Bus Computers	4-3
General Windows Performance Considerations	4-4
Programmed I/O Performance in Windows	4-5
DMA Performance in Windows	4-5
Buffers Requiring Reprogramming	4-5
Why Reprogramming Limits Performance	4-5
Results of Performance Limitation	4-6
Methods for Eliminating Performance Limitations	4-6

Chapter 5

NI-DAQ Double Buffering

Overview	5-1
Single-Buffered Versus Double-Buffered Data	5-1
Double-Buffered Input Operations	5-2
Potential Setbacks	5-4
Double-Buffered Output Operations	5-6
Potential Setbacks	5-7
Double-Buffered Functions	5-9
DB_Config Functions	5-10
DB_Transfer Functions	5-10
DB_HalfReady Functions	5-11
Conclusion	5-12

Customer Communication

Glossary

Index

Figures

Figure 1-1.	How to Set up Your DAQ System	1-3
Figure 3-1.	Single-Point Analog Reading with Onboard Conversion Timing.....	3-20
Figure 3-2.	Single-Point Analog Reading with External Conversion Timing	3-21
Figure 3-3.	Buffered Data Acquisition Basic Building Blocks.....	3-27
Figure 3-4.	Buffered Data Acquisition Application Building Block 1, Configuration.....	3-28
Figure 3-5.	Buffered Data Acquisition Application Building Block 2, Start, for the MIO and AI Devices	3-30
Figure 3-6.	Buffered Data Acquisition Application Building Block 2, Start, for the 516 Devices, DAQCard-500/700, Lab and 1200 Devices, and LPM Devices	3-31
Figure 3-7.	Buffered Data Acquisition Application Building Block 3, Checking, for the MIO, AI, and DSA Devices.....	3-32
Figure 3-8.	Buffered Data Acquisition Application Building Block 3, Checking, for the 516 Devices, DAQCard-500/700, Lab and 1200 Devices, and LPM Devices	3-32
Figure 3-9.	Double-Buffered Data Acquisition Application Building Block 3, Checking.....	3-34
Figure 3-10.	Multirate Scanning	3-36
Figure 3-11.	Equivalent Analog Output Calls.....	3-38
Figure 3-12.	Simple Analog Output Application.....	3-39
Figure 3-13.	Analog Output with Software Updates	3-40
Figure 3-14.	Basic Waveform Generation Application	3-45
Figure 3-15.	Waveform Generation with Pauses	3-48
Figure 3-16.	Double-Buffered Waveform Generation.....	3-50
Figure 3-17.	Staging-Based Waveform Generation.....	3-53
Figure 3-18.	Basic Port Input or Output Application with Handshaking	3-67
Figure 3-19.	Basic Port Input or Output Application without Handshaking	3-68
Figure 3-20.	Basic Line Input or Output Application	3-69
Figure 3-21.	Simple Digital Group Input or Output Application.....	3-70
Figure 3-22.	Digital Block Input or Output Application.....	3-72
Figure 3-23.	Double-Buffered Block Operation	3-74
Figure 3-24.	Counter Block Diagram.....	3-80
Figure 3-25.	Counter Timing and Output Types.....	3-83
Figure 3-26.	Event Counting	3-84
Figure 3-27.	Pulse Generation.....	3-85
Figure 3-28.	Simultaneous Counter Operation	3-87
Figure 3-29.	Timer Event Counting	3-88
Figure 3-30.	Pulse-Width Measurement	3-89
Figure 3-31.	Frequency Measurement	3-90
Figure 3-32.	Continuous Period Measurement	3-92

Figure 3-33.	Interval Counter Block Diagram.....	3-94
Figure 3-34.	Basic RTSI Application Calls.....	3-102
Figure 3-35.	General SCXibus Application	3-107
Figure 3-36.	Single-Channel or Software-Scanning Operation Using the SCXI-1100, SCXI-1102/B/C, VXI-SC-1102/B/C, SCXI-1120/D, SCXI-1121, SCXI-1122, or SCXI-1141 in Multiplexed Mode.....	3-109
Figure 3-37.	Single-Channel or Software-Scanning Operation Using the SCXI-1140 in Multiplexed Mode	3-111
Figure 3-38.	Channel-Scanning Operation Using Modules in Multiplexed Mode	3-113
Figure 3-39.	Single-Channel or Software-Scanning Operation Using the SCXI-1140 in Parallel Mode	3-117
Figure 3-40.	Channel-Scanning Operation Using the SCXI-1140 in Parallel Mode.....	3-118
Figure 3-41.	Strain Gauge Bridge Configuration	3-128
Figure 3-42.	Circuit Diagram of a Thermistor in a Voltage Divider.....	3-131
Figure 5-1.	Double-Buffered Input with Sequential Data Transfers	5-3
Figure 5-2.	Double-Buffered Input with an Overwrite Before Copy	5-4
Figure 5-3.	Double-Buffered Input with an Overwrite.....	5-5
Figure 5-4.	Double-Buffered Output with Sequential Data Transfers	5-6
Figure 5-5.	Double-Buffered Output with an Overwrite Before Copy	5-8
Figure 5-6.	Double-Buffered Output with an Overwrite.....	5-9

Tables

Table 1.	MIO and AI Device Classifications.....	xvii
Table 1-1.	NI-DAQ Version 6.0 Internal Device Hardware for AT, PC, and NEC Buses	1-4
Table 1-2.	NI-DAQ Version 6.0 Internal Device Hardware for PCMCIA, PCI, PXI, and VXI Buses	1-5
Table 1-3.	NI-DAQ Version 6.0 External Device Hardware	1-5
Table 3-1.	General DAQ Event Control Properties	3-8
Table 3-2.	Analog Trigger Event Control Properties.....	3-10
Table 3-3.	Analog Alarm Event Control Properties.....	3-12
Table 3-4.	Output Voltages with Unipolar Output Polarity	3-54
Table 3-5.	Output Voltages with Bipolar Output Polarity	3-54
Table 3-6.	Byte Mapping to Digital I/O Lines	3-60
Table 3-7.	Legal Group Assignments for DIO-32F Devices	3-63
Table 3-8.	MIO-16/16D RTSI Bus Signals.....	3-97
Table 3-9.	MIO-F-5/16X RTSI Bus Signals	3-98
Table 3-10.	MIO-16/16D RTSI Bus Signals.....	3-99
Table 3-11.	DIO-32F RTSI Bus Signals	3-100

Table of Contents

Table 3-12.	DIO 6533 RTSI Bus Signals	3-101
Table 3-13.	Maximum SCXI Module Settling Times	3-120
Table 3-14.	SCXI-1200 Module Settling Rates.....	3-121
Table 3-15.	Temperature Error for Thermocouple Inverse Equations	3-133

The *NI-DAQ User Manual for PC Compatibles* is for users of the NI-DAQ software for PC compatibles version 6.0. NI-DAQ software is a powerful application programming interface (API) between your data acquisition (DAQ) application and the National Instruments DAQ devices. Source code for several example applications is included in this manual.

How to Use the NI-DAQ Documentation Set

Begin by reading the NI-DAQ release notes and this manual. Chapter 1, *Introduction to NI-DAQ*, contains a flowchart that illustrates how to set up your DAQ system using either NI-DAQ or other National Instruments application software.

When you are familiar with the material in this manual, you can begin to use the *NI-DAQ Function Reference Manual for PC Compatibles*. The NI-DAQ Function Reference Manual contains detailed descriptions of the NI-DAQ functions. You also can use the Windows help file `NIDAQPC.HLP`, located in your NI-DAQ software, which contains all of the function reference material.

Organization of This Manual

The *NI-DAQ User Manual for PC Compatibles* is organized as follows:

- Chapter 1, *Introduction to NI-DAQ*, describes how to set up your DAQ system and configure your DAQ devices.
- Chapter 2, *Fundamentals of Building Windows Applications*, describes the fundamentals of creating NI-DAQ applications in Windows and Windows NT.
- Chapter 3, *Software Overview*, describes the function classes in NI-DAQ and briefly describes each function.
- Chapter 4, *DMA and Programmed I/O Performance Limitations*, discusses data acquisition performance reductions caused by interrupt latency in the Windows programming environment.

- Chapter 5, *NI-DAQ Double Buffering*, describes using double-buffered data acquisition with NI-DAQ.
- The *Customer Communication* appendix contains forms you can use to request help from National Instruments or to comment on our products and manuals.
- The *Glossary* contains an alphabetical list and description of terms used in this manual, including abbreviations, acronyms, metric prefixes, mnemonics, and symbols.
- The *Index* contains an alphabetical list of key terms and topics in this manual, including the page where you can find each one.

Conventions Used in This Manual

The following conventions are used in this manual.



This icon to the left of bold italicized text denotes a note, which alerts you to important information.

bold

Bold text denotes the names of menus, menu items, parameters, dialog boxes, dialog box buttons or options, icons, windows, Windows 95 tabs or pages, or LEDs.

bold italic

Bold italic text denotes a note, caution, or warning.

italic

Italic text denotes emphasis, a cross reference, or an introduction to a key concept. This font also denotes text for which you supply the appropriate word or value, such as in NI-DAQ 5.x.

italic monospace

Italic text in this font denotes that you must supply the appropriate words or values in the place of these items.

monospace

Text in this font denotes text or characters that you should literally enter from the keyboard, sections of code, programming examples, and syntax examples. This font also is used for the proper names of disk drives, paths, directories, programs, subprograms, subroutines, device names, functions, operations, variables, file names, and extensions, and for statements and comments taken from program code.

1102/B/C modules

Refers to the SCXI-1102, SCXI-1102B, and SCXI-1102C modules and the VXI-SC-1102, VXI-SC-1102B, and VXI-SC-1102C submodules.

12-bit device

These MIO and AI devices are listed in Table 1.

16-bit device	These MIO and AI devices are listed in Table 1.
445X device	Refers to the PCI-4451 and PCI-4452.
455X device	Refers to the PCI-4551 and PCI-4552.
516 device	Refers to the DAQCard-516 and PC-516.
611X device	Refers to the PCI-6110E and PCI-6111E.
6602 device	Refers to the PCI-6602 and PXI-6602.
AI device	These analog input devices are listed in Table 1.
Am9513-based device	These devices are the AT-MIO-16, AT-MIO-16F-5, AT-MIO-16X, AT-MIO-16D, and AT-MIO-64F-5.
DAQArb 5411 device	Refers to the AT-5411 and PCI-5411.
DAQCard-500/700	Refers to the DAQCard-500 and DAQCard-700.
DAQMeter 4350	Refers to the PC-4350, DAQCard-4350, and DAQPad-4350.
DIO 6533	Refers to the AT-DIO-32HS, PCI-DIO-32HS, DAQCard-6533, and PXI-6533.
DIO-24	Refers to the PC-DIO-24, PC-DIO-24PnP, and DAQCard-DIO-24.
DIO-32F	Refers to the AT-DIO-32F.
DIO-96	Refers to the PC-DIO-96, PC-DIO-96PnP, PCI-DIO-96, DAQPad-6507, DAQPad-6508, and PXI-6508.
DIO device	Refers to any DIO-24, DIO-32, DIO-6533, or DIO-96.
DSA device	Refers to the PCI-4451, PCI-4452, PCI-4551, and PCI-4552.
E Series device	These are MIO and AI devices. Refer to Table 1 for a complete list of these devices.
1200 and 1200AI device	Refers to the DAQCard-1200, DAQPad-1200, Lab-PC-1200, Lab-PC-1200AI, PCI-1200, and SCXI-1200.
Lab and 1200 device	Refers to the DAQCard-1200, DAQPad-1200, Lab-PC+, Lab-PC-1200, Lab-PC-1200AI, PCI-1200, and SCXI-1200.

Lab and 1200 analog output device	Refers to the DAQCard-1200, DAQPad-1200, Lab-PC+, Lab-PC-1200, PCI-1200, and SCXI-1200.
LPM device	Refers to the PC-LPM-16 and PC-LPM-16PnP.
MIO device	Refers to multifunction I/O devices. See Table 1 for a list of these devices.
MIO-F-5/16X device	Refers to the AT-MIO-16F-5, AT-MIO-16X, and the AT-MIO-64F-5.
MIO-16/16D device	Refers to the AT-MIO-16 and AT-MIO-16D.
MIO-16XE-50 device	Refers to the AT-MIO-16XE-50, DAQPad-MIO-16XE-50, and NEC-MIO-16XE-50, and PCI-MIO-16XE-50.
MIO-64	Refers to the AT-MIO-64F-5, AT-MIO-64E-4, PCI-6031E, PCI-6071E, VXI-MIO-64E-1, and VXI-MIO-64XE-10.
NI-DAQ	Refers to the NI-DAQ software for PC compatibles, unless otherwise noted.
PC	Refers to the IBM PC/XT, IBM PC AT, and compatible computers.
PCI Series	Refers to the National Instruments products that use the high-performance expansion bus architecture originally developed by Intel to replace ISA and EISA.
Remote SCXI	Refers to an SCXI configuration where either an SCXI-2000 chassis or an SCXI-2400 remote communications module is connected to the PC serial port.
SCXI-1102/B/C	SCXI-1102/B/C refers to the SCXI-1102, SCXI-1102B, and SCXI-1102C devices.
SCXI-1120/D	SCXI-1120/D refers to the SCXI-1120 and SCXI-1120D.
SCXI analog input module	Refers to the SCXI-1100, SCXI-1102, SCXI-1120, SCXI-1120D, SCXI-1121, SCXI-1122, SCXI-1140, and SCXI-1141.
SCXI chassis	Refers to the SCXI-1000, SCXI-1000DC, SCXI-1001, and SCXI-2000.
SCXI digital module	Refers to the SCXI-1160, SCXI-1161, SCXI-1162, SCXI-1162HV, SCXI-1163, and SCXI-1163R.
Simultaneous sampling device	Refers to the PCI-6110E, PCI-6111E, PCI-4451, PCI-4452, PCI-4551, and PCI-4552.

VXI-MIO device Refers to the VXI-MIO-64E-1 and VXI-MIO-64XE-10.

VXI-SC-1102/B/C Refers to the VXI-SC-1102, VXI-SC-1102B, and VXI-SC-1102C.

MIO and AI Device Terminology

This manual uses generic terms to describe groups of devices whenever possible. The generic terms for the MIO and AI devices are based on the number of bits, the platform, the functionality, and the series name of the devices. For example, *NEC E Series devices* refers to the NEC-AI-16E-4, NEC-AI-16XE-50, NEC-MIO-16E-4, and NEC-MIO-16XE-50. The following table lists each MIO and AI device and the possible classifications for each.

Table 1. MIO and AI Device Classifications

Device	Number of SE Channels	Bit	Type	Functionality	Series
AT-AI-16XE-10	16	16-bit	AT	AI	E Series
AT-MIO-16	16	12-bit	AT	MIO	Am9513-based
AT-MIO-16D	16	12-bit	AT	MIO	Am9513-based
AT-MIO-16DE-10	16	12-bit	AT	MIO	E Series
AT-MIO-16E-1	16	12-bit	AT	MIO	E Series
AT-MIO-16E-2	16	12-bit	AT	MIO	E Series
AT-MIO-16E-10	16	12-bit	AT	MIO	E Series
AT-MIO-16F-5	16	12-bit	AT	MIO	Am9513-based
AT-MIO-16X	16	16-bit	AT	MIO	Am9513-based
AT-MIO-16XE-10	16	16-bit	AT	MIO	E Series
AT-MIO-16XE-50	16	16-bit	AT	MIO	E Series
AT-MIO-64E-3	64	12-bit	AT	MIO	E Series
AT-MIO-64F-5	64	12-bit	AT	MIO	Am9513-based
DAQCard-AI-16E-4	16	12-bit	PCMCIA	AI	E Series
DAQCard-AI-16XE-50	16	16-bit	PCMCIA	AI	E Series

Table 1. MIO and AI Device Classifications (Continued)

Device	Number of SE Channels	Bit	Type	Functionality	Series
DAQPad-MIO-16XE-50	16	16-bit	Parallel Port	MIO	E Series
DAQPad-6020E	16	12-bit	USB	MIO	E Series
NEC-AI-16E-4	16	12-bit	NEC	AI	E Series
NEC-AI-16XE-50	16	16-bit	NEC	AI	E Series
NEC-MIO-16E-4	16	12-bit	NEC	MIO	E Series
NEC-MIO-16XE-50	16	16-bit	NEC	MIO	E Series
PCI-6110E	4, DIFF only	12-bit, 16-bit AO	PCI	MIO	E Series
PCI-6111E	2, DIFF only	12-bit, 16-bit AO	PCI	MIO	E Series
PCI-6031E (MIO-64XE-10)	64	16-bit	PCI	MIO	E Series
PCI-6032E (AI-16XE-10)	16	16-bit	PCI	AI	E Series
PCI-6033E (AI-64XE-10)	64	16-bit	PCI	AI	E Series
PCI-6071E (MIO-64E-1)	64	12-bit	PCI	MIO	E Series
PCI-MIO-16E-1	16	12-bit	PCI	MIO	E Series
PCI-MIO-16E-4	16	12-bit	PCI	MIO	E Series
PCI-MIO-16XE-10	16	16-bit	PCI	MIO	E Series
PCI-MIO-16XE-50	16	16-bit	PCI	MIO	E Series
PXI-6011E	16	16-bit	PXI	MIO	E Series
PXI-6030E	16	16-bit	PXI	MIO	E Series

Table 1. MIO and AI Device Classifications (Continued)

Device	Number of SE Channels	Bit	Type	Functionality	Series
PXI-6040E	16	12-bit	PXI	MIO	E Series
PXI-6070E	16	12-bit	PXI	MIO	E Series
VXI-MIO-64E-1	64	12-bit	VXI	MIO	E Series
VXI-MIO-64XE-10	64	16-bit	VXI	MIO	E Series

National Instruments Documentation

The *NI-DAQ User Manual for PC Compatibles* is one piece of the documentation set for your system. You could have any of several types of manuals, depending on the hardware and software in your system. Use the manuals you have as follows:

- *Getting Started with SCXI*—If you are using SCXI, this is the first manual you should read. It gives an overview of the SCXI system and contains the most commonly needed information for the modules, chassis, and software.
- Your SCXI user manuals—These manuals contain detailed information about signal connections and module configuration. They also explain in greater detail how the module works and contain application hints.
- Your DAQ hardware user manuals—These manuals have detailed information about the DAQ hardware that plugs into or is connected to your computer. Use these manuals for hardware installation and configuration instructions, specification information about your DAQ hardware, and application hints.
- Software documentation—Examples of software documentation you might have are the National Instruments application software—LabVIEW, LabWindows/CVI, ComponentWorks, BridgeVIEW, and VirtualBench—and the NI-DAQ documentation. After you have set up your hardware system, use either the application software or the NI-DAQ documentation to help you write your application. If you have a large and complicated system, it is worthwhile to look through the software documentation before you configure your hardware.



Notes: *Only NI-DAQ for PC compatibles versions 4.6.1 and earlier support LabWindows for DOS.*

Only NI-DAQ for PC compatibles versions 4.8.0 and earlier support DOS.

Only NI-DAQ for PC compatibles versions 5.0 and earlier support Windows 3.x.

- Accessory installation guides or manuals—If you are using accessory products, read the terminal block and cable assembly installation guides or accessory board user manuals. They explain how to physically connect the relevant pieces of the system. Consult these guides when you are making your connections.
- *SCXI Chassis User Manual*—This manual contains maintenance information on the chassis, installation instructions, and information about making custom modules.

Related Documentation

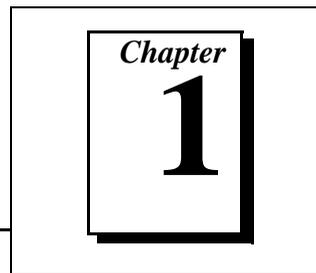
For detailed hardware information, refer to the user manual included with each device. The following documents contain information you may find useful as you read this manual:

- *NI-DAQ Function Reference Manual for PC Compatibles*
- *DAQ Hardware Overview Guide*
- *Microsoft Visual C++ User Guide to Programming*
- *NIST Monograph 175*

Customer Communication

National Instruments wants to receive your comments on our products and manuals. We are interested in the applications you develop with our products, and we want to help if you have problems with them. To make it easy for you to contact us, this manual contains comment and configuration forms for you to complete. These forms are in the *Customer Communication* appendix at the end of this manual.

Introduction to NI-DAQ



This chapter describes how to set up your DAQ system and configure your DAQ devices.

About the NI-DAQ Software for PC Compatibles

Thank you for buying a National Instruments DAQ device, which includes NI-DAQ software for PC compatibles. NI-DAQ is a set of functions that control all of the National Instruments plug-in DAQ devices for analog I/O, digital I/O, timing I/O, SCXI signal conditioning, and RTSI multiboard synchronization.

NI-DAQ has both *high-level* DAQ I/O functions for maximum ease of use, and *low-level* DAQ I/O functions for maximum flexibility and performance. Examples of high-level functions are streaming data to disk or acquiring a certain number of data points. Examples of low-level functions are writing directly to the DAQ device registers or calibrating the analog inputs. NI-DAQ does not sacrifice the performance of National Instruments DAQ devices because it lets multiple devices operate at their peak performance.

NI-DAQ includes a *Buffer and Data Manager* that uses sophisticated techniques for handling and managing data acquisition buffers so that you can acquire and process data simultaneously. NI-DAQ can transfer data using DMA, interrupts, or software polling. NI-DAQ can use DMA to transfer data into memory above 16 MB even on ISA bus computers.

With the NI-DAQ *Resource Manager*, you can use several functions and several devices simultaneously. The Resource Manager prevents multiboard contention over DMA channels, interrupt levels, and RTSI channels.

NI-DAQ can send *event-driven messages* to Windows or Windows NT applications each time a user-specified event occurs. Thus, polling is eliminated and you can develop event-driven DAQ applications. Some examples of NI-DAQ user events are:

- When a specified number of analog samples has been acquired
- When the analog level and slope of a signal match specified levels
- When the signal is inside or outside a voltage band
- When a specified digital I/O pattern is matched
- When a rising or falling edge occurred on a timing I/O line

How to Set up Your DAQ System

Figure 1-1 shows the steps for you to install your software and hardware, configure your hardware, and begin using NI-DAQ in your application programs.

If you are accessing the NI-DAQ device drivers through LabVIEW, read the NI-DAQ release notes and then use your *LabVIEW Function and VI Reference Manual* to help you get started using the data acquisition VIs in LabVIEW.

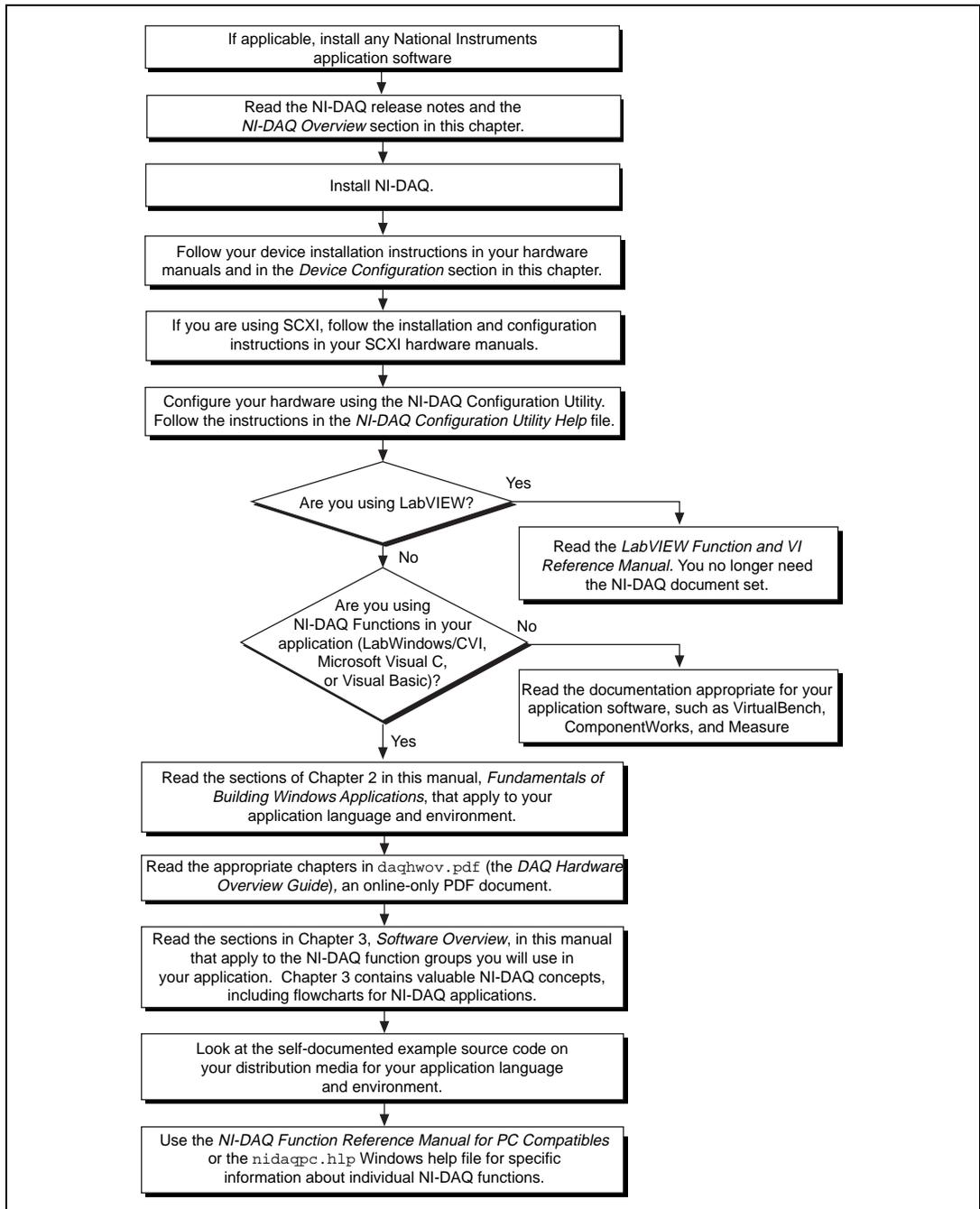


Figure 1-1. How to Set up Your DAQ System

NI-DAQ Overview

NI-DAQ is a library of routines that work with National Instruments DAQ devices. NI-DAQ helps you overcome difficulties ranging from simple device initialization to advanced high-speed data logging. The number of services you need for your applications depends on the types of DAQ devices you have and the complexity of your applications.

NI-DAQ Hardware Support

National Instruments periodically upgrades NI-DAQ to add support for new DAQ hardware. To ensure that this version of NI-DAQ supports your hardware, consult Tables 1-1 through 1-3.

Table 1-1. NI-DAQ Version 6.0 Internal Device Hardware for AT, PC, and NEC Buses

AT	PC	NEC
AT-AI-16XE-10	Lab-PC+	NEC-AI-16E-4
AT-AO-6/10	PC-516	NEC-AI-16XE-50
AT-DIO-32F	PC-AO-2DC	NEC-MIO-16E-4
AT-MIO-16	PC-DIO-24	NEC-MIO-16XE-50
AT-MIO-16D	PC-DIO-24PnP	
AT-MIO-16DE-10	PC-DIO-96	
AT-MIO-16E-1	PC-DIO-96PnP	
AT-MIO-16E-2	PC-LPM-16	
AT-MIO-16E-10	PC-LPM-16PnP	
AT-MIO-16F-5	PC-OPDIO-16	
AT-MIO-16X	PC-TIO-10	
AT-MIO-16XE-10	Lab-PC-1200	
AT-MIO-16XE-50	Lab-PC-1200AI	
AT-MIO-64E-3	PC-4350	
AT-DIO-32HS	PC-4060	
AT-5411		
AT-5102		

Table 1-2. NI-DAQ Version 6.0 Internal Device Hardware for PCMCIA, PCI, PXI, and VXI Buses

PCMCIA	PCI		PXI	VXI
DAQCard-500	PCI-MIO-16E-1	PCI-DIO-32HS	PXI-6040E (MIO-16E-4)	VXI-MIO-64E-1
DAQCard-516	PCI-MIO-16E-4	PCI-5411	PXI-6533	VXI-MIO-64XE-10
DAQCard-700	PCI-MIO-16XE-10	PCI-6110E	PXI-6070E	VXI-DIO-128
DAQCard-1200	PCI-MIO-16XE-50	PCI-6111E	PXI-6011E	VXI-AO-48XDC
DAQCard-AI-16E-4	PCI-DIO-96	PCI-4451	PXI-6030E	
DAQCard-AI-16XE-50	PCI-1200	PCI-4452	PXI-6508	
DAQCard-AO-2DC	PCI-6031E (MIO-64XE-10)	PCI-4551	PXI-4060	
DAQCard-DIO-24	PCI-6032E (AI-16XE-10)	PCI-4552	PXI-5102	
DAQCard-6533	PCI-6033E (AI-64XE-10)	PCI-4060		
DAQCard-4350	PCI-6071E (MIO-64E-1)	PCI-5102		

Table 1-3. NI-DAQ Version 6.0 External Device Hardware

SCXI		USB ²	Parallel Port ²	Other Devices
SCXI-1000	SCXI-1122	DAQPad-6507	DAQPad-1200	AMUX-64T
SCXI-1000DC	SCXI-1124	DAQPad-6508	DAQPad-MIO-16XE-50	SC-2040
VXI-SC-1000	SCXI-1140	DAQPad-6020E		SC-2042-RTD
SCXI-1001	SCXI-1141	DAQPad-4350		SC-2043-SG
PXI-1010	VXI-SC-1150			SC-2345
SCXI-1100	SCXI-1160			
SCXI-1102	SCXI-1161			
SCXI-1102B	SCXI-1162			
SCXI-1102C	SCXI-1162HV			
VXI-SC-1102	SCXI-1163			
VXI-SC-1102B	SCXI-1163R			
VXI-SC-1102C	SCXI-1126			
SCXI-1120	SCXI-1200 ¹			
SCXI-1120D	SCXI-2000			
SCXI-1121	SCXI-2400			

¹ This device works with NEC PC-9800 computers only when used with remote SCXI.
² These devices do not work with NEC PC-9800 computers.

Throughout this manual, many of the devices are grouped into categories that are similar in functionality. The categories are often used in the text to avoid long lists of specific devices. The *Conventions Used in This Manual* section of *About This Manual* lists the devices in each functional type. Any device not included in a category will be referred to by its name.

NI-DAQ Language Support

NI-DAQ supplies header files, examples, and instructions on how to use an Integrated Development Environment (IDE) for one of the following languages under Windows 95/NT:

- Microsoft Visual C++ 2.x, 4.x, or 5.0
- Visual Basic 4.0 (32-bit) or 5.0
- Borland C++ 5.x

NI-DAQ also provides an NI-DAQ function prototype file for use with Borland Delphi 2.x (32-bit).

Most of the files on the release media are compressed. Always run the NI-DAQ installation utilities to extract the files you want. For a brief description of the directories produced by the install programs and the names and purposes of the uncompressed files, consult the `README.DOC` file (or the `READMEJ.DOC` file for the Japanese version of Windows).

Device Configuration

Before you begin your NI-DAQ application development, you must configure your National Instruments DAQ devices, which can be plug-in devices, PCMCIA cards, or external devices you connect to the parallel port of your computer. NI-DAQ needs the device configuration information to program your hardware properly.

Because all system architectures are different, each requires a different device configuration procedure. This procedure ensures that your DAQ devices work properly and coexist with other peripherals in your system such as serial ports and parallel ports.

In most cases you follow the same general steps:

1. Install your application software (LabVIEW or CVI, for example).
2. Install your NI-DAQ driver software and your appropriate support files.
3. Install your DAQ hardware device.
4. Configure your device using the NI-DAQ Configuration Utility.

The NI-DAQ driver software that ships with your hardware is the latest version of NI-DAQ at the time your hardware was shipped. However,

in some cases, application software will install an older version of the NI-DAQ driver software. In such cases, install the latest version of NI-DAQ after you have installed the application software. In *all* cases, install the NI-DAQ software prior to installing your DAQ hardware.

Before installing your DAQ device, consult your hardware user manual to see if you need to change any hardware-selectable options. Some DAQ devices have jumpers to select analog input polarity, input mode, analog output reference, and so on. Make a note of which device options you change so that you can notify NI-DAQ either by entering the information in one of the NI-DAQ configuration utilities or by using NI-DAQ function calls in your application.

Some DAQ devices also have jumpers to select interrupt request (IRQ) levels and/or DMA channels. If you have multiple DAQ devices in your system, select different interrupt request levels and DMA channels for each device. Also select a unique base address for each device if your device has address DIP switches. Make a note of your device interrupt request, DMA, and address settings.

The installation and configuration process you should follow depends on your computer system and the type of DAQ product you have. The following sections provide information on the configuration procedure for PC Cards, DAQ Pads, Plug and Play devices, and non-Plug and Play devices for ISA (PC AT/XT) and EISA computers.



Note: *The following sections assume that you have already installed your application software (LabVIEW or CVI, for example) and the latest version of NI-DAQ.*

Configuring PC Cards (PCMCIA)

The configuration procedure for your PC Card depends on which operating system you are using. Follow the instructions below for your respective operating system.

Configuring PC Cards for Windows NT 4.0

When you install Windows NT 4.0, it automatically installs the PC Card driver if it detects PC Card slots. To install and configure your PC Card for Windows NT 4.0, follow the instructions below:

1. Read the *Using the NI-DAQ Configuration Utility* section later in this chapter. Then run the NI-DAQ Configuration Utility to

configure your PC Card and assign it available resources (interrupt and base I/O address).

2. Shut down your computer.
3. Insert the PC Card, and restart your computer.
4. Run the NI-DAQ Configuration Utility. Click on the **System** tab and the **Test** button to ensure that the card is responding properly to the selected resource assignments. If the device is not responding to the selected interrupt or base I/O setting or if your computer freezes, assign different resources and repeat steps 2 and 4.

If you are using SCXI hardware, read the SCXI installation instructions in your SCXI user manual.

Configuring PC Cards for Windows 95

Windows 95 and PC Cards work very well together because Windows 95 includes Plug and Play capabilities and standard drivers for PC Card devices. To configure your PC Card for Windows 95, insert the PC Card into your computer. After you have read the *Using the NI-DAQ Configuration Utility* section later in this chapter, run the NI-DAQ Configuration Utility. If you have SCXI hardware, read the SCXI installation instructions in your SCXI user manual.

Configuring Parallel Port DAQ Devices

If you are installing a parallel port DAQ device, connect one end of the parallel port cable to the device. Connect the other end to the parallel port on your PC.

If you are using Windows 95, notify the Windows Device Manager that you have a parallel port DAQ device. Refer to the NI-DAQ Configuration Utility help file for detailed instructions.

Then run the NI-DAQ configuration utility.

Configuring Plug and Play Devices



Note:

We recommend that you configure all non-Plug and Play devices in your system before adding any Plug and Play devices. This enables the configuration utility to perform better resource checking on all your DAQ devices.

Refer to your hardware manual to determine if you have a Plug and Play device. Most DAQ devices are Plug and Play, except for some AT and PC devices for ISA bus computers. All E Series devices are Plug and Play. All resources including base address, DMA channels, and interrupt request levels on these devices are fully software configurable. No jumpers or DIP switches are needed to configure any of these resources.

Configuring Plug and Play Devices in Windows NT 4.0

You can install either ISA or PCI/PXI Plug and Play devices in Windows NT 4.0. Refer to the appropriate section below to install either kind of these devices.

ISA Devices

If you plan to use ISA Plug and Play devices (for example, AT E Series devices), install the Windows NT 4.0 ISA Plug and Play driver. This driver is not installed by default. Follow these steps to install the driver:

1. Insert your Windows NT 4.0 CD.
2. Go to the `\Drvlib\Npisa\X86` directory.
3. Right-click once on the `Npisa.inf` file, select the **Install** option, and follow the instructions.
4. After you have installed the `Npisa.inf` file, restart your system.
5. Install your Plug and Play device in your computer.

To configure this device, use the NI-DAQ Configuration Utility to assign system resources. After you have made resource changes in the NI-DAQ Configuration Utility, restart your system again.

PCI/PXI Devices

Install your PCI/PXI Plug and Play device in your computer. To configure this device, use the NI-DAQ Configuration Utility to assign system resources. After you have made resource changes in the NI-DAQ Configuration Utility, restart your system.

Configuring Plug and Play Devices in Windows 95

Install your Plug and Play device in your computer. The Windows 95 Device Manager allocates resources (base I/O address, interrupt, and DMA) to your Plug and Play device. Refer to the *NI-DAQ Configuration Utility Help* for detailed instructions.

After using the Windows 95 Device Manager to allocate resources, run the NI-DAQ Configuration Utility. Before saving the device configuration, this utility performs a full set of tests to ensure that the device operates correctly with the allocated resources. If the device fails any of the tests, the utility reports the errors and does not save the configuration. In this case, you need to start over by reinstalling the device in the **Device Manager** with different resources. After successfully testing and saving the device configuration in the NI-DAQ Configuration Utility, you do not need to restart your system.

If you install the device in the computer before you install NI-DAQ 6.0, Windows 95 might classify a National Instruments Plug and Play DAQ device (for example, a PCI, PC Card, USB, or ISA Plug and Play device) as a generic device and install it in the **Device Manager** under **Other Devices**. NI-DAQ will not recognize the device as a valid DAQ device.

The following steps will correct the problem:

1. Install NI-DAQ 6.0 if you have not already done so.
2. Open the Windows 95 **Device Manager**.
 - a. From the **Start** menu, select **Settings»Control Panel**.
 - b. From the **Control Panel**, double-click on **System**.
 - c. In the **System Properties** dialog box, select the **Device Manager** tab.
3. Under **Other Devices**, remove the entries that correspond to your type of Plug and Play DAQ device.
4. Restart your system. Windows 95 will re-identify all of your DAQ devices and they will now appear in Windows 95 under **Data Acquisition Devices**.

**Note:**

There might be more than one PCI/PXI, PC Card, or ISA Plug and Play device classified under Other Devices in the Windows 95 Device Manager. If you are not sure which generic entry corresponds with your DAQ device (or devices), you can remove all the entries under Other Devices, restart, and let Windows 95 identify the devices again.

Configuring Non-Plug and Play Devices on ISA (PC AT/XT) or EISA Computers

Industry Standard Architecture (ISA) is the oldest computer system architecture among the system architectures NI-DAQ supports. The ISA specification does not define any standard device setup procedure. It relies on the user to make sure that all the plug-in devices are free of resource conflicts, that no plug-in device I/O base address ranges are overlapping each other, and that no plug-in devices are using the same interrupt levels.

Consult your hardware user manual and check your device jumpers and DIP switches to verify that there are no resource conflicts, turn off your computer, and plug in your devices. Then, continue with the SCXI installation instructions in your SCXI user manual, if applicable, and the *Using the NI-DAQ Configuration Utility* section in this chapter.



Note: *Do not use the EISA configuration utility supplied with an EISA computer under any circumstances.*

Using the NI-DAQ Configuration Utility

The NI-DAQ Configuration Utility is a Windows-based application that you can use to configure and view National Instruments DAQ device settings.



Note: *To use the NI-DAQ Configuration Utility, quit any applications that are performing DAQ operations.*

Refer to the *NI-DAQ Configuration Utility Online Help* for more information and detailed instructions. To run the help file, go to **Start»Programs»NI-DAQ for Windows»NI-DAQ Configuration Utility Help**.

Fundamentals of Building Windows Applications

Chapter

2

This chapter describes the fundamentals of creating NI-DAQ applications in Windows and Windows NT.

The following section contains general information about building NI-DAQ applications, describes the nature of the NI-DAQ files used in building NI-DAQ applications, and explains the basics of making applications using the following tools:

- Borland C++ for Windows
- Microsoft Visual C++
- Microsoft Visual Basic

If you are not using the tools listed, consult your development tool reference manual for details on creating applications that call DLLs.

The NI-DAQ Libraries

The NI-DAQ for Windows function libraries are DLLs, which means that NI-DAQ routines are not linked into the executable files of applications. Only the information about the NI-DAQ routines in the NI-DAQ import libraries is stored in the executable files.



Note:

Use the 32-bit `NIDAQ32.DLL`. If you are programming in C or C++, link in the appropriate import library. See the following sections for language-specific details.

Import libraries contain information about their DLL-exported functions. They indicate the presence and location of the DLL routines. Depending on the development tools you are using, you can send information to the DLL routines through import libraries or through function declarations.

Using function prototypes is a good programming practice. That is why NI-DAQ is packaged with function prototype files for different Windows development tools. The installation utility copies the

appropriate prototype files for the development tools you choose. If you are not using any of the development tools that NI-DAQ works with, you must create your own function prototype file.

Creating a Windows Application Using Borland C++

This section assumes that you will be using the Borland IDE (Integrated Development Environment) to manage your code development.

For Windows programs in general, follow this procedure:

1. Open a project module to manage your application code.
2. Create files of type `.c` (C source code) or `.cpp` (C++ source code).
3. Set **Options\Application to Windows App** to set options similar to those used in a module definition file. You also can create a **ConsoleApp** if you are creating a 32-bit application. In these cases, you can skip the next step.
4. (Optional step)—Create your resources using the Borland Whitewater Resource Toolkit. After you have created the resources, save them into a `.res` file and add the `.res` file to the list of files for the project window.

To use the NI-DAQ functions, you must use the NI-DAQ DLL. Follow this procedure:

1. Create your source file as you would for other Windows programs written in C++, calling NI-DAQ functions as typical function calls.
2. Prototype any NI-DAQ routines used in your application. Include the NI-DAQ header file, which prototypes all NI-DAQ routines, as shown in the following example:

```
#include "NIDAQ.H"
```

3. Add the NI-DAQ import library `NIDAQ32B.LIB` to the project module, depending on your operating system. Put this import library under the same node as your source code files that use NI-DAQ functions.

Example Programs

There are some example programs and project files in `.\Examples\BorlandC` in your NI-DAQ directory.

Additional information about these example programs is in the *NI-DAQ Examples Online Help* file. Access this file through **Start»Programs»NI-DAQ for Windows»NI-DAQ Examples Online Help**.

Special Considerations

Buffer Allocation

To allocate memory, you can use the Windows functions `GlobalAlloc()` and `GlobalFree()`. After allocation, to use a buffer of memory, lock memory with `GlobalLock()`. After using the memory, unlock memory with `GlobalUnlock()`.



Note: *If you allocate memory from `GlobalAlloc()`, call `GlobalLock()` on the memory object before passing it to NI-DAQ.*

String Passing

To pass strings, pass a pointer to the first element of the character array. Be sure that the string is null-terminated.

Parameter Passing

By default, C passes parameters by value. Remember to pass pointers to the address of a variable when you need to pass by reference.

Creating a Windows Application Using Microsoft Visual C++

This section assumes that you will be using the Microsoft Visual C++ Integrated Development Environment (IDE) to manage your code development.

To develop NI-DAQ with a graphical user interface, follow this procedure:

1. Open a project module to manage your application code.
2. Create files of type `.c` (C source code) or `.cpp` (C++ source code) and add them to the project.
3. (Optional step)—Create a `.def` file (module definition) and add it to the project.

4. (Optional step)—Create your resources. After you have created the resources, save them into an `.rc` (resource script) and add the file to the project.
5. To use the NI-DAQ functions, prototype any NI-DAQ function used in your application by including the NI-DAQ header file in your source files, as shown below:


```
#include "NIDAQ.H"
```

You either can copy this file into your project directory, or you can specify the path to this header file in the `include` system environmental variable.
6. Add the NI-DAQ import library `NIDAQ32.LIB` (for 32-bit Visual C++ 2.x or later) to the project module.
7. Build your application.

If you are getting started with NI-DAQ programming, you can create a Windows application without a graphical user interface; therefore, you will not need to create a module definition file or resource file. If you are using Visual C++ 2.x or later (32-bit), you can create **Console Applications**. These types of programs do not require the normal message and window handling as Window GUI programs usually require, so your code is made much simpler.

To develop a Console Application using Visual C++ 2.x or later (32-bit), follow this procedure (the specific steps depend on your version of Visual C++):

1. Create your source file of type `.c` (C source code) or `.cpp` (C++ source code), as you would for other Windows programs written in C or C++, calling NI-DAQ functions as typical function calls. Include the NI-DAQ header file, `NIDAQ.H` as shown in the preceding paragraphs.
2. Open a new project file (**File**»**New**) and specify the **Project Type** as **Console Application (.EXE)**. Specify a project name and a directory.
3. Add the C or C++ source file you have created to the project. To do this in Visual C++ 2.x, select the menu **Project**»**Files** and select the source files. In Visual C++ 4.x, select the menu item **Insert**»**Files Into Project** and select the source files.
4. Add the 32-bit NI-DAQ import library `NIDAQ32.LIB` to the project. Add this file in the same way you added your source files.

- Build your application. To do this in Visual C++ 2.x, select the menu item **Project»Build** (your project name) **.EXE**. In Visual C++ 4.x, select the menu item **Build»Build** (your project name) **.EXE**.

Example Programs

There are some example programs and project files in `.\Examples\VisualC` in your NI-DAQ directory.

To load an example program, use one of the project modules with the `.MAK` extension.

If you are using Visual C++ 2.x or later (32-bit), go to the **File** menu, select **Open**, and select **List Files of Type** to be projects (`*.MAK`). Then select the `.MAK` project module of your choice. Refer to the `FILELIST.TXT` file for a short description of all the files in the examples directory.

See *Special Considerations* in the *Creating a Windows Application Using Borland C++* section earlier in this chapter if you need to for your application.

Creating a Windows Application Using Microsoft Visual Basic

To use the NI-DAQ functions, you must use the NI-DAQ DLL. Follow this procedure:

- Create your forms and code as you would for any other Visual Basic program, calling NI-DAQ functions as typical function calls.
- If you are using Visual Basic 4.0 or later, prototype any NI-DAQ routines used in your application. You can do this by adding the NI-DAQ header module `NIDAQ32.BAS` in the `NI-DAQ.\include` directory in your NI-DAQ directory.
 - Go to the **File** menu and select the **Add File** option.
 - Then, using the file dialog box, find `NIDAQ32.BAS` and click on the **OK** button.
 - Verify the existence of the file in the *Project* window. This header file prototypes all NI-DAQ functions.



Note: *In Visual Basic, function declarations have scope globally throughout the project. In other words, you can define your prototypes in any module. The functions will be recognized even in other modules.*

For information on using the NI-DAQ Visual Basic Custom Controls, see the NI-DAQ Events in Visual Basic for Windows section in Chapter 3, Software Overview.

Please also refer to the Programming Language Considerations section in Chapter 1, Introduction to NI-DAQ, of the NI-DAQ Function Reference Manual for more information on using the NI-DAQ functions in Visual Basic for Windows.

Example Programs

You can find some example programs and project files in the `.\Examples\VBBasic` directory in your NI-DAQ directory; the project files have a `.VBP` extension.

If you are using Visual Basic 4.0 or later, load them by opening the **File** menu, selecting **Open Project**, and selecting the `.VBP` file of your choice. These are Visual Basic 4.0 projects, which you can open only with Visual Basic 4.0 or later.

Refer to the `FILELIST.TXT` file for a short description of all the files in the examples directory.

Special Considerations

Buffer Allocation

Visual Basic 4.0 is quite restrictive when allocating memory. You allocate memory by declaring an array of whatever data type with which you want to work. Visual Basic uses dynamic memory allocation so you can redimension an array to a variable size during run time. However, arrays are restricted to being less than 64 KB in *total* size (this translates to about 32,767 (16-bit) integers, 16,384 (32-bit) long integers, or 8,191 doubles).

To break the 64 KB buffer size barrier, you can use the Windows functions `GlobalAlloc()` and `GlobalFree()` to allocate and lock buffers larger than 64 KB. After allocation, to use a buffer of memory, you must lock memory with `GlobalLock()`. After using the memory, you must unlock memory with `GlobalUnlock()`.



Note: *If you allocate memory from `GlobalAlloc()`, call `GlobalLock` on the memory object before passing it to NI-DAQ.*

The following paragraph illustrates declarations of functions.

For Visual Basic 4.0 or later, 32-bit:

```
Declare Function GlobalAlloc Lib "kernel32" Alias
"GlobalAlloc" (ByVal wFlags As Long, ByVal dwBytes As
Long) As Long
```

```
Declare Function GlobalFree Lib "kernel32" Alias
"GlobalFree" (ByVal hMem As Long) As Long
```

```
Declare Function GlobalLock Lib "kernel32" Alias
"GlobalLock" (ByVal hMem As Long) As Long
```

```
Declare Function GlobalReAlloc Lib "kernel32" Alias
"GlobalReAlloc" (ByVal hMem As Long, ByVal dwBytes As
Long, ByVal wFlags As Long) As Long
```

```
Declare Function GlobalUnlock Lib "kernel32" Alias
"GlobalUnlock" (ByVal hMem As Long) As Long
```

String Passing

In Visual Basic, variables of data type `String` need no special modifications to be passed to NI-DAQ for Windows functions. Visual Basic automatically appends a null character to the end of a string before passing it (by reference, because strings cannot be passed by value in Visual Basic) to a procedure or function.

Parameter Passing

By default, Visual Basic passes parameters by reference. Prepend the `ByVal` keyword if you need to pass by value.

Using Borland Delphi with NI-DAQ

The NI-DAQ installer installs a prototype file for use with Borland Delphi 2.0 or later, which is stored in the `.\INCLUDE` directory in your NI-DAQ directory. To use this prototype file, include the file `NIDAQ.PAS` into your Borland Delphi project, and be sure to include this line in your Delphi source code:

```
uses NIDAQ;
```



Note: *There are no examples for Borland Delphi. For examples on NI-DAQ function flow, refer to the examples of other languages to get started.*

NI-DAQ Examples

The NI-DAQ installer installs a suite of concisely written examples in the following languages:

- LabWindows/CVI
- Visual C++
- Visual Basic
- Borland C++

These examples illustrate how to use NI-DAQ functions to perform a single task. All examples are devoid of any code to extract values from graphical user interface (GUI) objects so that you can focus on how the code flow is formed. In addition, most parameters are hardcoded at the top of the routine so that if you decide to change them, you can simply change the assignment.

The examples correspond to the function flowcharts that you will see in Chapter 3, *Software Overview*. If a task and a flowchart in the following chapter suits your data acquisition needs, you should find a corresponding example to get you started.

Each example consists of the following files:

- An appropriate project file for the programming language (except for Borland C++, where .BAT files are included to help build the executable)
- A single source code file to illustrate the task at hand
- A library of NI-DAQ example utility functions (for buffer creation, waveform plotting, error checking, and implementing a delay)



Note: *None of the examples are installed in their pre-compiled executable (.EXE) format. To run them, you first must build them or load them into the IDE for the appropriate programming language.*

The examples are stored in the hierarchy shown below for each language:

- . \AI Analog Input examples
- . \AO Analog Output examples
- . \DI Digital Input examples
- . \DO Digital Output examples
- . \CTR Counter/timer examples
- . \SCXI SCXI examples
- . \CALIB Calibration examples

The project files have the same file name (not including extension) as the source code files. The following types are installed:

- LabWindows/CVI:
 - .PRJ (project file), .C (source file)
- Visual C++:
 - .MAK (make file), .C (source file)
- Visual Basic:
 - .VBP (project file, for Visual Basic 4.0 [32-bit] or later),
 - .FRM (form module)
- Borland C++:
 - .BAT (Batchfile), .C (source file)

For more information about each example, how to compile examples, and details on the NI-DAQ Example Utility functions, please refer to the *NI-DAQ Examples Online Help* file. To open this file, go to **Start»Programs»NI-DAQ for Windows»NI-DAQ Examples Online Help**.

Software Overview

Chapter

3

This chapter describes the function classes in NI-DAQ and briefly describes each function.

NI-DAQ functions are grouped according to the following classes:

- Initialization and general-configuration
- Event message
- Software-calibration and device-specific
- Analog input function group
 - One-shot analog input
 - Single-channel analog input
 - Data acquisition
 - High-level data acquisition
 - Low-level data acquisition
 - Low-level double-buffered data acquisition
- Analog output function group
 - One-shot analog output
 - Waveform generation
 - High-level waveform generation
 - Low-level waveform generation
- Digital I/O function group
 - Digital I/O
 - Group digital I/O
 - Double-buffered digital I/O
- Counter/Timer function group
 - Counter/timer
 - Interval counter/timer
 - General-purpose counter/timer

- RTSI bus trigger
- SCXI
- Transducer conversion

Initialization and General-Configuration Functions

Use these general functions for initializing and configuring your hardware and software.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

<code>Align_DMA_Buffer</code>	Aligns the data in a DMA buffer to avoid crossing a physical page boundary. This function is for use with DMA waveform generation and digital I/O pattern generation.
<code>Get_DAQ_Device_Info</code>	Retrieves parameters pertaining to the device operation.
<code>Get_NI_DAQ_Version</code>	Returns the version number of the NI-DAQ library.
<code>Init_DA_Brds</code>	Initializes the hardware and software states of a National Instruments DAQ device to its default state, and then returns a numeric device code that corresponds to the type of device initialized. Any operation that the device is performing is halted. NI-DAQ automatically calls this function; your application does not have to call it explicitly. This function is useful for reinitializing the device hardware, for reinitializing the NI-DAQ software, and for determining which device has been assigned to a particular slot number.
<code>Set_DAQ_Device_Info</code>	Selects parameters pertaining to the device operation.

`Timeout_Config` Establishes a timeout limit that is used by the synchronous functions to ensure that these functions eventually return control to your application. Examples of synchronous functions are `DAQ_Op`, `DAQ_DB_Transfer`, and `WFM_from_Disk`.

Software-Calibration and Device-Specific Functions

Each of these software-calibration and configuration functions is specific to only one type of device or class of devices.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

`AO_Calibrate` Loads a set of calibration constants into the calibration DACs or copies a set of calibration constants from one of four EEPROM areas to EEPROM area 1. You can load an existing set of calibration constants into the calibration DACs from a storage area in the onboard EEPROM. You can copy EEPROM storage areas 2 through 5 (EEPROM area 5 contains the factory-calibration constants) to storage area 1. NI-DAQ automatically loads the calibration constants stored in EEPROM area 1 the first time a function pertaining to the AT-AO-6/10 is called.

`Calibrate_1200` Calibrates the gain and offset values for the 1200/AI devices ADCs and DACs. You can perform a new calibration or use an existing set of calibration constants by copying the constants from their storage location in the onboard EEPROM. You can store up to six sets of calibration constants. NI-DAQ automatically loads the calibration constants stored in

	EEPROM user area 5 the first time you call a function pertaining to the device.
Calibrate_DSA	Use this function to calibrate your DSA device.
Calibrate_E_Series	Use this function to calibrate your E Series device and to select a set of calibration constants for NI-DAQ to use.
Configure_HW_Analog_Trigger	Configures the hardware analog trigger available on your E Series device.
LPM16_Calibrate	Calibrates the LPM device converter. The function calculates the correct offset voltage for the voltage comparator, adjusts positive linearity and full-scale errors to less than ± 0.5 LSB each, and adjusts zero error to less than ± 1 LSB.
MIO_Calibrate	Calibrates the gain and offset values for ADCs and DACs of MIO-F-5/16X devices. You can perform a new calibration or use an existing set of calibration constants by copying the constants from their storage location in the onboard EEPROM. You can store up to six sets of calibration constants. NI-DAQ automatically loads the calibration constants stored in EEPROM user area 5 the first time you call a function pertaining to the MIO-F-5/16X devices.
MIO_Config	Turns dithering on and off. For the MIO-64, this function also lets you specify whether to use AMUX-64T channels or onboard channels.
Select_Signal	Selects the source and polarity of certain signals used by the E Series, DSA, and DAQArb 5411 devices. You typically need to use this function to

externally control timing, to use the RTSI bus, or to configure one of the I/O connector PFI pins.

Event Message Functions

NI-DAQ Event Message functions are an efficient way to monitor your background data acquisition processes, without dedicating your foreground process for status checking.

The NI-DAQ Event Message dispatcher notifies your application when a user-specified DAQ event occurs. Using event messaging eliminates continuous polling of data acquisition processes.

<code>Config_Alarm_Deadband</code>	Specify alarm on/off condition for data acquisition event messaging.
<code>Config_ATrig_Event_Message</code>	Specify analog input trigger level and slope for data acquisition event messaging.
<code>Config_DAQ_Event_Message</code>	Specify analog input, analog output, digital input, or digital output trigger condition for event messaging.

Event Messaging Application Hints

To receive notification from the NI-DAQ data acquisition process in case of special events, you can call `Config_Alarm_Deadband`, `Config_ATrig_Event_Message`, or `Config_DAQ_Event_Message` to specify an event in which you are interested. If you are interested in more than one event, you can call any of those three functions again for each event.

After you have configured all event messages, you can begin your data acquisition by calling `SCAN_Start`, `DIG_Block_In`, and so on.

When any of the events you specified occur, NI-DAQ notifies your application.

Event notification can be done through user-defined callbacks and/or the Windows Message queue. When a user-specified event occurs, NI-DAQ calls the user-defined callback (if defined) and/or puts a message into the Windows Message queue, if you specified a window handle. Your application receives the message when it calls the Windows GetMessage API.

After your application receives an event message, it can carry out the appropriate task, such as updating the screen or saving data to disk.

To restart your data acquisition process after it completes, you do not need to call the message configuration calls again. They remain defined as long as your application does not explicitly remove them or call `Init_DA_Brds`.

To add or remove a message, first clear your data acquisition process. Then, call one of the three event message configuration functions.

NI-DAQ Events in Visual Basic for Windows

Visual Basic Custom Controls

Unlike standard control-flow programming languages, event occurrences drive Visual Basic code. You interact with outside events through the properties and procedures of a control. For any given control, there is a set of procedures, called *event procedures*, that affect that control. For example, a command button named **Run** has a procedure called `Run_Click()` that is called when you click on the **Run** button. If you want something to run when you click the **Run** button, enter code in the `Run_Click()` procedure. When a program starts executing, Visual Basic looks for events related to controls and calls control procedures as necessary. You do not write an event loop.

There are three NI-DAQ custom controls for Visual Basic applications:

- General Data Acquisition Event (DAQEVENT.OCX)



- Analog Trigger Event (ATRIGEV.OCX)



- Analog Alarm Event (ALARMEV.OCX)



All of these custom controls are placed in the NIDAQ subdirectory of your Windows 95/NT directory under the file names shown above.

These three custom controls actually call the NI-DAQ Config_DAQ_Event_Message, Config_ATrig_Event_Message and Config_Alarm_Deadband functions. Visual Basic applications cannot receive Windows messages, but if you use NI-DAQ custom controls shown previously in this section, your Visual Basic application can receive NI-DAQ messages.



Note: *You can use the OCXs in Visual Basic, version 4.0 (32-bit) or later.*

General DAQ Event

You use the General DAQ Event custom control to configure and enable a single data acquisition event. See the *Event Message Functions* section earlier in this chapter for a complete description of NI-DAQ events. Table 3-1 lists the properties for the General DAQ Event control.



Note: *An n represents a generic number and is not the same value in every occurrence.*

Table 3-1. General DAQ Event Control Properties

Property	Allowed Property Values
Name	GeneralDAQEvent n (default)
Board	1- n (default)
ChanStr	See Config_DAQ_Event_Message in the NI-DAQ Function Reference Manual
DAQEvent	<ul style="list-style-type: none"> 0—Acquired or generated n scans 1—Every n scans 2—Completed operation or stopped by error 3—Voltage out of bounds 4—Voltage within bounds 5—Analog Positive Slope Triggering 6—Analog Negative Slope Triggering 7—Digital Pattern Not Matched 8—Digital Pattern Matched 9—Counter Pulse Event
DAQTrigVal0	Long
DAQTrigVal1	Long
TrigSkipCount	Long
PreTrigScans	Long
PostTrigScans	Long
Index	N/A
Tag	N/A
Enabled	<ul style="list-style-type: none"> 0—False (default) 1—True

Some General DAQ Events can be implemented only by a select group of National Instruments DAQ devices. Also, some General DAQ Events require that you set the asynchronous data acquisition or generation operation to use interrupts. For more information on the different types of General DAQ Events, refer to the descriptions for the `Config_DAQ_Event_Message` function in the NI-DAQ Function Reference Manual.

Set each of these properties as follows:

```
GeneralDAQEventn.(property name) = (property value)
```

For example, to set the `ChanStr` property to Analog Input channel 0 for GeneralDAQEvent 1:

```
GeneralDAQEvent1.ChanStr = "AI0"
```

Set up your program flow like this:

1. Set the properties of the General DAQ Event control. Then configure the acquisition or generation operations using the appropriate NI-DAQ functions.
2. Set the Enabled property of the General DAQ Event control to 1 (True).
3. Invoke the `GeneralDAQEventn.Refresh` method to set the DAQ Event in the NI-DAQ driver. Each subsequent use of `GeneralDAQEventn.Refresh` deletes the old DAQ Event and sets a new one with the current set of properties.
4. Start an asynchronous data acquisition or generation operation.
5. When the selected event occurs, the `GeneralDAQEventn_Fire` procedure is called. You can perform the necessary event processing within this procedure, such as updating a global count variable, or toggling digital I/O lines.

The `GeneralDAQEventn_Fire` procedure is prototyped as follows:

```
Sub GeneralDAQEventn_Fire (DoneFlag As Integer, Scans As Long)
```

The parameter `DoneFlag` equals 1 if the acquisition was over when the DAQ Event fired. Otherwise, it is 0. `Scans` equals the number of the scan that caused the DAQ Event to fire.

For a detailed example of how to use the General DAQ Event custom control in a Visual Basic program, please see the General DAQ Event example at the end of the *NI-DAQ Events in Visual Basic for Windows* section.

Analog Trigger Event

Use the Analog Trigger Event custom control to configure and enable an analog trigger. See the *Event Message Functions* section earlier in this chapter for a definition of the analog trigger.

Table 3-2 lists the properties for the Analog Trigger Event control.

Table 3-2. Analog Trigger Event Control Properties

Property	Allowed Property Values
Name	GeneralDAQEvent <i>n</i> (default)
Board	1- <i>n</i> (default)
ChanStr	See <code>Config_DAQ_Event_Message</code> in the NI-DAQ Function Reference Manual
Level	Single (voltage)
WindowSize	Single (voltage)
Slope	0—Positive (default) 1—Negative
TrigSkipCount	Long
PreTrigScans	Long
PostTrigScans	Long
Index	N/A
Tag	N/A
Enabled	0—False (default) 1—True

The Analog Trigger Event requires that you set the asynchronous data acquisition operation to use interrupts. For more information on Analog Trigger Events, refer to the descriptions for the `Config_ATrig_Event_Message` function in the NI-DAQ Function Reference Manual.

Each of these properties should be set as follows:

```
AnalogTriggerEventn.(property name) = (property value)
```

For example, to set the `ChanStr` property to Analog Input channel 0 for Analog Trigger Event 1:

```
AnalogTriggerEvent1.ChanStr = "AI0"
```

Set up your program flow like this:

1. Set the properties of the Analog Trigger Event control. Next configure the acquisition or generation operations using the appropriate NI-DAQ functions.
2. Set the Enabled property of the Analog Trigger Event control to 1 (True).
3. Invoke the `AnalogTriggerEventn.Refresh` method to actually set the Analog Trigger Event in the NI-DAQ driver. Each subsequent invocation of `AnalogTriggerEventn.Refresh` deletes the old Analog Trigger Event and sets a new one with the current set of properties.
4. Start an asynchronous data acquisition operation.
5. When the Analog Trigger conditions are met, the `AnalogTriggerEventn_Fire` procedure is called. You can perform the necessary event processing within this procedure, such as updating a global count variable, or toggling digital I/O lines.

The `AnalogTriggerEventn_Fire` procedure is prototyped as follows:

```
Sub AnalogTriggerEventn_Fire (DoneFlag As Integer, Scans As Long)
```

The parameter `DoneFlag` equals 1 if the acquisition was over when the Analog Trigger Event fired. Otherwise, it is 0. `Scans` equals the number of the scan that caused the Analog Trigger Event to fire.

Analog Alarm Event

Use the Analog Alarm Event custom control to configure and enable an analog trigger. See the *Event Message Functions* section earlier in this chapter for a definition of the analog trigger.

Table 3-3 lists the properties for the Analog Alarm Event control.

Table 3-3. Analog Alarm Event Control Properties

Property	Allowed Property Values
Name	GeneralDAQEvent n (default)
Board	1- n (default)
ChanStr	See <code>Config_DAQ_Event_Message</code> in the NI-DAQ Function Reference Manual
HighAlarmLevel	Single (voltage)
LowAlarmLevel	Single (voltage)
HighDeadbandWidth	Single (voltage)
LowDeadbandWidth	Single (voltage)
Index	N/A
Tag	N/A
Enabled	0—False (default) 1—True

The Analog Alarm Event requires that you set the asynchronous data acquisition operation to use interrupts. For more information on Analog Alarm Events, refer to the descriptions for the `Config_Alarm_Deadband` function in the NI-DAQ Function Reference Manual.

Each of these properties should be set as follows:

```
AnalogAlarmEvent $n$ .(property name) = (property value)
```

For instance, to set the ChanStr property to Analog Input channel 0 for Analog Alarm Event 1:

```
AnalogAlarmEvent1.ChanStr = "AI0"
```

Set up your program flow like this:

1. Set the properties of the Analog Alarm Event control. Next configure the acquisition or generation operations using the appropriate NI-DAQ functions.
2. Set the Enabled property of the Analog Alarm Event control to 1 (True).
3. Invoke the `AnalogAlarmEvent n .Refresh` method to set the Analog Alarm Event in the NI-DAQ driver. Each subsequent invocation of `AnalogAlarmEvent n .Refresh` deletes the old Analog Alarm Event and sets a new one with the current set of properties.
4. Start an asynchronous data acquisition operation.
5. Any one of the four following procedures can be called:
`AnalogAlarm_HighAlarmOn,`
`AnalogAlarm_HighAlarmOff,`
`AnalogAlarm_LowAlarmOn,` or
`AnalogAlarm_LowAlarmOff.`

You can perform necessary event processing within this procedure, such as updating a global count variable or toggling digital I/O lines.

The four Analog Alarm procedures are prototyped as follows:

```
Sub AnalogAlarm $n$ _HighAlarmOn (DoneFlag As Integer, Scans As Long)
Sub AnalogAlarm $n$ _HighAlarmOff (DoneFlag As Integer, Scans As Long)
Sub AnalogAlarm $n$ _LowAlarmOn (DoneFlag As Integer, Scans As Long)
Sub AnalogAlarm $n$ _LowAlarmOff (DoneFlag As Integer, Scans As Long)
```

The parameter `DoneFlag` equals 1 if the acquisition was over when the Analog Alarm Event fired. Otherwise, it is 0. `Scans` equals the number of the scan that caused the Analog Alarm Event to fire.

Using Multiple Controls

In general, a program might contain any number of General DAQ Event, Analog Trigger Event, and Analog Alarm Event controls. Just like regular Visual Basic controls, there are two ways you can place multiple controls on a Visual Basic form:

- You can create control arrays by copying and pasting a control that already exists on the form. Each individual element in the control

array is then distinguished by the Index property, and the event procedures is an extra parameter Index as Integer. The first element has Index = 0, the second element has Index = 1, and so on. You have only one procedure for each type of event custom control; however, you can determine which control array element caused the event to occur by examining the Index property.

- You can place multiple controls from the **Visual Basic Tool Box** onto the form. Each individual custom control of the same type is then distinguished by the number after the name of the custom control, such as GeneralDAQEvent1, GeneralDAQEvent2, and so on. Consequently, you can have separate procedures for each custom control, such as GeneralDAQEvent1_Fire, GeneralDAQEvent2_Fire, and so on.

General DAQ Event Example

The following steps provide an outline of how to use the General DAQ Event custom control in a Visual Basic program. A working knowledge of Visual Basic is assumed; otherwise, this example is complete, except for error checking:

1. To use the GeneralDAQEvent custom control, you must first include the proper custom control file. If you are using Visual Basic 4.0 (32-bit), select the **Tools»Custom Controls** option, and select the **National Instruments GeneralDAQEvent** custom control. If you are using Visual Basic 5.0, select the **Project»Components** option, and select the **National Instruments GeneralDAQEvent** custom control. In either version, if you do not find the custom control listed, click on the **Browse...** button and find the custom control in the NI-DAQ subdirectory under your Windows directory.
2. To place the GeneralDAQEvent custom control into your form, go to the tool box window and select the GeneralDAQEvent tool, labelled *DAQ EVENT*. Click somewhere on the form, and while holding down the mouse button, drag the mouse to place the control onto the form. You will see a small icon, which does not appear in run time.
3. To set up a DAQ Event that notifies you after every n scans (DAQ Event #1), unless you decide to make n very large, you can use the Set_DAQ_Device_Info function to set the device analog inputs to use interrupts. The constants used in this function come from NIDAQCNS.INC. See the function description for Set_DAQ_Device_Info in the *Programming Language*

Considerations section in the *Using the NI-DAQ Functions* chapter of the NI-DAQ Function Reference Manual for more information. You must also configure some parameters so that the `GeneralDAQEvent` can occur when it needs to. In the `Form_Load` event routine, add the following to the existing code:

```
er% = Set_DAQ_Device_Info(1, ND_DATA_XFER_MODE_AI, ND_INTERRUPTS)
                                     ' set AI to use INTR
GeneralDAQEvent1.Board = 1           ' assume Device 1
GeneralDAQEvent1.DAQEvent = 1       ' event every N scans
GeneralDAQEvent1.DAQTrigVal0 = 1000 ' set N=1000 scans
GeneralDAQEvent1.Enabled = True
```

4. Next, start an asynchronous operation. Use the NI-DAQ function `DAQ_Start`. Set up your program so it does a `DAQ_Start` on channel 0 when you click on a button you have placed on your form. To do so, add the following code in the `Command1_Click()` subroutine as follows:

```
Redim buffer%(10000)
GeneralDAQEvent1.ChanStr = "AI0"
GeneralDAQEvent1.Refresh           'refresh to set params
er% = DAQ_Start(1, 0, 1, buffer%(0), 10000, 3, 10)
```

5. Next, define what to do when the DAQ Event occurs. In this example, we can easily update a text box upon every 1,000 scans, and also when the whole acquisition is complete. Place a text box on your form. It is automatically named *Text1*. Go to the *code window*, pull down on the **Object** combo box, and select **GeneralDAQEvent1**. The only **Proc** for this control object is **Fire**. Within the subroutine, enter the following code:

```
If (DoneFlag% <> 1) Then
    Text1.Text = Str$(Scans&)+" scans have been acquired."
Else
    Text1.Text = "Acquisition is complete!"
    er% = DAQ_Clear(1)
End If
```

6. Make sure that you stop any ongoing acquisition when you stop the program. To do so, call the `DAQ_Clear` function before the `End` statement in the subroutine `Command2_Click(_)`. Place another button on your form and label it *Exit*. The subroutine should have code as follows:

```
er% = DAQ_Clear(1)
End
```

7. Run the program. Because you are not going to display the data onto a graph, it does not matter what the data is; however, when you click on the **Click Me!** button, the text box should update its contents every second. After all the scans are acquired, you should see the text box display a completion message. If you run into errors, refer to the NI-DAQ Function Reference Manual for guidance.
8. Click on the **Exit** button to stop the program.

Analog Input Function Group

The analog input function group contains two sets of functions—the one-shot analog input functions, which perform single A/D conversions, and the data acquisition functions, which perform multiple clocked, buffered A/D functions. Within the analog input functions, single-channel analog input (AI) functions perform single A/D conversions on one channel. Within the data acquisition functions, there are high level, low level, and low-level double buffered.

If you are using SCXI analog input modules (other than the SCXI-1200) you must use the SCXI functions first to program the SCXI hardware. Then you can use these functions to acquire the data using your DAQ device or SCXI-1200 module.

One-Shot Analog Input Functions

Single-Channel Analog Input Functions

Use the single-channel Analog Input functions for analog input on the 516 devices, DAQCard-700, analog input Lab and 1200 devices, MIO and AI devices, and LPM devices.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

AI_Check	Returns the status of the analog input circuitry and an analog input reading if one is available. AI_Check is intended for use when A/D conversions are initiated by external pulses applied at the appropriate pin; see the DAQ_Config section in the <i>Function Reference</i> chapter of the NI-DAQ Function Reference Manual for information on enabling external conversions.
AI_Clear	Clears the analog input circuitry and empties the FIFO memory.
AI_Change_Parameter	Selects a specific parameter setting for the analog input section or analog input channel. Use this to set the coupling for AI channels.
AI_Configure	Informs NI-DAQ of the input mode (single-ended or differential), input range, and input polarity selected for the device. Use this function if you change the jumpers affecting the analog input configuration from their factory settings. For the E Series and MIO-F-5/16X devices, which have no jumpers for analog input configuration, this function programs the device for the settings you want. For the E Series devices, the AT-MIO-64F-5, and the AT-MIO-16X settings, you can configure the input mode and polarity on a per channel basis. Also use AI_Configure to specify whether or not to drive AISENSE to onboard ground.
AI_Mux_Config	Configures the number of multiplexer (AMUX-64T) devices connected to an MIO and AI device and informs NI-DAQ if any AMUX-64T devices are

	attached to the system. This function applies <i>only</i> to the MIO and AI devices.
AI_Read	Reads an analog input channel (initiates an A/D conversion on an analog input channel) and returns the unscaled result.
AI_Read_Scan	Returns readings for all analog input channels selected by <code>Scan_Setup</code> .
AI_Read_VScan	Returns readings in volts for analog input channels selected by <code>Scan_Setup</code> .
AI_Setup	Selects the specified analog input channel and gain setting for externally pulsed conversion operations.
AI_VRead	Reads an analog input channel (initiates an A/D conversion on an analog input channel) and returns the result scaled to a voltage in units of volts.
AI_VScale	Converts the binary result from an <code>AI_Read</code> call to the actual input voltage.

Single-Channel Analog Input Application Hints

All of the NI-DAQ functions described in this section are for nonbuffered single-point analog input readings. For buffered data acquisition, consult the *Data Acquisition Functions* section later in this chapter.

Two of the AI functions are related to device configuration. If you have changed the device jumper settings from the factory-default settings or want to reprogram the E Series and MIO-F-5/16X devices, call `AI_Configure` at the beginning of your application to inform NI-DAQ about the changes. Furthermore, if you have connected multiplexer devices (AMUX-64T) to your MIO and AI devices, call `AI_Mux_Config` once at the beginning of your application to inform NI-DAQ about the multiplexer devices.

For most purposes, `AI_VRead` is the only function required to perform single-point analog input readings. Use `AI_Read` when unscaled data is sufficient or when extra time taken by `AI_VRead` to scale the data is detrimental to your applications. Use `AI_VScale` to convert the binary values to voltages at a later time if you want. See Figure 3-1 for the function flow typical of single-point data acquisition. Also, refer to the *NI-DAQ Examples Online Help* (`NIDAQEX.HLP`) to find a related example.

When using SCXI as a front end for analog input to the DAQCard-700, analog input Lab and 1200 devices, MIO and AI device, or LPM devices, it is not advisable to use the `AI_VRead` function because that function does not take into account the gain of the SCXI module when scaling the data. Use the `AI_Read` function to obtain the unscaled data, then call the `SCXI_Scale` function using both the SCXI module gain and the DAQ device gain.

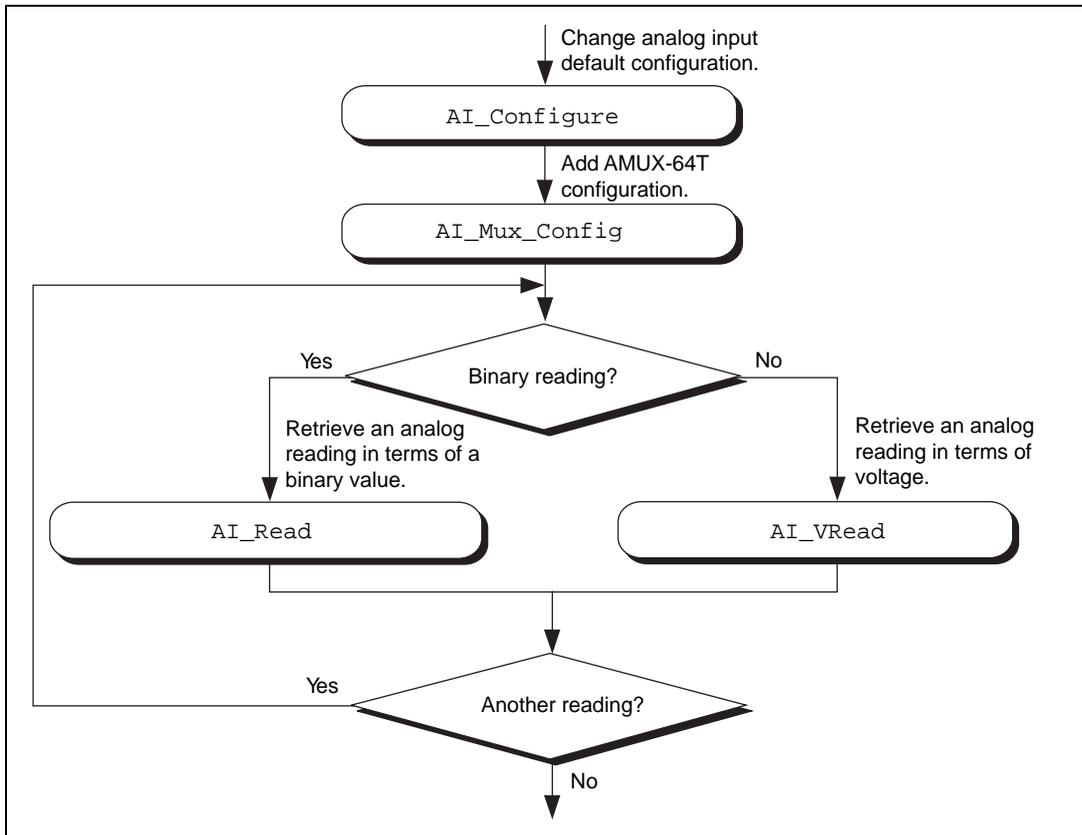


Figure 3-1. Single-Point Analog Reading with Onboard Conversion Timing

When accurate sample timing is important, you can use external conversion pulses with `AI_Clear`, `AI_Setup`, and `AI_Check` to sample your signal on the analog input channels. See Figure 3-2 for the function flow typical of single-point data acquisition using external conversion pulses. However, this method works only if your computer is faster than the rate of conversion pulses. Refer to the *Data Acquisition Functions* section later in this chapter to learn more about interrupt and DMA-driven data acquisition by using high-speed data acquisition.

When using SCXI analog input modules, use the SCXI functions to set up the SCXI chassis and modules *before* using the AI functions described in Figures 3-1 and 3-2.

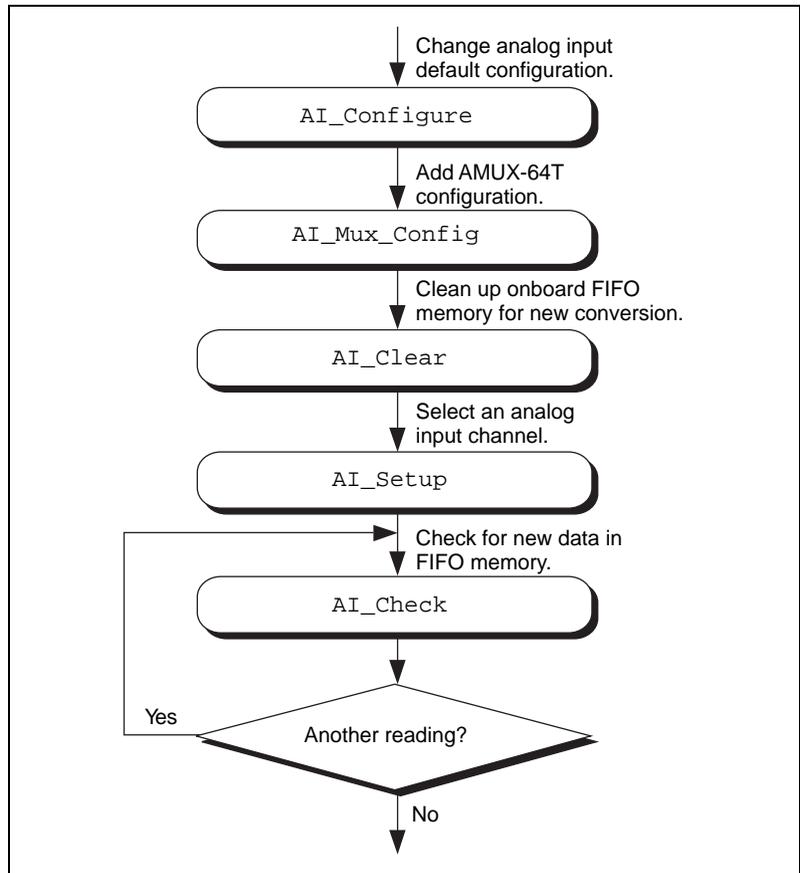


Figure 3-2. Single-Point Analog Reading with External Conversion Timing

Data Acquisition Functions

High-Level Data Acquisition Functions

These high-level data acquisition functions are synchronous calls that acquire data and return when data acquisition is complete.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

DAQ_Op

Performs a synchronous, single-channel data acquisition operation. DAQ_Op does not return until

DAQ_to_Disk	NI-DAQ has acquired all the data or an acquisition error has occurred.
DAQ_to_Disk	Performs a synchronous, single-channel data acquisition operation and saves the acquired data in a disk file. DAQ_to_Disk does not return until NI-DAQ has acquired and saved all the data or an acquisition error has occurred.
Lab_ISCAN_Op	Performs a synchronous, multiple-channel scanned data acquisition operation. Lab_ISCAN_Op does not return until NI-DAQ has acquired all the data or an acquisition error has occurred.
Lab_ISCAN_to_Disk	Performs a synchronous, multiple-channel scanned data acquisition operation and simultaneously saves the acquired data in a disk file. Lab_ISCAN_to_Disk does not return until NI-DAQ has acquired all the data and saved all the data or an acquisition error has occurred.
SCAN_Op	Performs a synchronous, multiple-channel scanned data acquisition operation. SCAN_Op does not return until NI-DAQ has acquired all the data or an acquisition error has occurred.
SCAN_to_Disk	Performs a synchronous, multiple-channel scanned data acquisition operation and simultaneously saves the acquired data in a disk file. SCAN_to_Disk does not return until NI-DAQ has acquired all the data and saved or an acquisition error has occurred.

Low-Level Data Acquisition Functions

These functions are low-level primitives used for setting up, starting, and monitoring asynchronous data acquisition operations.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

DAQ_Check	Checks if the current data acquisition operation is complete and returns the status and the number of samples acquired to that point.
DAQ_Clear	Cancels the current data acquisition operation (both single-channel and multiple-channel scanned) and reinitializes the data acquisition circuitry.
DAQ_Config	Stores configuration information for subsequent data acquisition operations.
DAQ_Monitor	Returns data from an asynchronous data acquisition in progress. During a multiple-channel acquisition, you can call DAQ_Monitor to retrieve data from a single channel or from all channels being scanned. Using the Oldest/Newest mode, you can specify whether DAQ_Monitor returns sequential (oldest) blocks of data, or the most recently acquired (newest) blocks of data.
DAQ_Rate	Converts a data acquisition rate into the timebase and sample-interval values needed to produce the rate you want.
DAQ_Set_Clock	Sets the scan rate for a group of channels.
DAQ_Start	Initiates an asynchronous, single-channel data acquisition operation and stores its input in an array.

<code>DAQ_StopTrigger_Config</code>	Enables the pretrigger mode of data acquisition and indicates the number of data points to acquire after you apply the stop trigger pulse at the appropriate PF1 pin.
<code>DAQ_VScale</code>	Converts the values of an array of acquired binary data and the gain setting for that data to actual input voltages measured.
<code>Lab_ISCAN_Check</code>	Checks if the current scan data acquisition operation begun by the <code>Lab_ISCAN_Start</code> function is complete and returns the status, the number of samples acquired to that point, and the scanning order of the channels in the data array.
<code>Lab_ISCAN_Start</code>	Initiates a multiple-channel scanned data acquisition operation and stores its input in an array.
<code>SCAN_Demux</code>	Rearranges, or demultiplexes, data acquired by a <code>SCAN</code> operation into row-major order (that is, each row of the array holding the data corresponds to a scanned channel) for easier access by C applications. <code>SCAN_Demux</code> does not need to be called by BASIC applications to rearrange two-dimensional arrays because these arrays are accessed in column-major order.
<code>SCAN_Sequence_Demux</code>	Rearranges the data produced by a multirate acquisition so that all the data from each channel is stored in adjacent elements of your buffer.
<code>SCAN_Sequence_Retrieve</code>	Returns the scan sequence created by NI-DAQ as a result of a previous call to <code>SCAN_Sequence_Setup</code> .

<code>SCAN_Sequence_Setup</code>	Initializes the device for a multirate scanned data acquisition operation. Initialization includes selecting the channels to be scanned, assigning gains to these channels, and assigning different sampling rates to each channel by dividing down the base scan rate.
<code>SCAN_Setup</code>	Initializes circuitry for a scanned data acquisition operation. Initialization includes storing a table of the channel sequence and gain setting for each channel to be digitized.
<code>SCAN_Start</code>	Initiates a multiple-channel scanned data acquisition operation, with or without interval scanning, and stores its input in an array.

Low-Level Double-Buffered Data Acquisition Functions

These functions are low-level primitives used for setting up and monitoring asynchronous double-buffered data acquisition operations.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

<code>DAQ_DB_Config</code>	Enables or disables double-buffered data acquisition operations.
<code>DAQ_DB_HalfReady</code>	Checks whether the next half buffer of data is available during a double-buffered data acquisition.
<code>DAQ_DB_Transfer</code>	Transfers half of the data from the buffer being used for double-buffered data acquisition to another buffer, which is passed to the function. This function waits until the data to be transferred is available before returning. You can execute <code>DAQ_DB_Transfer</code> repeatedly to return sequential half buffers of the data.

Data Acquisition Application Hints

Lab and 1200 Device Counter/Timer Signals

For the Lab and 1200 devices, counter A2 produces the total sample interval for data acquisition timing. However, if the total sample interval is greater than 65,535 μs , counter B0 generates the clock for a slower timebase, which counter A2 uses for the total sample interval. Thus, the `ICTR_Setup` and `ICTR_Reset` functions cannot use counter B0 for the duration of the data acquisition operation.

In addition, the Waveform Generation functions cannot use counter B0 if the total update interval for waveform generation is also greater than 65,535 μs and counter B0 must produce a timebase for waveform generation different from the timebase counter B0 produced for data acquisition. If waveform generation is not in progress, counter B0 is available for data acquisition if you have made no `ICTR_Setup` call on counter B0 since startup, or if you have made an `ICTR_Reset` call on counter B0. If waveform generation is in progress and is using counter B0 to obtain the timebase required to produce the total update interval, counter B0 is only available for data acquisition if this timebase is the same as that required by the Data Acquisition functions to produce the total sample interval. In this case, counter B0 provides the same timebase for data acquisition and waveform generation.

DAQCard-500/700, 516 Device, and LPM Device Counter/Timer Signals

For these devices, counter 0 produces the sample interval for data acquisition timing. If data acquisition is not in progress, you can call the `ICTR` functions to use counter 0 as a general-purpose counter. Because the `CLOCK0` input is connected to a 1 MHz oscillator, the timebase for counter 0 is fixed.

External Multiplexer Support (AMUX-64T)

You can expand the number of analog input signals measurable by the MIO and AI devices with an external multiplexer device (AMUX-64T). Refer to the *AMUX-64T External Multiplexer Devices* chapter in the *DAQ Hardware Overview Guide*, for more information on using the AMUX-64T with your MIO and AI device. See the *AMUX-64T User Manual* for more information on the external multiplexer device.

Basic Building Blocks

Most of the buffered data acquisition applications are made up of four building blocks, as shown in Figure 3-3. However, depending on the specific devices and applications you have, the NI-DAQ functions comprising each building block vary. Typical applications can include the NI-DAQ functions in each of their four building blocks.

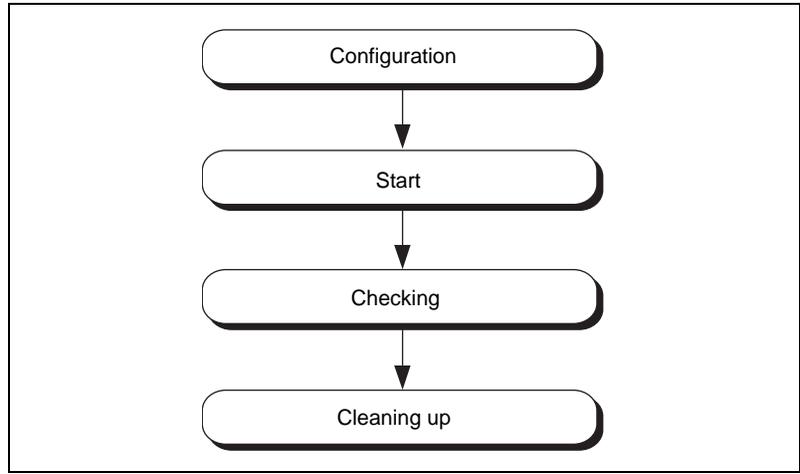


Figure 3-3. Buffered Data Acquisition Basic Building Blocks

When using SCXI analog input modules, use the SCXI functions to set up the SCXI chassis and modules before using the AI, DAQ, SCAN, and Lab_ISCAN functions shown in the following flowcharts.

Building Block 1: Configuration

Five configuration functions are available for creating the first building block, as shown in Figure 3-4. However, you do not have to call all five functions every time you start a data acquisition.

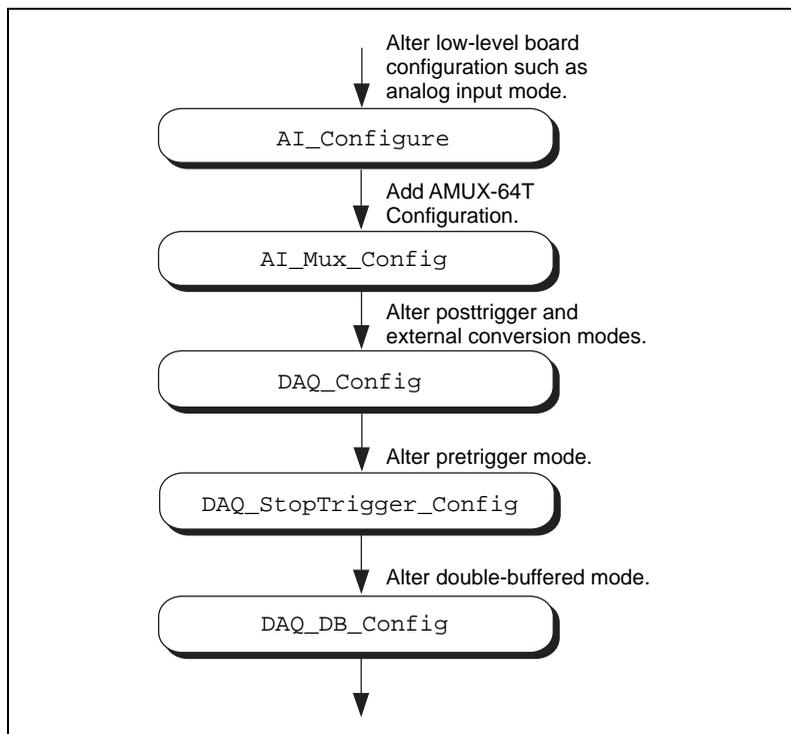


Figure 3-4. Buffered Data Acquisition Application Building Block 1, *Configuration*

NI-DAQ records the device configurations and the default configurations. (See the `Init_DA_Brds` description in the *Function Reference* chapter of the NI-DAQ Function Reference Manual, for device default configurations.) Therefore, if you are satisfied with the default or the current configurations of your devices, your configuration building block will be empty, and you can go on to the next building block, *Start*.

Building Block 2: Start

NI-DAQ has high-level and low-level start functions. The high-level start functions are as follows:

- `DAQ_Op`
- `SCAN_Op` (MIO, AI, and DSA devices only)
- `Lab_ISCAN_Op` (DAQCard-500/700, 516 devices, LPM devices, and Lab and 1200 devices only)
- `DAQ_to_Disk`
- `SCAN_to_Disk` (MIO, AI, and DSA devices only)
- `Lab_ISCAN_to_Disk` (DAQCard-500/700, 516 devices, LPM devices, and Lab and 1200 devices only)

A high-level start call initiates data acquisition but does not return to the function caller until the data acquisition is complete. For that reason, you do not need the next building block, *Checking*, when you use high-level start functions.

The major advantage of the high-level start functions is that they are simple. A single call can produce a buffer full or a disk full of data. However, if your application is acquiring data at a very slow rate or is acquiring a lot of data, the high-level start functions might tie up the computer for a significant amount of time. Therefore, NI-DAQ has some low-level (or asynchronous) start functions that initiate data acquisition and return to the calling program function caller immediately.

Asynchronous start functions include the `DAQ_Start`, `SCAN_Start`, and `SCAN_Start Lab_ISCAN_Start` functions. Figures 3-5 and 3-6 show how the start calls make up building block 2 for different devices.

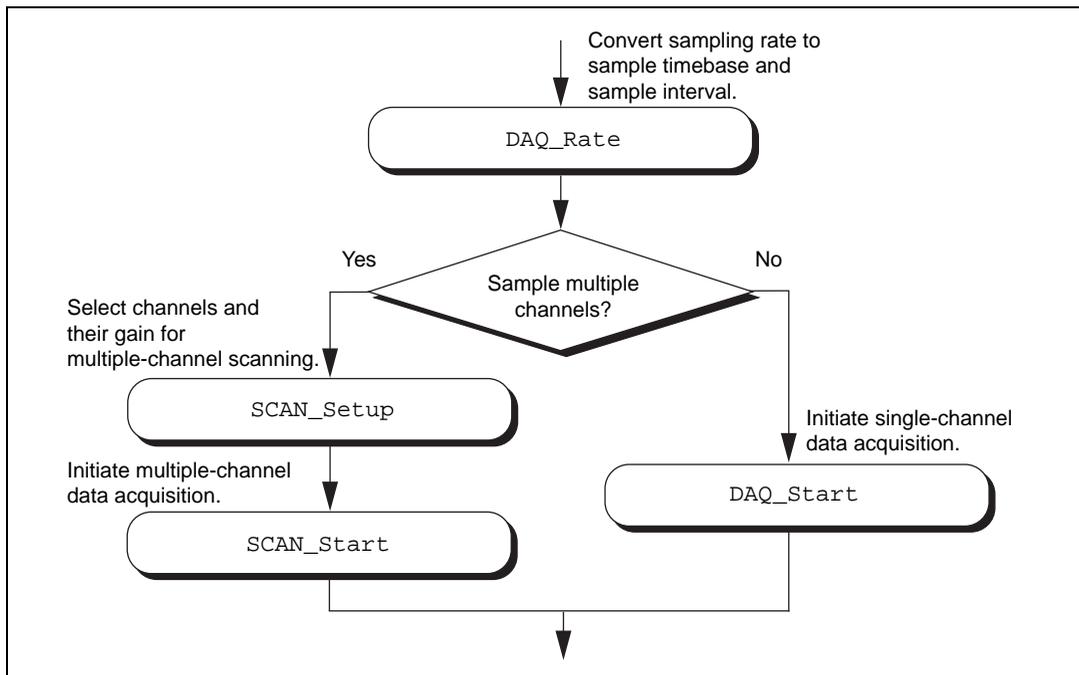


Figure 3-5. Buffered Data Acquisition Application Building Block 2, *Start*, for the MIO and AI Devices

For DSA devices, substitute `DAQ_Set_Clock` for `DAQ_Rate` in Figure 3-5. `DAQ_Rate` will not produce the correct clock settings for DSA devices.

If your device works with multirate scanning, you can use `SCAN_Sequence_Setup` instead of `SCAN_Setup` in building block 2.

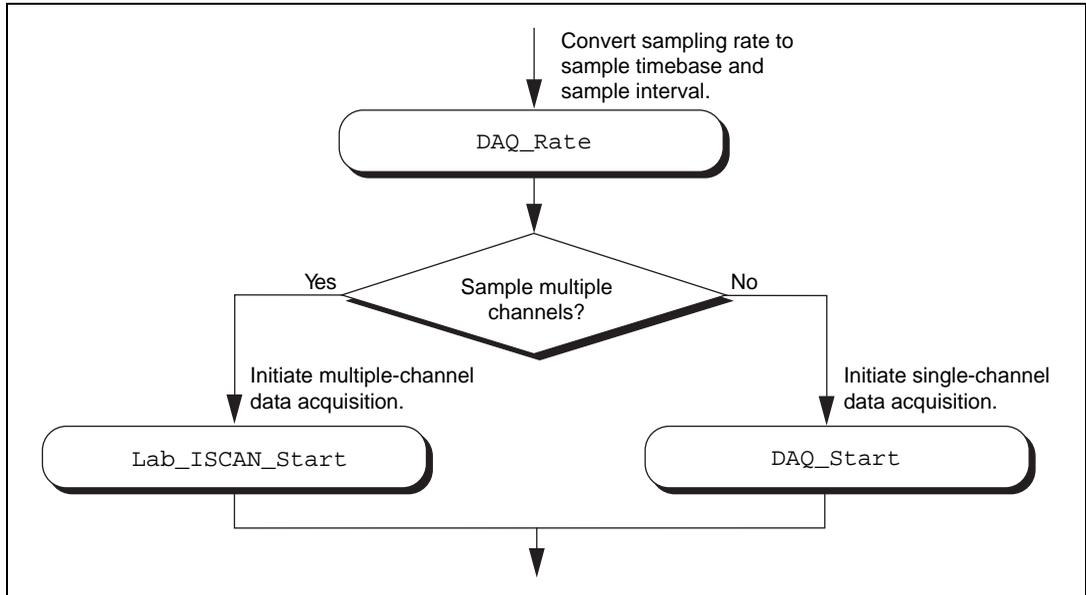


Figure 3-6. Buffered Data Acquisition Application Building Block 2, *Start*, for the 516 Devices, DAQCard-500/700, Lab and 1200 Devices, and LPM Devices

When you have the asynchronous start calls in your building block 2, the next building block, *Checking*, is very useful for determining the status of the ongoing data acquisition process.

Building Block 3: Checking

DAQ_Check and Lab_ISCAN_Check shown in Figures 3-7 and 3-8 are simple and quick ways to check the ongoing data acquisition process. This call is often put in a while loop so that the application can periodically monitor the data acquisition process.

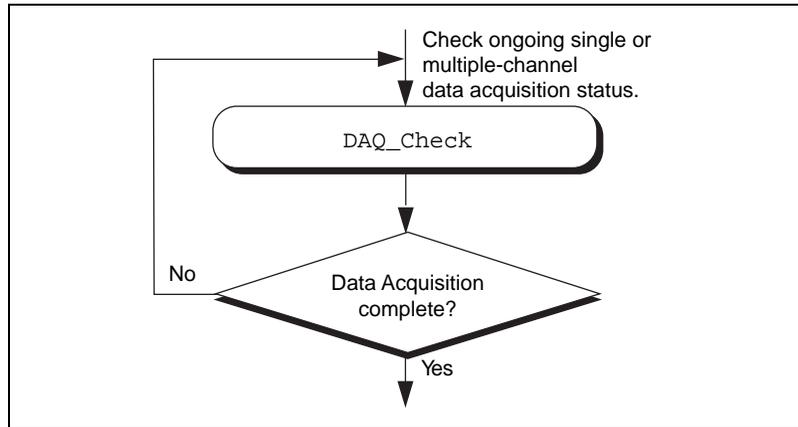


Figure 3-7. Buffered Data Acquisition Application Building Block 3, *Checking*, for the MIO, AI, and DSA Devices

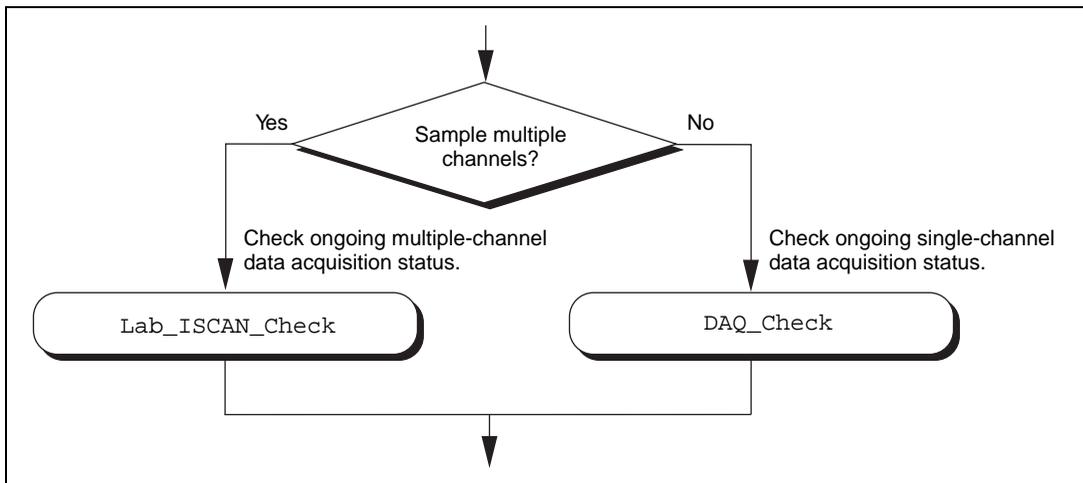


Figure 3-8. Buffered Data Acquisition Application Building Block 3, *Checking*, for the 516 Devices, DAQCard-500/700, Lab and 1200 Devices, and LPM Devices

However, if the information provided by `DAQ_Check` is not sufficient, `DAQ_Monitor` or the double-buffered functions might be a better choice. With `DAQ_Monitor`, not only can you monitor the data acquisition process, but you can also retrieve a portion of the acquired data. With the double-buffered functions, you can retrieve half of the data buffer at a time. Double-buffered functions are very useful when your application has a real-time strip chart displaying the incoming data.

Building Block 4: Cleaning up

The purpose of this building block is to stop the data acquisition and free any system resources (such as DMA channels) used for the data acquisition. `DAQ_Clear` is the only function needed for this building block and is automatically called by the check functions described in the previous building block when the data acquisition is complete. Therefore, you can eliminate this last building block if your application continuously calls the previously described check functions until the data acquisition is complete.



Note: `DAQ_Clear` *does not alter the device configurations made by building block 1.*

Double-Buffered Data Acquisition

The double-buffered (`DAQ_DB`) data acquisition functions return data from an ongoing data acquisition without interrupting the acquisition. These functions use a double, or circular, buffering scheme that permits half buffers of data to be retrieved and processed as the data becomes available. By using a circular buffer, you can collect an unlimited amount of data without needing an unlimited amount of memory. Double-buffered data acquisition is useful for applications such as streaming data to disk and real-time data display.

Initiating double-buffered data acquisition requires some simple changes to the first and third basic building blocks, *Configuration* and *Checking*, respectively.

In building block 1, turn on double-buffered mode data acquisition through the `DAQ_DB_Config` call. Notice that after the double-buffered mode is enabled, all subsequent data acquisitions are in double-buffered mode.

In building block 3, different checking functions are needed. Figure 3-9 shows a simple way to monitor the data acquisition in progress and to retrieve data when they are available.

For further details on double-buffered data acquisition, consult Chapter 5 of this manual, *NI-DAQ Double Buffering*.

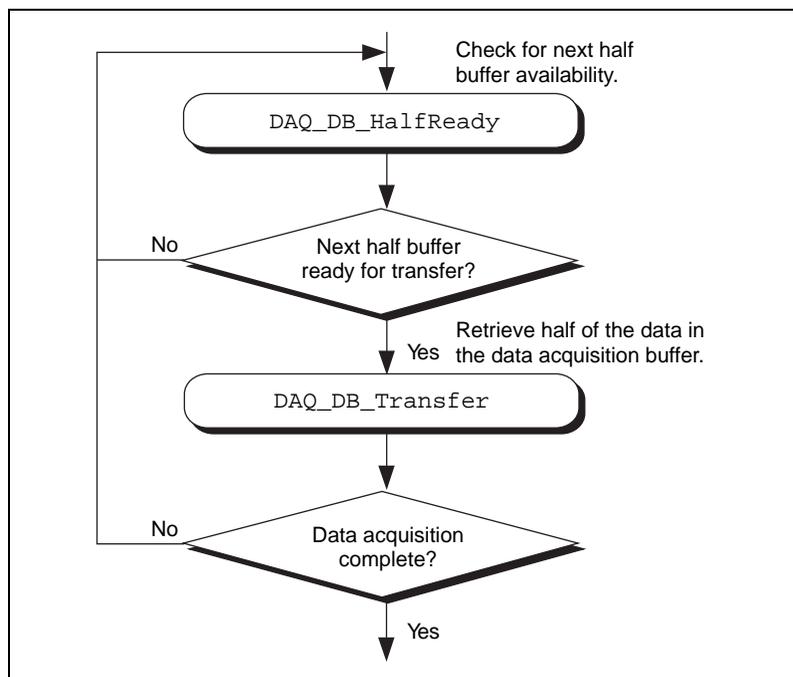


Figure 3-9. Double-Buffered Data Acquisition Application Building Block 3, *Checking*

Multirate Scanning

Use multirate scanning to scan multiple channels at different scan rates and acquire the minimum amount of data necessary for your application. This is particularly useful if you are scanning very fast and want to write your data to disk, or if you are acquiring large amounts of data and want to keep your buffer size to a minimum.

Multirate scanning is a hardware-dependent feature that is implemented for the MIO-F-5/16X devices and all E Series devices.

Multirate scanning works by scanning each channel at a rate that is a fraction of the specified scan rate. For example, if you want to scan four channels at 6,000, 4,000, 3,000, and 1,000 scans per second, specify a scan rate of 12,000 scans per second and a scan rate divisor vector of 2, 3, 4, and 12.

NI-DAQ includes three functions for multirate scanning:

- `SCAN_Sequence_Setup`
- `SCAN_Sequence_Retrieve`
- `SCAN_Sequence_Demux`

Use `SCAN_Sequence_Setup` to identify the channels to scan, their gains, and their scan rate divisors. After the data is acquired, use `SCAN_Sequence_Retrieve` and `SCAN_Sequence_Demux` to arrange the data into a more convenient format.

Figure 3-10 shows how to use the multirate scanning functions in conjunction with other NI-DAQ functions.



Note: *The PCI-6110E and PCI-6111E do not support multirate scanning.*

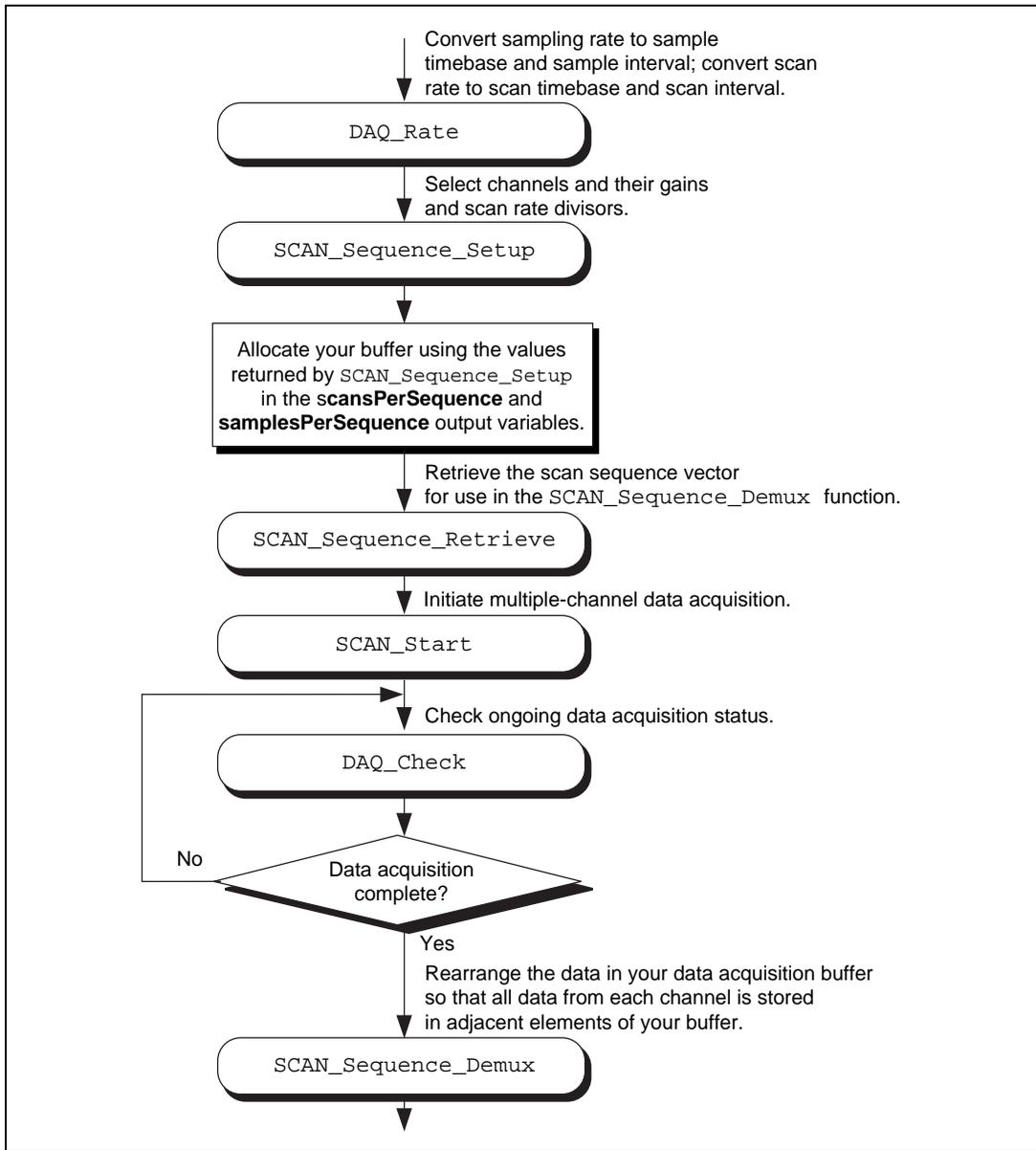


Figure 3-10. Multirate Scanning

Analog Output Function Group

The Analog Output function group contains two sets of functions—the Analog Output (AO) functions, which perform single D/A conversions, and the Waveform (WFM) functions, which perform buffered D/A conversions.



Note: *Use the SCXI functions described later in this chapter for the SCXI-1124 analog output module.*

One-Shot Analog Output Functions

Use the Analog Output functions to perform single D/A conversions with analog output devices.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

<code>AO_Change_Parameter</code>	Selects a specific parameter setting for the analog output section or analog output channel. These parameters might be data transfer conditions, filter settings, or similar device settings.
<code>AO_Configure</code>	Records the output range and polarity selected for each analog output channel by the jumper settings on the device and indicates the update mode of the DACs. Use this function if you have changed the jumper settings affecting analog output range and polarity from their factory settings. Also use this function to change the analog output settings on devices without jumpers.
<code>AO_Update</code>	Updates analog output channels on the specified device to new voltage values when the later internal update mode is enabled by a previous call to <code>AO_Configure</code> .
<code>AO_VScale</code>	Scales a voltage to a binary value that, when written to one of the analog

output channels, produces the specified voltage.

`AO_VWrite`

Accepts a floating-point voltage value, scales it to the proper binary number, and writes that number to an analog output channel to change the output voltage.

`AO_Write`

Writes a binary value to one of the analog output channels, changing the voltage produced at the channel.

Analog Output Application Hints

This section contains a basic explanation of how to construct an application using the analog output functions. The flowcharts are a quick reference for constructing potential applications from the NI-DAQ function calls.

For most purposes, `AO_VWrite` is the only function required to generate single analog voltages. It converts the floating-point voltage to binary and writes the value to the device. `AO_VWrite` is the equivalent of a call to `AO_VScale` followed by a call to `AO_Write`. Figure 3-11 illustrates the equivalency.

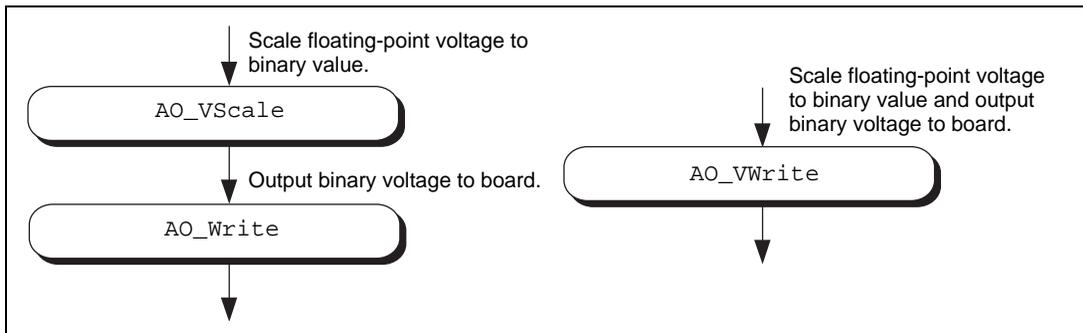


Figure 3-11. Equivalent Analog Output Calls

The following applications are shown using `AO_VWrite`. However, substituting the equivalent `AO_VScale` and `AO_Write` calls will not change the results.

Simple Analog Output Application

Figure 3-12 illustrates the basic series of calls for a simple analog output application.

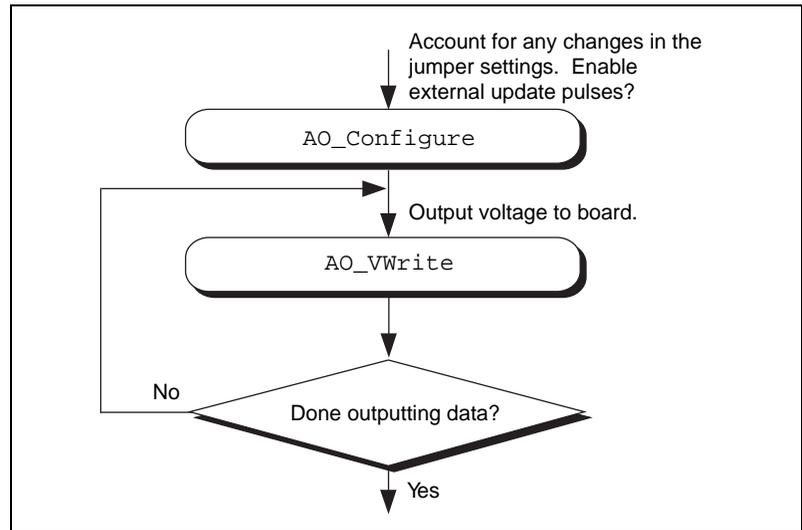


Figure 3-12. Simple Analog Output Application

The call to `AO_Configure` in Figure 3-12 must be made only if you have changed the jumper settings of an MIO, AT-AO-6/10, or Lab-PC+ device. You also might call `AO_Configure` to enable external updating of the voltage. When you select external update mode, voltages written to the device are not output until you apply a pulse to pin 46 (OUT2) on the MIO-16/16D I/O connector, to pin 44 (EXTDACUPDATE*) on an MIO-F-5/16X, to pin 48 (EXTUPDATE) on the AT-AO-6/10, to pin 39 (EXTUPDATE) on the Lab and 1200 analog output devices, or to the selected pin on an E Series device. You can simultaneously change the voltages at all the analog output channels.

The final steps in Figure 3-12 form a simple loop. New voltages are output until the data ends.

Analog Output with Software Update Application

Another application option is to enable later software updates. Like the external update mode, voltages written to the device are not immediately output. Instead, the device does not output the voltages

until you call `AO_Update`. In later software update mode, the device changes voltages simultaneously at all the channels. Figure 3-13 illustrates a modified version of the flowchart in Figure 3-12.

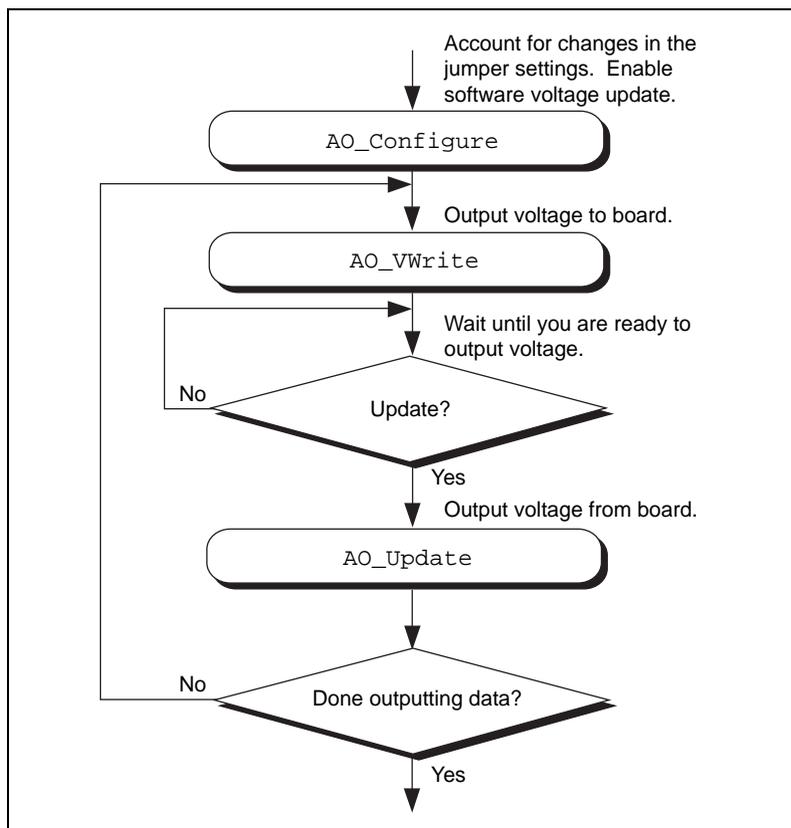


Figure 3-13. Analog Output with Software Updates

The first modification you make is to enable later internal updates when you call `AO_Configure`. The next change, which follows the `AO_VWrite` step, is the decision to wait or to output the voltage. If you want the voltage to be output, your application must call `AO_Update` to write out the voltage. The rest of the flowchart is identical to Figure 3-12.



Note: *Implement buffered analog output via the Waveform Generation functions.*

Waveform Generation Functions

Use the Waveform Generation functions to perform buffered analog output operations with the MIO devices, AT-AO-6/10 devices, and Lab and 1200 analog output devices.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

High-Level Waveform Generation Functions

The following high-level Waveform Generation functions accomplish with a single call tasks that require several low-level calls to accomplish:

<code>WFM_from_Disk</code>	Assigns a disk file to one or more analog output channels, selects the rate and the number of times the data in the file is to be generated, and starts the generation. <code>WFM_from_Disk</code> always waits for completion before returning, unless you call <code>Timeout_Config</code> .
<code>WFM_Op</code>	Assigns a waveform buffer to one or more analog output channels, selects the rate and the number of times the data in the buffer is to be generated, and starts the generation. If the number of buffer generations is finite, <code>WFM_Op</code> waits for completion before returning, unless you call <code>Timeout_Config</code> .

Low-Level Waveform Generation Functions

Low-level waveform generation functions are for setting up, starting, and controlling synchronous waveform generation operations:

<code>WFM_Chan_Control</code>	Temporarily halts or restarts waveform generation for a single analog output channel.
<code>WFM_Check</code>	Returns status information concerning a waveform generation operation.

<code>WFM_ClockRate</code>	Sets an update rate and a delay rate for a group of analog output channels.
<code>WFM_DB_Config</code>	Enables and disables the double-buffered mode of waveform generation.
<code>WFM_DB_HalfReady</code>	Checks if the next half buffer for one or more channels is available for new data during a double-buffered waveform generation operation. You can use <code>WFM_DB_HalfReady</code> to avoid the waiting period possible with the double-buffered transfer functions.
<code>WFM_DB_Transfer</code>	Transfers new data into one or more waveform buffers (selected in <code>WFM_Load</code>) as waveform generation is in progress. <code>WFM_DB_Transfer</code> waits until NI-DAQ can transfer the data from the buffer to the waveform buffer.
<code>WFM_Group_Control</code>	Controls waveform generation for a group of analog output channels.
<code>WFM_Group_Setup</code>	Assigns one or more analog output channels to a waveform generation group. A call to <code>WFM_Group_Setup</code> is required only for the AT-AO-6/10. By default, both analog output channels for the Lab and 1200 analog output devices and MIO devices are in group 1.
<code>WFM_Load</code>	Assigns a waveform buffer to one or more analog output channels and indicates the number of waveform cycles to generate. For the AT-MIO-16X, AT-MIO-64F-5, E Series devices, and AT-AO-6/10, this function also enables or disables FIFO mode waveform generation. For DAQArb 5411 devices, this function can enable the FIFO, ARB, or DDS

	(Direct Digital Synthesis) mode of waveform generation and also can load the staging instructions to the device.
<code>WFM_Rate</code>	Converts a waveform generation update rate into the timebase and update-interval values needed to produce the rate you want.
<code>WFM_Scale</code>	Translates an array of floating-point values that represent voltages into an array of binary values that produce those voltages. The function uses the current analog output configuration settings to perform the conversions.
<code>WFM_Set_Clock</code>	Sets an update rate for a group of channels.

Waveform Generation Application Hints

This section outlines a basic explanation of constructing an application with the Waveform Generation functions. The flowcharts are a quick reference for constructing potential applications from the NI-DAQ function calls.

Basic Waveform Generation Applications

A basic waveform application outputs a series of voltages to an analog output channel. Figure 3-14 illustrates the ordinary series of calls for a basic waveform application.

The first step of Figure 3-14 calls `WFM_Scale`. The `WFM_Scale` function converts floating-point voltages to integer values, thus producing the voltages (DAC values) you want.

You have two options available for starting a waveform generation. The first option is to call the high-level function `WFM_Op`. The `WFM_Op` function immediately begins the waveform generation after you call it. If the number of iterations is nonzero, `WFM_Op` does not return until the waveform generation is done and all cleanup work is complete. Setting the iterations equal to 0 signals NI-DAQ to place the waveform generation in continuous double-buffered mode. In continuous double-buffered mode, waveform generation occurs in the background, and the

`WFM_Op` function returns immediately to your application. See the *Double-Buffered Waveform Generation Applications* section later in this chapter for more information.

The second option to start a waveform generation is to call the following sequence of functions:

1. `WFM_Group_Setup` (required only for the AT-AO-6/10) to assign one or more analog output channels to a group
2. `WFM_Load` to assign a waveform buffer to one or more analog output channels
3. `WFM_Rate` to convert a data output rate to a timebase and an update interval that generates the rate you want. `WFM_Rate` only supports some devices. Since it does not have a **device number** parameter, it cannot return an error if you use it with a non-supported device. See the NI-DAQ Function Reference Manual for supported devices.
4. `WFM_ClockRate` or `WFM_Set_Clock` to set the update rate (see the NI-DAQ Function Reference Manual to find out which function supports your device)
5. `WFM_Group_Control` (with **operation=START**) to start the waveform generation in the background and return to your application after the waveform generation has begun

The next step in Figure 3-14 shows how the call to `WFM_Check`. `WFM_Check` retrieves the current status of the waveform generation. Your application uses this information to determine if the generation is complete or should be stopped.

The final step is to call `WFM_Group_Control` (**operation=CLEAR**). The CLEAR operation performs all of the necessary cleanup work after a waveform generation. Additionally, the CLEAR operation halts any ongoing waveform generation.

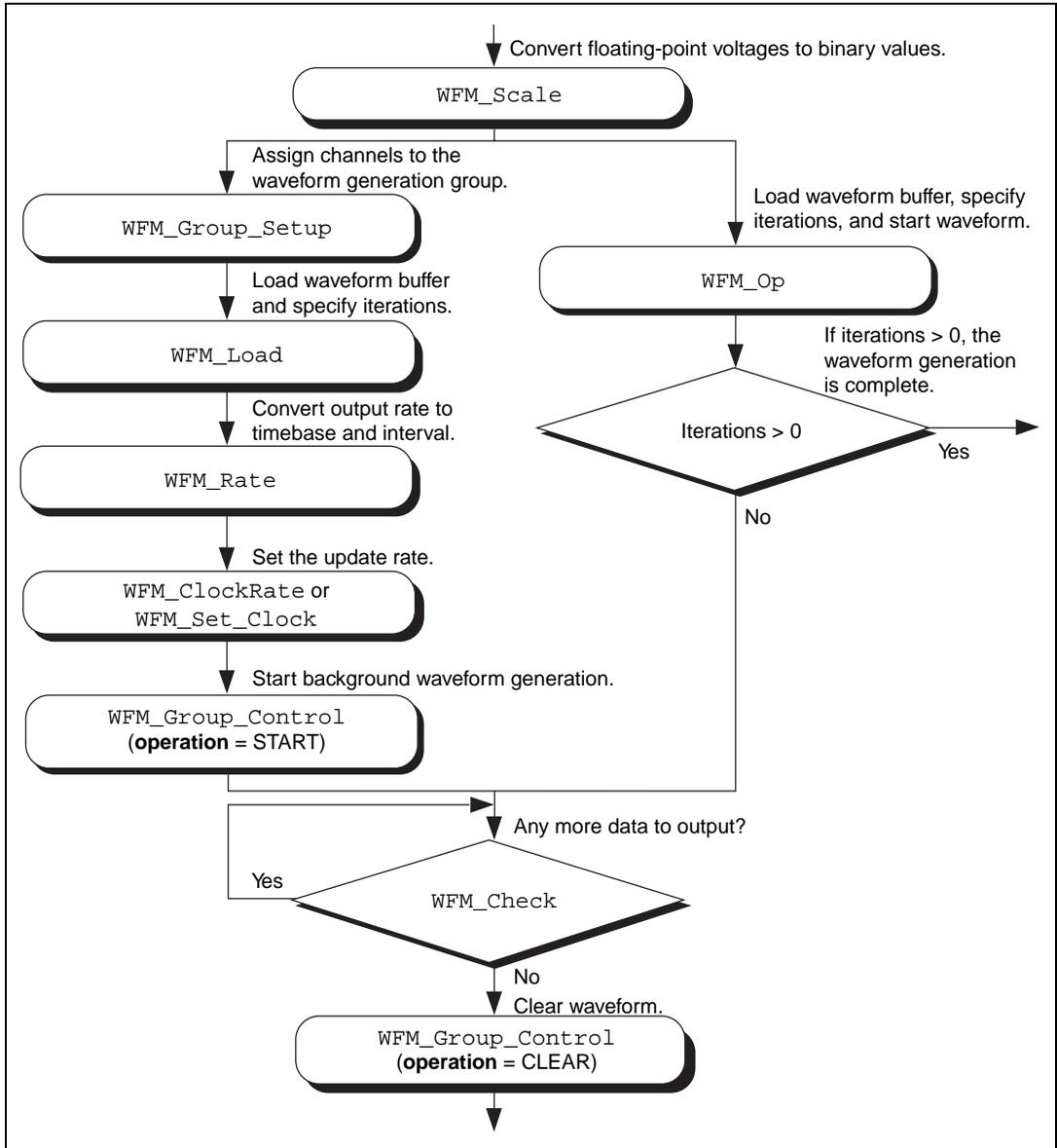


Figure 3-14. Basic Waveform Generation Application

Basic Waveform Generation with Pauses

The application skeleton described in this section is nearly identical to the basic waveform generation application skeleton. The difference is that the description in this section includes the pause and resume operations. Figure 3-15 illustrates the ordinary series of calls for a basic waveform application with pauses.

The first step of Figure 3-15 calls `WFM_Group_Setup`. The `WFM_Group_Setup` function assigns one or more analog output channels to a group.

The second step is to assign a buffer to the analog output channels using the calls `WFM_Scale` and `WFM_Load`. The `WFM_Scale` function converts floating-point voltages to integer values that produce the voltages you want. The `WFM_Load` function assigns a waveform buffer to one or more analog output channels.

The next step is to assign an update rate to the group of channels using the calls `WFM_Rate` and `WFM_ClockRate`. The `WFM_Rate` function converts a data output rate to a timebase and an update interval that generates the rate you want. The `WFM_ClockRate` function assigns a timebase, update interval, and delay interval to a group of analog output channels.

Notice that there are restrictions for using the `WFM_ClockRate` function to specify delay rate. Refer to the `WFM_ClockRate` function description in the *Function Reference* chapter of the NI-DAQ Function Reference Manual for further details.

Your application is now ready to start a waveform generation. Call `WFM_Group_Control` (**operation**=START) to start the waveform generation in the background. `WFM_Group_Control` will return to your application after the waveform generation begins.

The next step in Figure 3-15 is an application decision to pause the waveform generation. The application uses a number of conditions for making this decision, including status information returned by `WFM_Check`.

Pause the waveform generation by calling `WFM_Group_Control` (**operation**=PAUSE). The pause operation stops the waveform generation and maintains the current waveform voltage at the channel output.

Resume the waveform generation by calling `WFM_Group_Control` (**operation**=RESUME). The RESUME operation restarts the waveform generation at the data point where it was paused. The output rate and the data buffer are unchanged.

The final step is to call `WFM_Group_Control` (**operation**=CLEAR). The CLEAR operation performs all of the necessary cleanup work after a waveform generation. Additionally, the CLEAR operation halts any ongoing waveform generation.

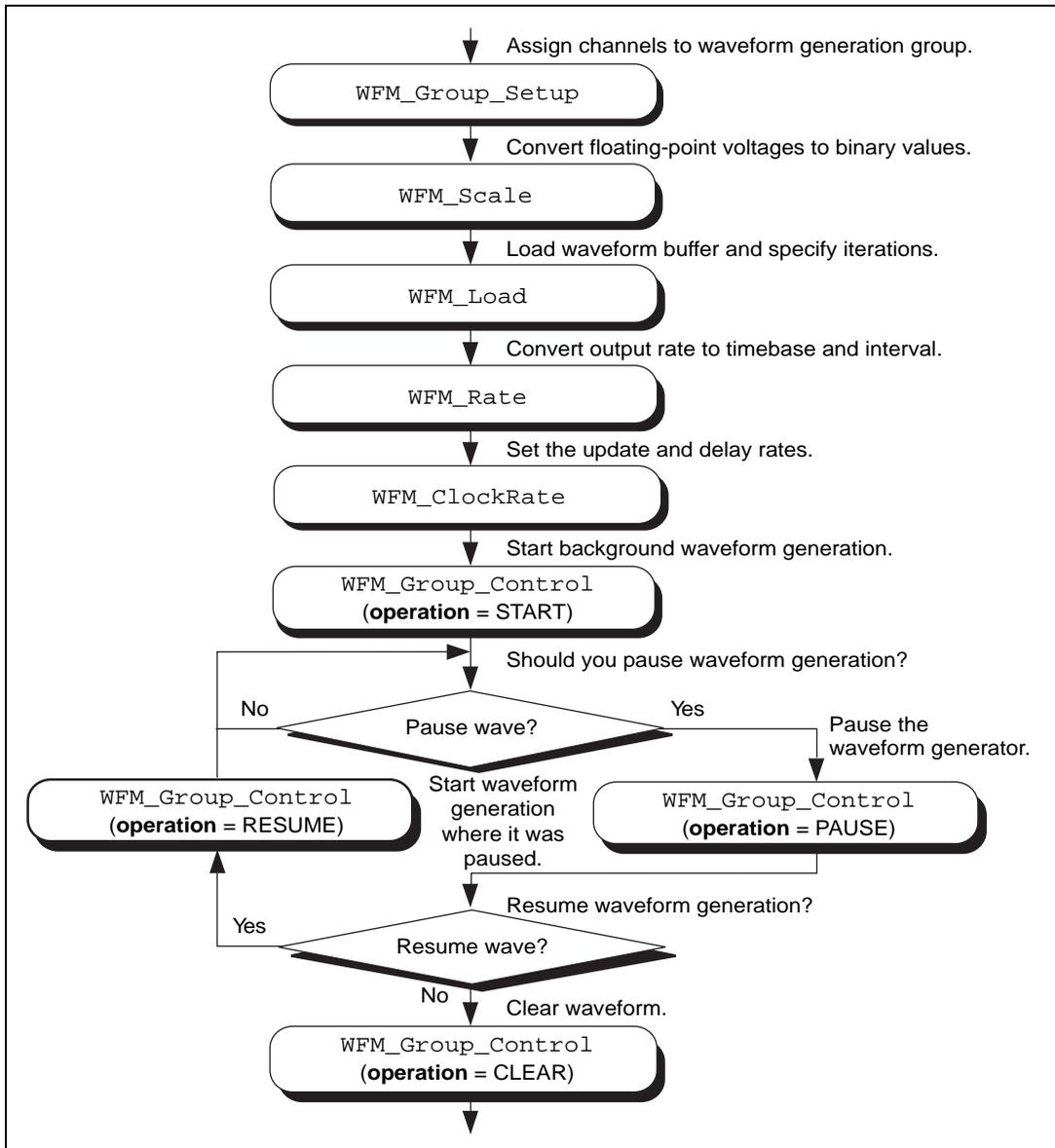


Figure 3-15. Waveform Generation with Pauses

Double-Buffered Waveform Generation Applications

You also can configure waveform generation as a double-buffered operation. Double-buffered operations can perform continuous waveform generation with a limited amount of memory. For an explanation of double buffering, refer to Chapter 5, *NI-DAQ Double Buffering*. Figure 3-16 outlines the basic steps for double-buffered waveform applications.

First, enable double buffering by calling `WFM_DB_Config` as shown in the first step of Figure 3-16.

Although every step is not in the diagram, you might also call `WFM_Rate` and/or `WFM_Scale` as described in the basic waveform application outline.

There are two ways in which your application can start waveform generation. The first way is to call the high-level function `WFM_Op`. The second way is to call the following sequence of functions—`WFM_Group_Setup` (only required on the AT-AO-6/10), `WFM_Load`, `WFM_ClockRate` or `WFM_Set_Clock`, `WFM_Group_Control` (**operation=START**). The `WFM_Group_Setup` function assigns one or more analog output channels to a group. The `WFM_Load` function assigns a waveform buffer to one or more analog output channels. This buffer is called a *circular buffer*. The `WFM_ClockRate` and `WFM_Set_Clock` functions (see the NI-DAQ Function Reference Manual for which function supports your device) assign an update rate to a group of analog output channels. Calling `WFM_Group_Control` (**operation=START**) starts the background waveform generation. `WFM_Group_Control` returns to your application after the waveform generation begins.

After the operation begins, you can perform unlimited of transfers to the circular waveform buffer. To transfer data to the circular buffer, call the `WFM_DB_Transfer` function. After you call the function, NI-DAQ waits until it is able to transfer the data before returning to the application. To avoid the waiting period, you can call `WFM_DB_HalfReady` to determine if the transfer can be made immediately. If `WFM_DB_HalfReady` indicates NI-DAQ is not ready for a transfer, your application is free to do other processing and check the status later.

After the final transfer, you can call `WFM_Check` to get the current transfer progress. Remember, NI-DAQ requires some time after the final transfer to actually output the data.

The final step is to call `WFM_Group_Control` (**operation=**CLEAR). The CLEAR operation performs all of the necessary cleanup work after a waveform generation. Additionally, the CLEAR operation halts any ongoing waveform generation.

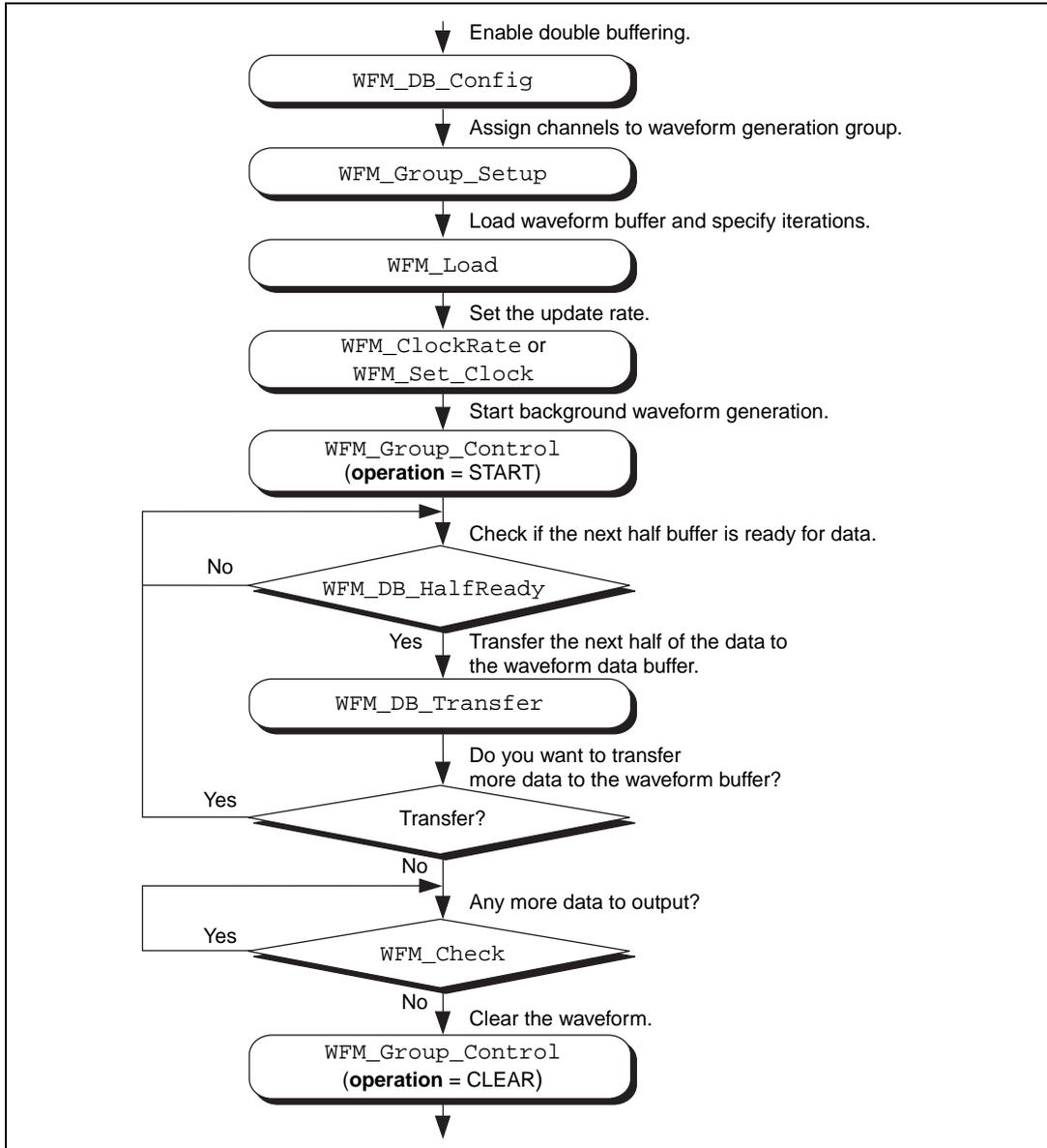


Figure 3-16. Double-Buffered Waveform Generation

Staging-Based Arbitrary Waveform Generation (For DAQArb 5411 Devices Only)

Figure 3-17 illustrates the series of calls for staging-based waveform generation. The *sequence list* is used in staging-based waveform generation for linking, looping, and generating multiple waveforms stored on the onboard memory. A sequence list contains a list of entries. Each entry is called a *stage*. Each stage specifies which waveform to generate and other associated settings for that waveform (for example, the number of loops in the generation).

The first step in Figure 3-17 is to call the `WFM_Group_Setup` function. This function assigns one or more analog output channels to a group.

The second step is to set up trigger modes, analog filter, digital filter, output enable, attenuation, output impedance, SYNC duty cycle, PLL reference frequency, and other miscellaneous settings that the `AO_Change_Parameter` calls. Refer to the `AO_Change_Parameter` function description in the *Function Reference* chapter of the NI-DAQ Function Reference Manual for more details.

The third step is to assign a waveform buffer to the analog output channels using the `WFM_Load` function. Refer to the `WFM_Load` function description in the *Function Reference* chapter of the NI-DAQ Function Reference Manual for more details. You can use two types of waveform buffer modes for staging. When **mode=2**, the buffer is a DDS (Direct Digital Synthesis) buffer, and only one buffer is loaded onto the device. When **mode=3**, the buffer is an ARB buffer, and you can load multiple buffers onto the device and assign them an ID.

You can call `WFM_Load` a number of times to load different buffers consecutively. When you call this function, you must assign each buffer an ID using the **iterations** parameter. The first buffer should have an ID of 0, and the successive buffers should always have the buffer ID of one more than the previously loaded buffer. When all of the buffers are loaded, then load the sequence list. To generate a sequence of these buffers in the order you want, call `WFM_Load` again with **mode=4**.

The fourth step is to assign an update rate to the group of channels by calling the `WFM_ClockRate` function. This function assigns a timebase and update interval to an analog output channel group. Learn more about the `WFM_ClockRate` function in the *Function Reference* chapter of the NI-DAQ Function Reference Manual. Your application is now ready to start a waveform generation.

Use the `WFM_Group_Control` (**operation**=START) to start the waveform generation. The waveform generation continues, depending on what trigger mode you set up earlier.

The final step is to call `WFM_Group_Control` (**operation**=CLEAR). The CLEAR operation halts any ongoing waveform generation. This operation also performs all of the necessary clean-up work after a waveform generation.



Note: *To load another sequence list for waveform generation, which uses some or all of the buffers already loaded onto the device, you do not have to load the waveform buffers again. Instead, you can call `WFM_Load` again with **mode**=4 and the new sequence list.*

To load any new waveform buffer onto the device, start from the beginning by calling `WFM_Load` with **mode**=2 or **mode**=3, and the **iterations** parameter set to 0. All information about the buffers loaded previously will be cleared.



Note: *You can change the settings of the analog filter, digital filter output enable, attenuation, output impedance, SYNC duty cycle, or filter correction frequency even when the waveform generation is in progress.*

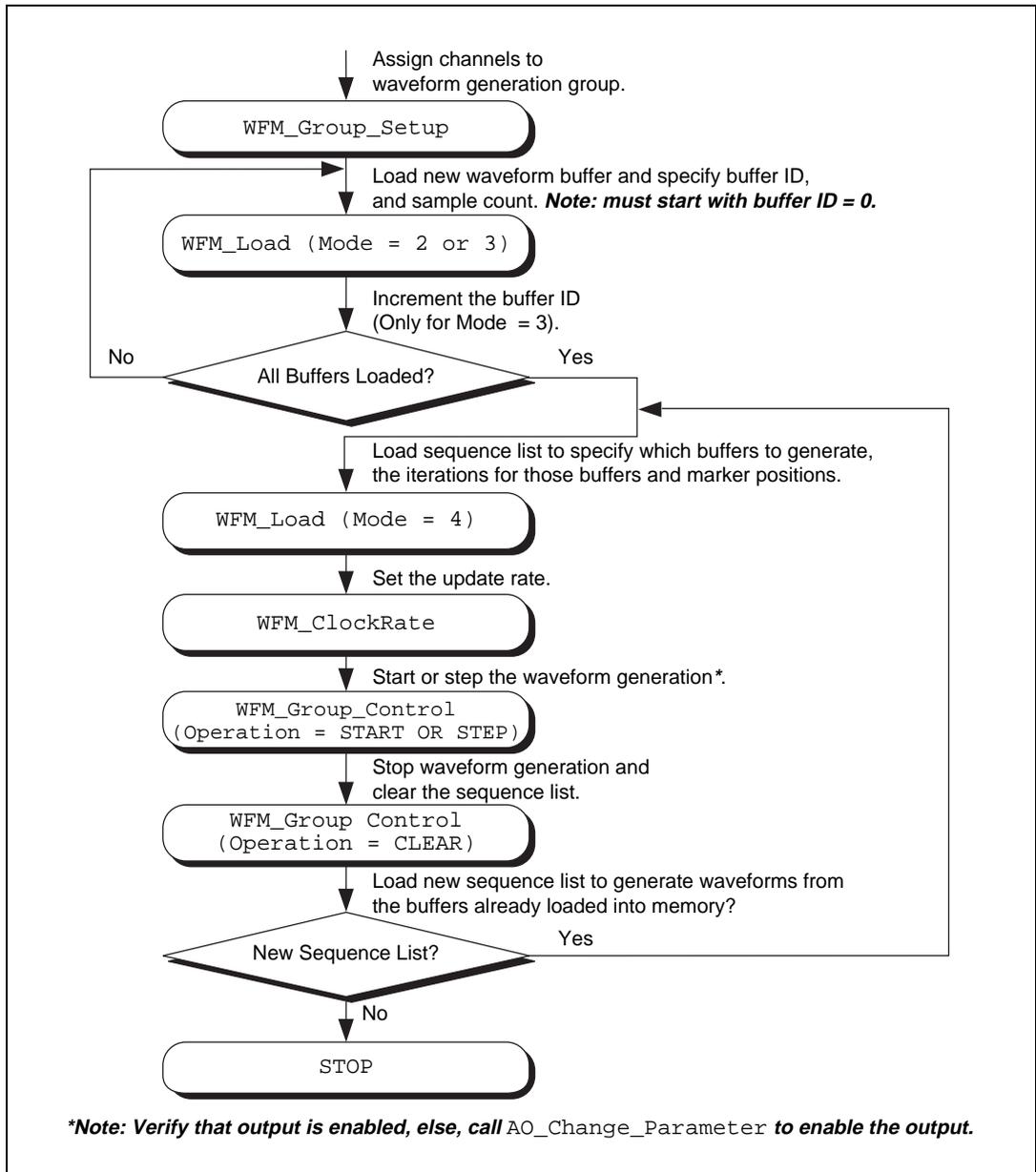


Figure 3-17. Staging-Based Waveform Generation

Reference Voltages for Analog Output Devices

Table 3-4 shows the output voltages produced when you select unipolar output polarity.

Table 3-4. Output Voltages with Unipolar Output Polarity

Device	Value in Waveform Buffer		
	0	4,095	65,535
AT-MIO-16X, AT-MIO-16XE-10, PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E (MIO-64XE-10), VXI-MIO-64XE-10	0 V	—	Reference voltage
All other MIO devices	0 V	Reference voltage	—
AT-AO-6/10	0 V	Reference voltage (+10 V in default case)	—
Lab and 1200 devices with analog output	0 V	+5 V	—

Table 3-5 shows the output voltages produced when you select bipolar output polarity.

Table 3-5. Output Voltages with Bipolar Output Polarity

Device	Value in Waveform Buffer			
	-2,048	2,047	-32,768	32,767
AT-MIO-16X, AT-MIO-16XE-10, PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E (MIO-64XE-10), VXI-MIO-64XE-10, PCI-6110E, PCI-6111E	—	—	Negative of the reference voltage	Reference voltage

Table 3-5. Output Voltages with Bipolar Output Polarity (Continued)

Device	Value in Waveform Buffer			
	-2,048	2,047	-32,768	32,767
All other MIO devices	Negative of the reference voltage	Reference voltage	—	—
AT-AO-6/10	Negative of the reference voltage (-10 V in default case)	Reference voltage (+10 V in default case)	—	—
Lab and 1200 devices with analog output	-5 V	+5 V	—	—
DAQArb-5411 devices	—	—	-5 V into 50 Ω or -10 V into an unterminated load	5 V into 50 Ω or -10 V into an unterminated load



Note: *PCI-4451 and PCI-4551 devices use signed 18-bit binary data left-justified in a 32-bit word. Their output voltage range is ± 10 V.*

Minimum Update Intervals

The rate at which a device can output analog data is limited by the performance of the host computer. For waveform generation, the limitation is in terms of minimum update intervals. The update interval is the period of time between outputting new voltages. Therefore, the minimum update interval specifies the smallest possible time delay between outputting new data points. In other words, the minimum update interval specifies the fastest rate at which a device can output data. Refer to Chapter 4, *DMA and Programmed I/O Performance Limitations*, for more information on the minimum update intervals.

AT-MIO-16F-5 Notes on DMA Waveform Generation

Page breaks in the buffer can adversely affect AT-MIO-16F-5 DMA waveform generation. Page breaks are described in Chapter 4, *DMA and Programmed I/O Performance Limitations*.

Use the utility function `Align_DMA_Buffer` to avoid the negative effects of page boundaries on PC AT and compatible computers in the following cases:

- When using DMA waveform generation at update intervals faster than about 50 μ s (this number depends on your PC).
- When using interleaved DMA waveform generation.

To use `Align_DMA_Buffer`, allocate a buffer larger than the sample count to allow `Align_DMA_Buffer` room to move the data around. If you are using interleaved DMA waveform generation but at rates that can tolerate a page break, allocating an extra two bytes is sufficient to position the data so that the page break does not cause unpredictable results. After the buffer is aligned, you can make the normal calls to all of the Waveform Generation functions. If you need to access the data in an aligned buffer while the waveform is in progress, use the index that `Align_DMA_Buffer` returned. When you make a call to `WFM_Group_Control` (**operation**=CLEAR), or make a call to `WFM_Load` with a new buffer while the waveform is in progress, NI-DAQ *unaligns* the previous waveform buffer. If you want to use the same buffer again for waveform generation after it has been unaligned, you must call `Align_DMA_Buffer` again. See the function description for `Align_DMA_Buffer` in the *Function Reference* chapter of the NI-DAQ Function Reference Manual for more information.

The first point of the waveform buffer is not generated until the second update pulse occurs. That is, two update intervals pass before the waveform begins to appear at the I/O connector after a `WFM_Op`, `WFM_from_Disk`, or `WFM_Group_Control` (**operation**=START) call starts the waveform.

When you use double DMA waveform generation on the AT-MIO-16F-5—when waveforms are generated at both DACs and a separate DMA channel services each DAC—the two waveforms must terminate simultaneously. Either set up both channels to terminate after generating the same number of points, or set up both channels to generate indefinite waveforms. If, for example, you set up channel 0 to terminate after 10 iterations through its buffer and set up channel 1 for indefinite waveform generation, when channel 0 has finished its iterations, it forces channel 1 to stop generating points also. This restriction does not apply to interrupt-driven double waveform generation.

Counter Usage

The 4451 and 4551 devices use the same counter for both waveform generation and analog input data acquisition. See `WFM_Set_Clock` in your NI-DAQ Function Reference Manual for an explanation of the restrictions this causes. This counter is separate from the general-purpose counters.

The MIO and E Series devices use dedicated counters from the DAQ-STC chip for waveform-generation control and timing.

For the MIO-16/16D devices, counter 2 generates interrupt requests that result in the voltage updates at the analog output channels. If counter 2 is otherwise in use (such as for interval scanning), waveform generation is not possible until counter 2 is free.

For the MIO-F-5/16X devices, counters 1, 2, and 5, as well as the dedicated external update signal, can generate either interrupt or DMA requests. If it is available, NI-DAQ uses counter 5 for waveform generation. Otherwise, NI-DAQ uses counter 2. If counter 2 is also unavailable, NI-DAQ selects counter 1.

On the Lab and 1200 devices and analog output devices, counter A2 produces the total update interval for waveform generation. However, if the total update interval is greater than 65,535 μ s, counter B0 generates the clock for a slower timebase, which counter A2 uses for the total update interval. The `ICTR_Setup` and `ICTR_Reset` functions cannot then use counter B0 for the duration of the waveform generation operation. In addition, the data acquisition functions `DAQ_Start` and `Lab_ISCAN_Start` cannot use counter B0 if the total sample interval for data acquisition is also greater than 65,535 μ s, unless the timebase required for data acquisition is the same as the timebase counter B0 produces for waveform generation. If data acquisition is not in progress, counter B0 is available for waveform generation if `ICTR_Setup` has not been called on counter B0 since startup, or an `CTR_Reset` call has been made on counter B0. If data acquisition is in progress and is using counter B0 to produce the sample timebase, counter B0 is available for waveform generation only if this timebase is the same as required by the Waveform Generation functions to produce the total update interval. In this case, counter B0 produces the same timebase for data acquisition and waveform generation.

On the AT-AO-6/10, counter 0 produces the total update interval for group 1 waveform generation and counter 1 produces the total update interval for group 2 waveform generation. However, if the total update interval is greater than 65,535 μs for either group 1 or 2, counter 2 is used by counter 0 (group 1) or counter 1 (group 2) to produce the total update interval. If either group is using counter 2 to produce the sample timebase, counter 2 is available to the other group only if the timebase is the same as the timebase required by the waveform generation functions to produce the total update interval. In this case, counter 2 produces the same timebase for both waveform generation groups.

Restrictions on Delay Rate Use on the AT-MIO-16X and AT-MIO-64F-5

To set a delay rate using `WFM_ClockRate`, the entire waveform buffer must fit within the analog output FIFOs of these devices. The FIFOs on both devices can hold 2,048 samples. The number of iterations of the buffer must be greater than zero and less than or equal to 65,535. Also, double-buffered waveform generation is incompatible with the use of a delay rate.

FIFO Lag Effect on the MIO, E Series, AT-AO-6/10, AT-MIO-16X, AT-MIO-64F-5, PCI-4451, and PCI-4551

Group 1 analog output channels use an onboard FIFO to output data values to the DACs. NI-DAQ continuously writes values to the FIFO as long as the FIFO is not full. NI-DAQ transfers data values from the FIFO to the DACs at regular intervals using an onboard or external clock. A lag effect is seen for group 1 channels because of the FIFO buffering. That is, a value written to the FIFO is not output to the DAC until all of the data values currently in the FIFO have been output to the DACs. This time lag is dependent upon the update rate (specified in `WFM_ClockRate`). Refer to your device user manual for a more detailed discussion of the onboard FIFO.

Three functions are affected by the FIFO lag effect—`WFM_Chan_Control`, `WFM_Check`, and double-buffered waveform generation.

- `WFM_Chan_Control`—When you execute **operation**=PAUSE for a group 1 channel, the effective pause does not occur until the FIFO has finished writing all of the data remaining in the FIFO for the specified channel. The same is true for the RESUME operation on

a group 1 channel; NI-DAQ cannot place data for the specified channel into the FIFO until the FIFO is empty.

- **WFM_Check**—The values returned in **pointsDone** and **itersDone** indicate the number of points that NI-DAQ has written to the FIFO for the specified channel. A time lag occurs from the point when NI-DAQ writes the data to the FIFO when NI-DAQ outputs the data to the DAC.
- When you use double-buffered waveform generation with group 1, make sure the total number of points for all of the group 1 channels (specified in the **count** parameter in **WFM_Load**) is at least twice the size of the FIFO. Refer to your device user manual for information on the analog output FIFO size.

With PCI E Series devices in NI-DAQ 5.1 and later, you can reduce or even eliminate the FIFO lag effect by specifying the FIFO condition NI-DAQ uses to determine when to put more data into the FIFO. Refer to the **AO_Change_Parameter** function in the NI-DAQ Function Reference Manual for details.

Externally Triggering Your Waveform Generation Operation

You can initiate a waveform generation operation from an external trigger signal in much the same manner as for analog input. See the **Select_Signal** function description in the NI-DAQ Function Reference Manual.

On Am9513-based MIO devices, you need to call **CTR_Config** and change the gating mode before you call the **WFM** functions. Refer to the *Using This Function* section of the **CTR_Config** function description in the NI-DAQ Function Reference Manual.

Digital I/O Function Group

The Digital I/O function group contains three sets of functions—the Digital I/O (**DIG**) functions, the Group Digital I/O (**DIG_Block**, **DIG_Grp**, and **DIG_SCAN**) functions, and the double-buffered Digital I/O (**DIG_DB**) functions. Refer to the *NI-DAQ Function Support* appendix in the NI-DAQ Function Reference Manual to find out which digital functions your device supports.

The **SCXI** functions control the **SCXI** digital and relay modules.

These devices contain a number of digital I/O ports of up to eight digital lines in width. The name *port* refers to a set of digital lines (digital lines are also referred to as bits in this text). In many instances, you control the set of digital lines as a group for both reading and writing purposes and for configuration purposes. For example, you can configure the port as an input port or as an output port, which means that the set of digital lines making up the port consist of either all input lines or all output lines.

The digital ports are usually assigned letters, and the digital lines making up the port are assigned numbers beginning with 0. For example, the DIO-24 contains three ports of eight digital lines each. These ports are labeled PA, PB, and PC on the DIO-24 I/O connector drawing, as shown in the PC-DIO-24 user manual. The eight digital lines making up port PA are labeled PA7 through PA0.

In some cases, you can combine digital I/O ports into a larger entity called a *group*. On the DIO-32F and DIO 6533 (DIO-32HS) devices, for example, you can assign any of the ports DIOA through DIOD to one of two groups. A group of ports are handshaked or clocked as a unit.

The Digital I/O functions can write to and read from both an entire port and single digital lines within the port. To write to an entire port, NI-DAQ writes a byte of data to the port in a specified digital output pattern. To read from a port, NI-DAQ returns a byte of data in a specified digital output pattern. The byte mapping to the digital I/O lines is as follows:

Table 3-6. Byte Mapping to Digital I/O Lines

Bit Number	Digital I/O Line Number
7	7 Most significant bit (MSB)
6	6
5	5
4	4
3	3
2	2
1	1
0	0 Least significant bit (LSB)

In the cases where a digital I/O port has fewer than eight lines, the most significant bits in the byte format are ignored.

You can configure most of the digital I/O ports as either input ports or output ports. On the PC-TIO-10, DIO 6533 (DIO-32HS), DSA, and E Series devices (except for ports 2, 3, and 4 on the AT-MIO-16DE-10), you can program lines on the same port independently as input or output lines. Some digital I/O ports are permanently fixed as either input ports or output ports. If you configure a port as an input port, reading that port returns the value of the digital lines. In this case, external devices connected to and driving those lines determine the state of the digital lines. If no external device is driving the lines, the lines float to some indeterminate state, and you can read them in either state 0 (digital logic low) or state 1 (digital logic high). If you configure a port as an output port, writing to the port sets each digital line in the port to a digital logic high or low, depending on the data written. In this case, these digital lines can drive an external device. Many of the digital I/O ports have read-back capability; if you configure the port as an output port, reading the port returns the output state of that port.

You can use digital I/O ports on the DIO-24, AT-MIO-16D, AT-MIO-16DE-10 (ports 2 and 3 only), DIO-96, Lab and 1200 devices, DIO 6533 (DIO-32HS), and DIO-32F devices for handshaking and no-handshaking modes. These two modes have the following characteristics:

- No-handshaking mode—This mode changes the digital value at an output port when written to and returns a digital value from a digital input port when read from. No handshaking signals are generated.
- Handshaking mode—This mode is for digital I/O handshaking; that is, a digital input port latches the data present at the input when the port receives a handshake signal and generates a handshake pulse when the computer writes to a digital output port. In this mode, you can read the status of a port or a group of ports to determine whether an external device has accepted data written to an output port or has latched data into an input port.



Note:

On the DIO 6533 (DIO-32HS) and DIO-32F devices, you must assign ports to a group before you can use handshaking mode.

Process control applications, such as controlling or monitoring relays, often use the no-handshaking mode. Communications applications, such as transferring data between two computers, often use the handshaking mode.

DIO-24, AT-MIO-16D, AT-MIO-16DE-10, DIO-96, and Lab and 1200 Device Groups

You can group together any combination of ports 0, 1, 3, 4, 6, 7, 9, and 10 on the DIO-96, ports 0 and 1 on the DIO-24 and Lab and 1200 devices, and ports 2 and 3 on the AT-MIO-16D and AT-MIO-16DE-10 to make up larger ports. For example, with the DIO-96 you can program ports 0, 3, 9, and 10 to make up a 32-bit handshaking port, or program all eight ports to make up a 64-bit handshaking port. See *Digital I/O Application Hints* later in this chapter and the `DIG_SCAN_Setup` function description in the NI-DAQ Function Reference Manual for more details.

DIO-32F and DIO 6533 (DIO-32HS) Device Groups

On the DIO-32F and DIO 6533 (DIO-32HS) devices, you can assign ports 0 through 3 (referring to ports DIOA through DIOD) to one of two groups for handshaking. These groups are referred to as group 1 and group 2. Group 1 uses handshake lines REQ1 and ACK1. Group 2 uses handshake lines REQ2 and ACK2. The group senses the REQ line. An active REQ signal is an indication that the group must perform a read or write. The group drives the ACK line. After the group has performed a read or write, it drives the ACK line to its active state. Refer to your device user manual for more information on the handshaking signals.

A group can be 8, 16, or 32 bits wide. An 8-bit group can be port 0, 1, 2, or 3. A 16-bit group can be ports 0 and 1 or ports 2 and 3. A 32-bit group is all four ports.

After you have assigned ports to a group, the group acts as a single entity controlling 8, 16, or 32 digital lines simultaneously. The DIO-32F has certain restrictions on which ports can be assigned to which groups. Refer to Table 3-7 for details.

Table 3-7. Legal Group Assignments for DIO-32F Devices

Assigned Ports	Group Name	Group Size (in Bits and Ports)
Port 0	1	8-bit group, one port
Port 1	1	8-bit group, one port
Port 2	2	8-bit group, one port
Port 3	2	8-bit group, one port
Ports 0 and 1	1	16-bit group, two ports
Ports 2 and 3	2	16-bit group, two ports
Ports 0, 1, 2, and 3	1	32-bit group, four ports

After you assign ports to a group, the group controls handshaking of that port. These ports are then read from or written to simultaneously by writing or reading 8 or 16 bits at one time from the group.

You can configure the groups for various handshake configurations. The configuration choices include a handshaking protocol, inverted or non-inverted ACK and REQ lines, and a programmed transfer settling time.



Note: *Implement buffered digital I/O via the `DIG_Block` functions described in detail in the *NI-DAQ Function Reference Manual*.*

Digital I/O Functions

The digital I/O (DIG) functions perform nonhandshaked digital line and port I/O.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

`DIG_In_Line` Returns the digital logic state of the specified digital input line in the specified port.

`DIG_In_Port` Returns digital input data from the specified digital I/O port.

DIG_Line_Config	Configures the specified line on a specified port for direction (input or output).
DIG_Out_Line	Sets or clears the specified digital output line in the specified digital port.
DIG_Out_Port	Writes digital output data to the specified digital port.
DIG_Prt_Config	Configures the specified port for direction (input or output).
DIG_Prt_Status	Returns a status word indicating the handshake status of the specified port.

Group Digital I/O Functions

The Group Digital I/O (DIG_Block, DIG_Grp, and DIG_SCAN) functions perform handshaked I/O on groups of ports.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

DIG_Block_Check	Returns the number of items remaining to be transferred after a DIG_Block_In or DIG_Block_Out call.
DIG_Block_Clear	Halts any ongoing asynchronous transfer, allowing another transfer to be initiated.
DIG_Block_In	Initiates an asynchronous data transfer from the specified group to memory.
DIG_Block_Out	Initiates an asynchronous data transfer from memory to the specified group.
DIG_Block_PG_Config	Enables or disables the pattern generation mode of buffered digital I/O.

<code>DIG_Grp_Config</code>	Configures the specified group for port assignment, direction (input or output), and size.
<code>DIG_Grp_Mode</code>	Configures the specified group for handshake signal modes.
<code>DIG_Grp_Status</code>	Returns a status word indicating the handshake status of the specified group.
<code>DIG_In_Grp</code>	Reads digital input data from the specified digital group.
<code>DIG_Out_Grp</code>	Writes digital output data to the specified digital group.
<code>DIG_SCAN_Setup</code>	Configures the specified group for port assignment, direction (input or output), and size.
<code>DIG_Trigger_Config</code>	Enables or disables the trigger mode of buffered digital I/O to indicate when to start and stop the data acquisition.

Double-Buffered Digital I/O Functions

The double-buffered digital I/O (`DIG_DB`) functions perform double-buffered operations during Group Digital I/O operations.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

<code>DIG_DB_Config</code>	Enables or disables double-buffered digital transfer operations and sets the double-buffered options.
<code>DIG_DB_HalfReady</code>	Checks whether the next half buffer of data is available during a double-buffered digital block operation. You can use <code>DIG_DB_HalfReady</code> to avoid the possible waiting period that can occur because <code>DIG_DB_Transfer</code> waits until the data can be transferred before returning.

DIG_DB_Transfer

For an input operation, DIG_DB_Transfer waits until NI-DAQ can transfer half the data from the buffer being used for double-buffered digital block input to another buffer, which is passed to the function. For an output operation, DIG_DB_Transfer waits until NI-DAQ can transfer the data from the buffer passed to the function to the buffer being used for double-buffered digital block output. You can execute DIG_DB_Transfer repeatedly to read or write sequential half buffers of data.

Digital I/O Application Hints

This section gives a basic explanation of how to construct an application using the digital input and output functions. The flowcharts are a quick reference for constructing potential applications from the NI-DAQ function calls.

Handshaking Versus No-Handshaking Digital I/O

Digital ports can output or input digital data in two ways. The first is to immediately read or write data to or from the port. This type of digital I/O is called no-handshaking mode. The second method is to coordinate digital data transfers with another digital port. The second method is called digital I/O with handshaking. With handshaking, you use dedicated transmission lines to ensure that data on the receiving end is not overwritten with new data before it is read from the input port.

NI-DAQ supports both handshaking and no-handshaking modes. The application outlines within this section explain the use of both modes where they apply.

Digital Port I/O Applications

Digital port I/O applications use individual digital ports to input or output digital data. In addition, the applications input or output data points on an individual basis.

You can configure individual port transfers for handshaking or no-handshaking. All AT and PC devices with digital I/O ports can use no-handshaking digital port I/O. DIO-24, AT-MIO-16D, AT-MIO-16DE-10, DIO-96, and Lab and 1200 devices can also execute handshaking digital I/O for using the port I/O functions.

Figure 3-18 illustrates the series of calls for digital port I/O applications without handshaking. Figure 3-19 illustrates the series of calls for digital port I/O applications with handshaking.

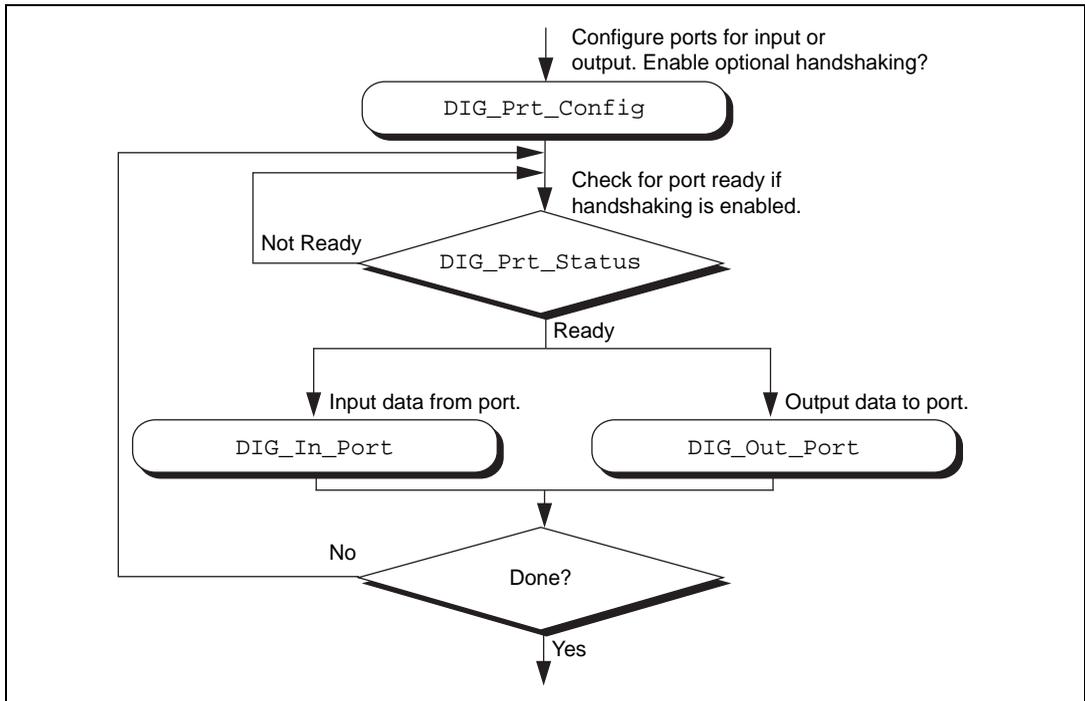


Figure 3-18. Basic Port Input or Output Application with Handshaking

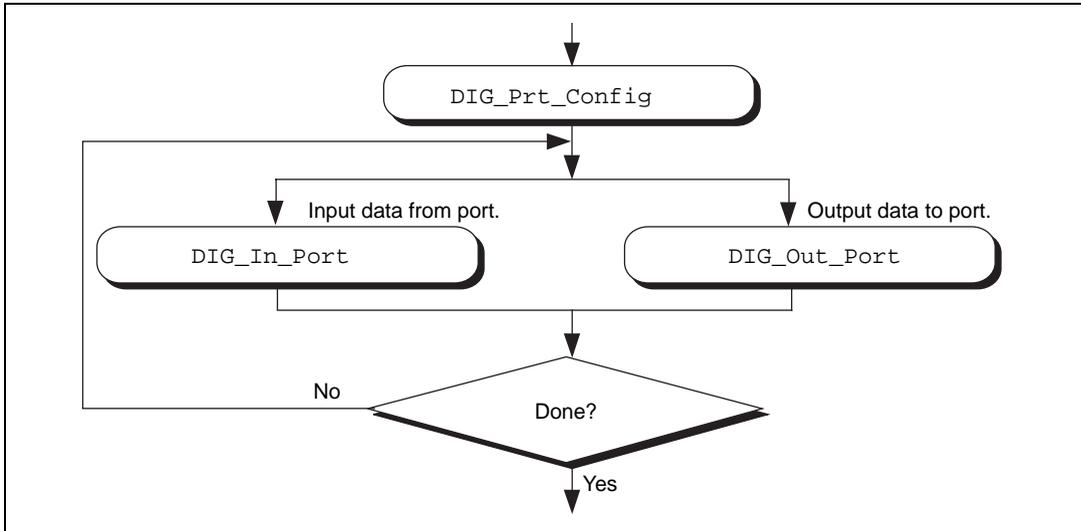


Figure 3-19. Basic Port Input or Output Application without Handshaking

The first step is to call `DIG_Prt_Config`, with which you configure the individual digital ports for input or output. Also, you use `DIG_Prt_Config` to enable handshaking.

If handshaking is disabled, do not check the port status (step 2 of Figure 3-19). If handshaking is enabled, call `DIG_PRT_Status` to determine if an output port is ready to output a new data point, or if an input port has latched new data.

The third step is to input or output the data point. Call `DIG_In_Port` to read data from an input port. Call `DIG_Out_Port` to write data to an output port.

The final step is to loop back if more data is to be input or output. These four steps form the basis of a simple digital port I/O application.

Digital Line I/O Applications

Digital line I/O applications are similar to digital port I/O applications, except that digital line I/O applications input or output data on a bit-by-bit basis rather than by port. The digital line I/O can only transfer data in no-handshaking mode.

Figure 3-20 is a flowchart outlining the basic line I/O application.

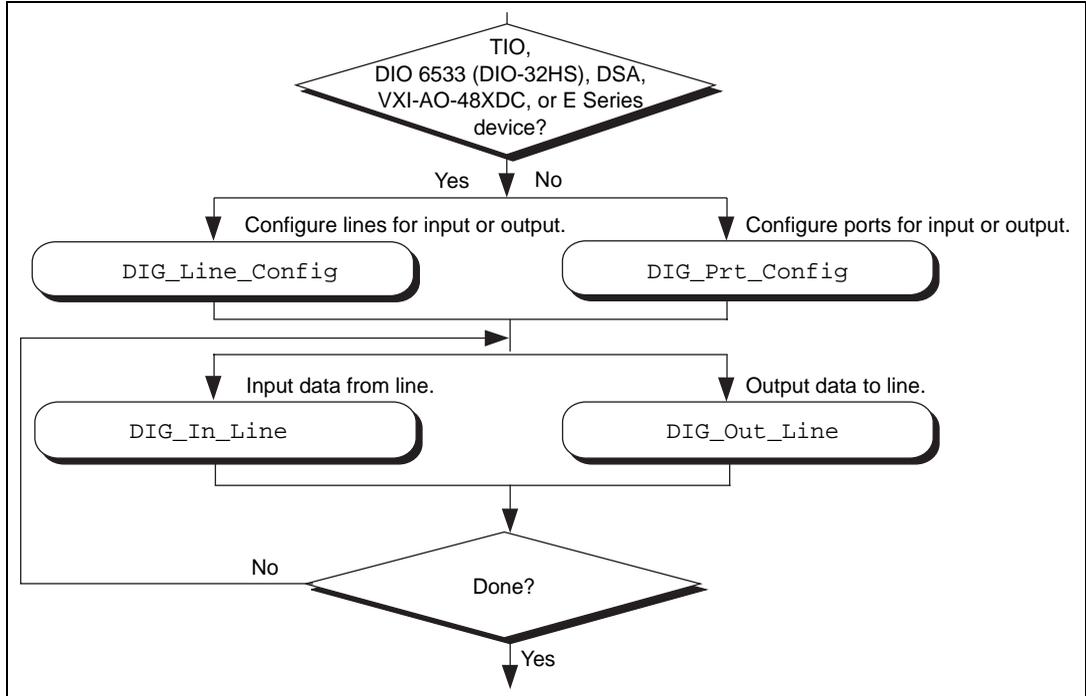


Figure 3-20. Basic Line Input or Output Application

First, configure the digital lines for input or output. You can program DIO 6533 (DIO-32HS) devices, PC-TIO-10, and E Series devices on an individual line basis. To do this, call `DIG_Line_Config`. You must configure all other devices on a port-by-port basis. As a result, you must configure all lines within a port for the same direction. Call `DIG_Prt_Config` to configure a port for input or output.

The next step is to call `DIG_In_Line` or `DIG_Out_Line` to output or input a bit from or to the line. The final step is to loop back until NI-DAQ has transferred all of the data.

Digital Group I/O Applications

Digital group I/O applications use one or more digital ports as a single group to input or output digital information.

Figure 3-21 is a flowchart for group digital applications that input and output data one point at a time. Only the DIO-32F and DIO 6533 (DIO-32HS) devices can execute group input or output one point at a time.

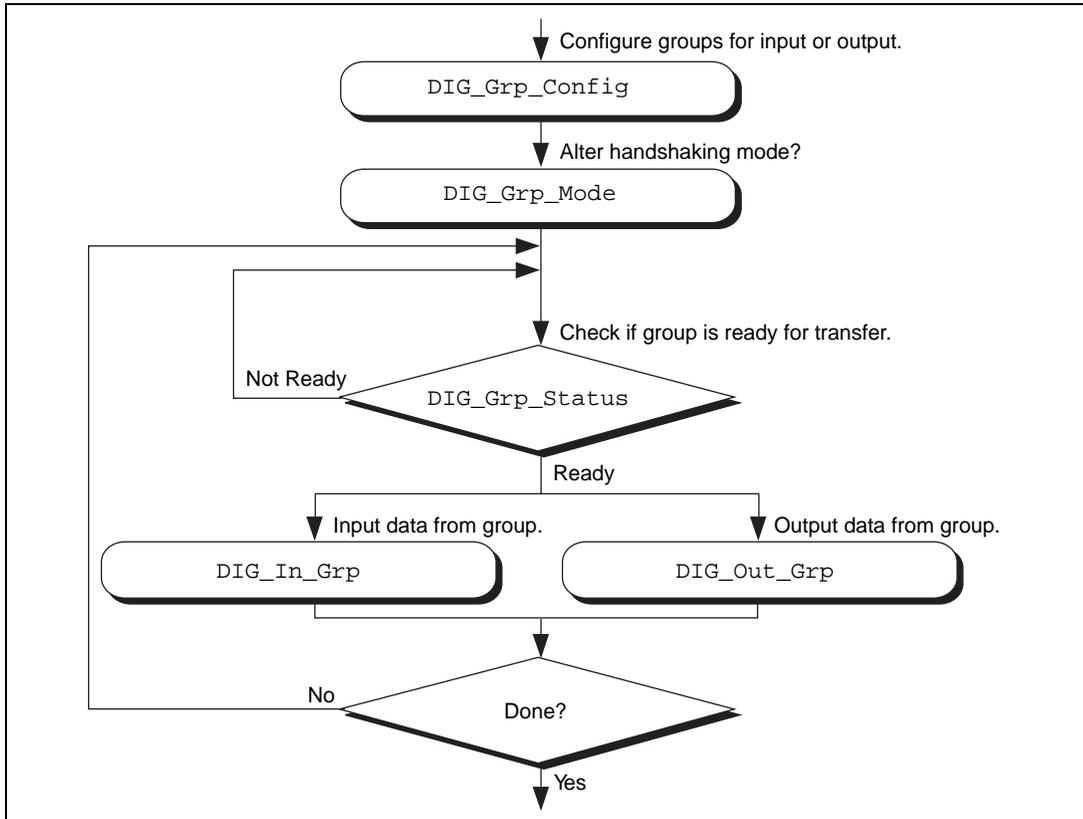


Figure 3-21. Simple Digital Group Input or Output Application

At the start of your application, call `DIG_Grp_Config` to configure the individual digital ports as a group. After the ports are grouped, call `DIG_Grp_Mode` (step 2 of Figure 3-21) to alter the handshaking mode of the DIO-32F and DIO 6533 devices. The various handshaking modes and the default settings are explained in the `DIG_Grp_Mode` function description.

The next step in your application is to check if the port is ready for a transfer (Step 3 of Figure 3-21). To do this, call `DIG_Grp_Status`. If the group status indicates it is ready, call `DIG_Out_Grp` or `DIG_In_Grp` to transfer the data to or from the group.

The final step of the flowchart is to loop back until all of the data has been input or output.

Digital Group Block I/O Applications

NI-DAQ also contains group digital I/O functions, which operate on blocks of data. Figure 3-22 outlines the basic steps for applications that use block I/O.

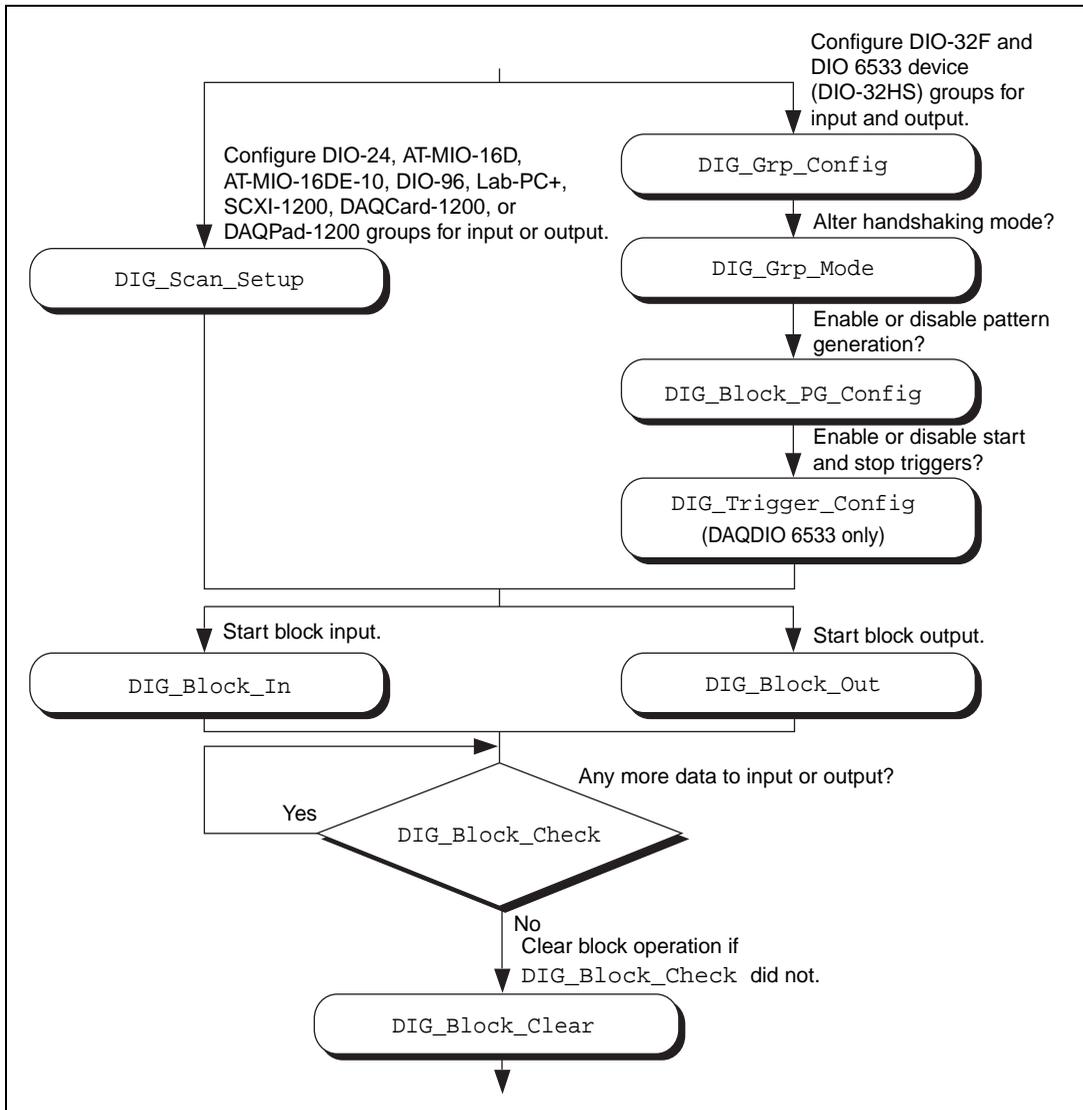


Figure 3-22. Digital Block Input or Output Application



Note:

The DIO-32F, DIO 6533 (DIO-32HS), DIO-24, AT-MIO-16D, AT-MIO-16DE-10, DIO-96, and Lab and 1200 devices all can perform group block operations. However, the DIO-24, AT-MIO-16D, AT-MIO-16DE-10, DIO-96, and Lab and 1200 devices have special wiring

requirements for groups larger than one port. The wiring for both the input and output cases for these devices is explained in the `DIG_SCAN_Setup` function description. No additional wiring is necessary for the `DIO-32F` and `DIO 6533 (DIO-32HS)` devices.

The first step for a group block I/O application is to call `DIG_Grp_Config` or `DIG_SCAN_Setup` to configure individual ports as a group. Call `DIG_Grp_Config` if you have a `DIO-32F` or a `DIO 6533` device. Call `DIG_SCAN_Setup` for all other devices. The `DIO-32F` is restricted to group sizes of two and four ports for block I/O.

If you are using a `DIO-32F` or `DIO 6533` device, you can either alter the handshaking mode of the group by calling `DIG_Grp_Mode` or perform digital pattern generation by calling `DIG_Block_PG_Config`, as shown in Figure 3-22. Pattern generation is simply reading in or writing out digital data at a fixed rate. This is the digital equivalent of analog waveform generation. To enable pattern generation, call `DIG_Block_PG_Config` as shown in Figure 3-22. You cannot handshake with pattern generation, so do not connect any handshaking lines. Refer to the explanation of pattern generation later in this chapter for more information.

The next step for your application, as illustrated in Figure 3-20, is to call `DIG_Block_In` or `DIG_Block_Out` to start the data transfer.

After you start the operation, you can call `DIG_Block_Check` to get the current progress of the transfer. If the block operation completes prior to a `DIG_Block_Check` call, `DIG_Block_Check` automatically calls `DIG_Block_Clear`, which performs cleanup work.

The final step of a digital block operation is to call `DIG_Block_Clear`. `DIG_Block_Clear` performs the necessary cleanup work after a digital block operation. You must call this function explicitly if `DIG_Block_Check` did not already call `DIG_Block_Clear`.



Note: `DIG_Block_Clear` *halts any ongoing block operation. Therefore, call `DIG_Block_Clear` only if you are certain the block operation has completed or you want to stop the current operation.*

Digital Double-Buffered Group Block I/O Applications

You also can configure group block operations as double-buffered operations for `DIO-32` devices. With double-buffered operations, you can do continuous input or output with a limited amount of memory.

See the *Double-Buffered I/O* section later in this chapter for an explanation of double buffering. Figure 3-23 outlines the basic steps for digital double-buffered group block I/O applications.

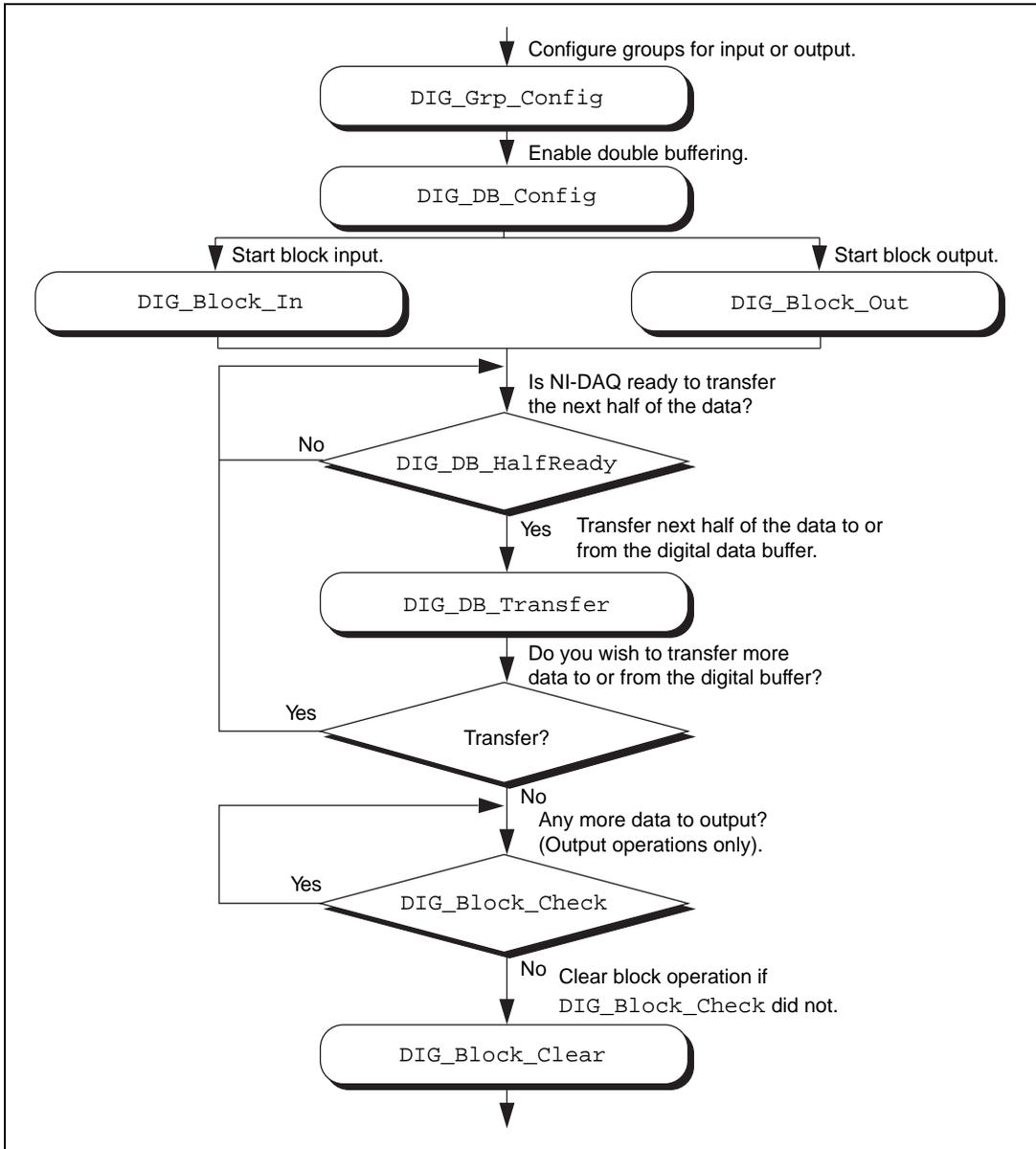


Figure 3-23. Double-Buffered Block Operation

The first step for an application is to call `DIG_Grp_Config` to configure individual ports as a group. Although the steps have been left out of the diagram, you can alter the handshaking mode and enable pattern generation as shown in Figure 3-22, and explained in the *Digital Group Block I/O Applications* section earlier in this chapter. Next, enable double buffering by calling `DIG_DB_Config` (second step of Figure 3-23). To start the digital block input or output, call `DIG_Block_In` or `DIG_Block_Out`.

After the operation has started, you can perform unlimited transfers to or from the circular buffer. Input operations transfer new data from the digital buffer for storage or processing. Output operations transfer new data to the digital buffer for output.

To transfer to or from the circular buffer, call the `DIG_DB_Transfer` function. After you call the function, NI-DAQ waits until it can transfer the data before returning to the application. To avoid the waiting period, call `DIG_DB_HalfReady` to determine if NI-DAQ can make the transfer immediately. If `DIG_DB_HalfReady` indicates that NI-DAQ is not ready for a transfer, your application can do other processing and check the status later.

After the final transfer, you can call `DIG_Block_Check` to get the current progress of the transfer. For example, if you are using double-buffered output, NI-DAQ requires some time after the final transfer to actually output the data. In addition, if NI-DAQ completes the block operation prior to a `DIG_Block_Check` call, `DIG_Block_Check` automatically calls `DIG_Block_Clear` to perform clean-up work.

The final step of a double-buffered block operation is to call `DIG_Block_Clear`. `DIG_Block_Clear` performs the necessary clean-up work after a digital block operation. You must explicitly call this function if `DIG_Block_Check` did not already call it.



Note: `DIG_Block_Clear` *halts any ongoing block operation. Therefore, call `DIG_Block_Clear` only if you are certain the block operation is complete or if you want to stop the current operation.*

Pattern Generation I/O with the DIO-32F and DIO 6533 (DIO-32HS) Devices

Use pattern generation for clocked digital I/O when you have a port that is written to or read from based on the output of a counter. The `DIG_Block_PG_Config` function enables the pattern generation mode of digital I/O. When pattern generation is enabled, a subsequent `DIG_Block_In` or `DIG_Block_Out` call automatically uses this mode. Each group has its own onboard counter so that each can simultaneously run in this mode at different rates. Also, use an external counter by connecting its output to the appropriate REQ pin at the I/O connector. For an input group, pattern generation is analogous to a data acquisition operation, but instead of reading analog input channels, NI-DAQ reads the digital ports. For an output group, pattern generation is analogous to waveform generation, but instead of writing voltages to the analog output channels, NI-DAQ writes digital patterns to the digital ports.

The DIO-32F and AT-DIO-32HS use DMA to service pattern generation. However, certain buffers require NI-DAQ to reprogram the DMA controller during the pattern generation. The extra time needed to reprogram increases the minimum request interval (thus decreasing the maximum rate unless you use dual DMA). Refer to Chapter 4, *DMA and Programmed I/O Performance Limitations*, for more information.



Note:

For the AT-DIO-32F, `DIG_Block_In` and `DIG_Block_Out` return a warning if it is necessary to reprogram the DMA controller. Also, page boundaries in a buffer that is to be used for 32-bit digital pattern generation cause unpredictable results for AT bus computer users, regardless of the request interval used.

For the DIO-32F, another option is to use the utility function `Align_DMA_Buffer` to avoid the negative effects of page boundaries in the following cases:

- When using digital I/O pattern generation at small request intervals for buffers with page boundaries
- When using 32-bit digital I/O pattern generation at any speed

To use `Align_DMA_Buffer`, however, you must allocate a buffer that is larger than the sample count to make room for `Align_DMA_Buffer` to move the data around. When the buffer is aligned, make the normal calls to `DIG_Block_In` and `DIG_Block_Out`. A call to `DIG_Block_Clear` (either directly or indirectly through `DIG_Block_Check`) unaligns

the data buffer if the data buffer was previously aligned by a call to `Align_DMA_Buffer`. To use the `Align_DMA_Buffer` utility function, follow these steps:

1. Allocate a buffer twice as large as the number of data samples you are generating.
2. If you are using digital output, build your digital pattern in the buffer.
3. Call `DIG_Grp_Config` for port assignment.
4. Call `DIG_Block_PG_Config` to enable pattern generation.
5. Call `Align_DMA_Buffer`, as described in the *Function Reference* chapter of the NI-DAQ Function Reference Manual.
6. Call `DIG_Block_In` or `DIG_Block_Out` with the aligned buffer to initiate the process.
7. Call `DIG_Block_Clear` after the pattern generation completes.
8. Because `DIG_Block_Clear` unaligns the buffer, you can access the digital input pattern generation as you can with an unaligned buffer. To use the same buffer again for digital output pattern generation, you must call `Align_DMA_Buffer` again.

Double-Buffered I/O

With the double-buffered (`DIG_DB`) digital I/O functions, you can input or output unlimited digital data without requiring unlimited memory. Double-buffered digital I/O is useful for applications such as streaming data to disk and sending long data streams as output to external devices. For an explanation of double-buffering, refer to Chapter 5, *NI-DAQ Double Buffering*.

Digital double-buffered output operations have two options. The first option is to stop the digital block operation if old data is ever encountered. This occurs if the `DIG_DB_Transfer` function calls are not keeping pace with the data input or output rate; that is, new data is not transferred to or from the circular buffer quickly enough. For digital input, this option prevents the loss of incoming data. For digital output, this option prevents erroneous data from being transferred to an external device. If the group is configured for handshaking, an old data stop is only a pause and a call to one of the transfer functions resumes the digital operation. For pattern generation, an old data stop forces you to clear and restart the block operation.

The second option, available only to output groups, is the ability to transfer data that is less than half the circular buffer size to the circular buffer. This option is useful when long digital data streams are being output but the size of the data stream is not evenly divisible by the size of half of the circular buffer. This option imposes the restriction that the double-buffered digital block output is halted when a partial block of data has been output. This means that the data from the first call to `DIG_DB_Transfer` with a count less than half the circular buffer size is the last data output by the device.

Notice, however, that enabling either of the double-buffered digital output options causes an artificial split in the digital block buffer, requiring DMA reprogramming at the end of each half buffer. For a group that is configured for handshaking, such a split means that a pause in data transfer can occur while NI-DAQ reprograms the DMA. For a group configured for pattern generation, this split can cause glitches in the digital input or output pattern (time lapses greater than the programmed period) during DMA reprogramming. Therefore, you should enable these options only if necessary. Both options can be enabled or disabled by the `DIG_DB_Config` function.



Note: *EISA chaining is disabled if partial transfers are enabled.*

The Counter/Timer Function Group

The Counter/Timer function group contains three sets—the Counter/Timer (`CTR`) functions, which perform timing I/O and counter operations such as pulse generation, frequency generation, and event counting; the Interval Counter/Timer (`ICTR`) functions, which perform interval timing I/O and counter operations; and General-Purpose Counter/Timer (`GPCTR`) functions, which perform various counting and timing operations.

Device Support for the Counter/Timer and Interval Counter/Timer Functions

Use the Counter/Timer (`CTR`) functions with the following devices:

- Am9513-based MIO devices
- PC-TIO-10

Use the Interval Counter (ICTR) functions with the following devices:

- 516 devices
- DAQCard-500/700
- Lab and 1200 devices
- LPM devices

Use the General-Purpose Counter/Timer (GPCTR) functions with the E Series devices. Refer to the GPCTR functions in the NI-DAQ Function Reference Manual for a detailed description of how to use the GPCTR functions for a variety of applications.

Counter/Timer Functions

The Counter/Timer (CTR) functions perform counting timing I/O and timing counter operations on the Am9513-based MIO devices and the PC-TIO-10:

CTR_Config	Specifies the counting configuration to use for a counter.
CTR_EvCount	Configures the specified counter for an event-counting operation and starts the counter.
CTR_EvRead	Reads the current counter total without disturbing the counting process and returns the count and overflow conditions.
CTR_FOUT_Config	Disables or enables and sets the frequency of the 4-bit programmable frequency output.
CTR_Period	Configures the specified counter for period or pulse-width measurement.
CTR_Pulse	Causes the specified counter to generate a specified pulse-programmable delay and pulse width.
CTR_Rate	Converts frequency and duty-cycle values of a square wave you want into

the timebase and period parameters needed for input to the `CTR_Square` function that produces the square wave.

<code>CTR_Reset</code>	Turns off the specified counter operation and places the counter output drivers in the selected output state.
<code>CTR_Restart</code>	Restarts the specified counter operation.
<code>CTR_Simul_Op</code>	Configures and simultaneously starts and stops multiple counters.
<code>CTR_Square</code>	Causes the specified counter to generate a continuous square wave output of specified duty cycle and frequency.
<code>CTR_State</code>	Returns the OUT logic level of the specified counter.
<code>CTR_Stop</code>	Suspends operation of the specified counter so that NI-DAQ can restart the counter operation.

Counter/Timer Operation for the CTR Functions

Figure 3-24 shows the 16-bit counters available on the Am9513-based MIO devices and PC-TIO-10.

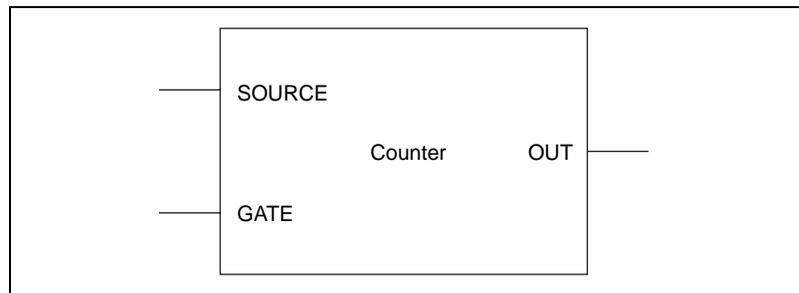


Figure 3-24. Counter Block Diagram

Each counter has a `SOURCE` input, a `GATE` input, and an output labeled `OUT`.

The counters can use several timebases for counting operations. A counter can use the signal supplied at any of the Am9513 five SOURCE or GATE inputs for counting operations. The Am9513 also makes available five internal timebases that any counter can use:

- 1 MHz clock (1 μ s resolution)
- 100 kHz clock (10 μ s resolution)
- 10 kHz clock (100 μ s resolution)
- 1 kHz clock (1 ms resolution)
- 100 Hz clock (10 ms resolution)



Note:

A 5 MHz internal timebase (200 ns resolution) is also available on SOURCE 2 of the Am9513 on the MIO-F-5/16X devices, SOURCE 5 for counters 1 to 5, and SOURCE 10 for counters 6 to 10 on the PC-TIO-10.

You can also program the counter to use the output of the next lower-order counter as a signal source. This arrangement is useful for counter concatenation. For example, you can program counter 2 to count the output of counter 1, thus creating a 32-bit counter.

You can configure a counter to count either falling or rising edges of the selected internal timebase, SOURCE input, GATE input, or next lower-order counter signal.

You can use the counter GATE input to gate counting operations. After you software-configure a counter for an operation, a signal at the GATE input can start and stop the counter operation. There are nine gating modes available in the Am9513:

- No Gating—Counter is started and stopped by software.
- High-Level Gating—Counter is active when its gate input is at high-logic state. The counter is suspended when its gate input is at low-logic state.
- Low-Level Gating—Counter is active when its gate input is at low-logic state. The counter is suspended when its gate input is at high-logic state.
- Rising Edge Gating—Counter starts counting when it receives a low-to-high edge at its gate input.
- Falling Edge Gating—Counter starts counting when it receives a high-to-low edge at its gate input.

- High Terminal Count Gating—Counter is active when the next lower-order counter reaches terminal count (TC) and generates a TC pulse.
- High-Level Gate N+1 Gating—Counter is active when the gate input of the next higher-order counter is at high-logic state. Otherwise, the counter is suspended.
- High-Level Gate N-1 Gating—Counter is active when the gate input of the next lower-order counter is at high-logic state. Otherwise, the counter is suspended.
- Special Gating—The gate input selects the reload source but does not start counting. The counter uses the value stored in its internal Hold register when the gate input is high, and uses the value stored in its internal Load register when the gate input is low.

Counter operation starts and stops relative to the selected timebase. When a counter is configured for no gating, the counter starts at the first timebase/source edge (rising or falling, depending on the selection) after the software configures the counter. When a counter is configured for gating modes, gate signals take effect at the next timebase/source edge. For example, if a counter is configured to count rising edges and to use the falling edge gating mode, the counter starts counting on the next rising edge after it receives a high-to-low edge on its GATE input. Thus, some time is spent synchronizing the GATE input with the timebase/source. This synchronization time creates a time lapse uncertainty from 0 to 1 timebase period between the signal application at the GATE input and the start of the counter operation.

The counter generates timing signals at its OUT output. If the counter is not operating, you can set its output to one of three states—high-impedance state, low-logic state, or high-logic state.

The counters generate two types of output signals during counter operation—TC pulse output and TC toggled output. A counter reaches TC when it counts up (to 65,535) or down (to 0) and rolls over. In many counter applications, the counter reloads from an internal register when it reaches TC. In TC pulse output mode, the counter generates a pulse during the cycle in which it reaches TC. In TC toggled output mode, the counter output changes state on the next source edge after reaching TC. In addition, you can configure the counters for positive logic output or negative (inverted) logic output. Figure 3-25 shows examples of the four types of output signals generated.

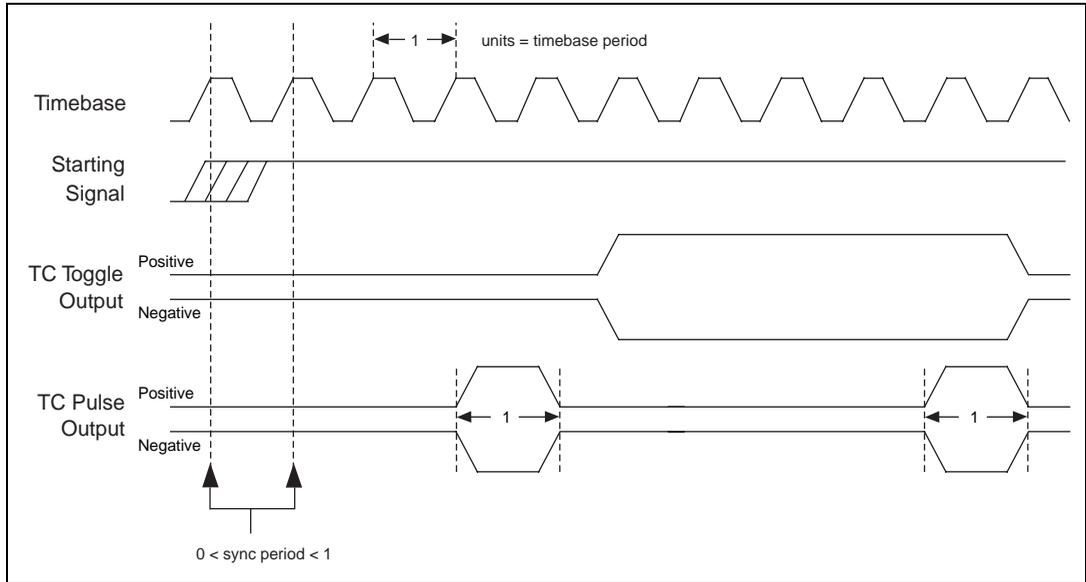


Figure 3-25. Counter Timing and Output Types

Figure 3-25 represents a counter generating a delayed pulse (see `CTR_Pulse`) and demonstrates the four forms the output pulse can take given the four different types of output signals supported. The TC toggled positive logic output looks like what is expected when generating a pulse. For most of the Counter/Timer functions, TC toggled output is the preferred output configuration; however, the other signal types are also available. The starting signal, shown in Figure 3-25, represents either a software starting of the counter, for the no-gating case, or some sort of signal at the GATE input. The signal is either a rising edge gate or a high-level gate. If the signal is a low-level or falling edge gate, the starting signal simply appears inverted. In Figure 3-25, the counter is configured to count the signal output changes with respect to the rising edge of the timebase.

Programmable Frequency Output Operation

The Am9513-based MIO devices and PC-TIO-10 provide a 4-bit programmable frequency output signal. This signal is a divided-down version of the selected timebase. Any of five internal timebases, counter SOURCE inputs, and counter GATE inputs can be selected as the FOUT source. See the `CTR_FOUT_Config` function description in the NI-DAQ Function Reference Manual for FOUT use and timing information.

Counter/Timer Application Hints

All NI-DAQ counter/timer functions can be broken down into two major categories—event-counting functions and pulse generation functions. On top of those functions, NI-DAQ has utility functions.

CTR_EvCount and CTR_EvRead are the two functions designed for event-counting. See Figure 3-26 for basic building blocks of event-counter applications. Also, read *Event-Counting Applications* later in this chapter for details.

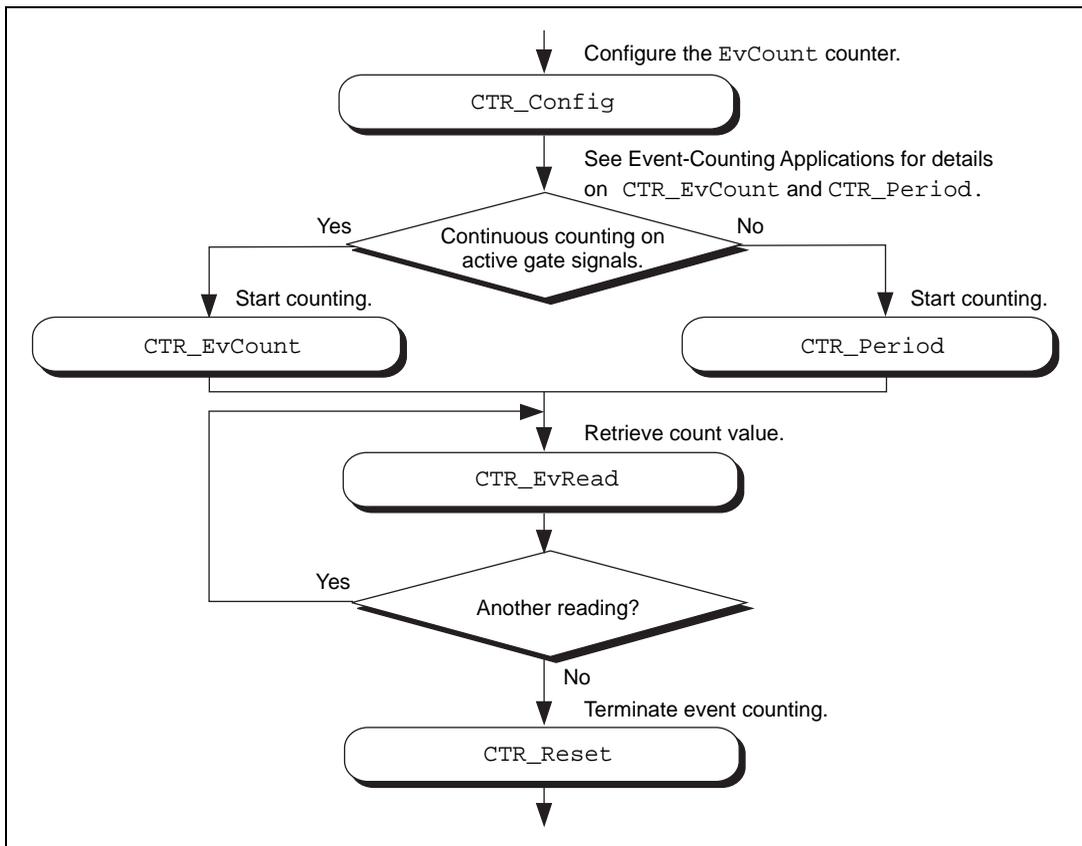


Figure 3-26. Event Counting

Another major category of counter functions is pulse generation. With the NI-DAQ counter functions, you can call CTR_Pulse to generate a pulse or CTR_Square to generate a train of pulses (a square wave). To generate a pulse or a square wave, see Figure 3-27 for details on the

function flow. When `CTR_Square` is used with special gating (`gateMode = 8`), you can achieve gate-controlled pulse generation. When the gate input is high, NI-DAQ uses **period1** to generate the pulses. When the gate input is low, NI-DAQ uses **period2** to generate the pulses. If the output mode is TC Toggled, the result is two 50 percent duty square waves of different frequencies. If the output mode is TC Pulse, the result is two pulse trains of different frequencies.

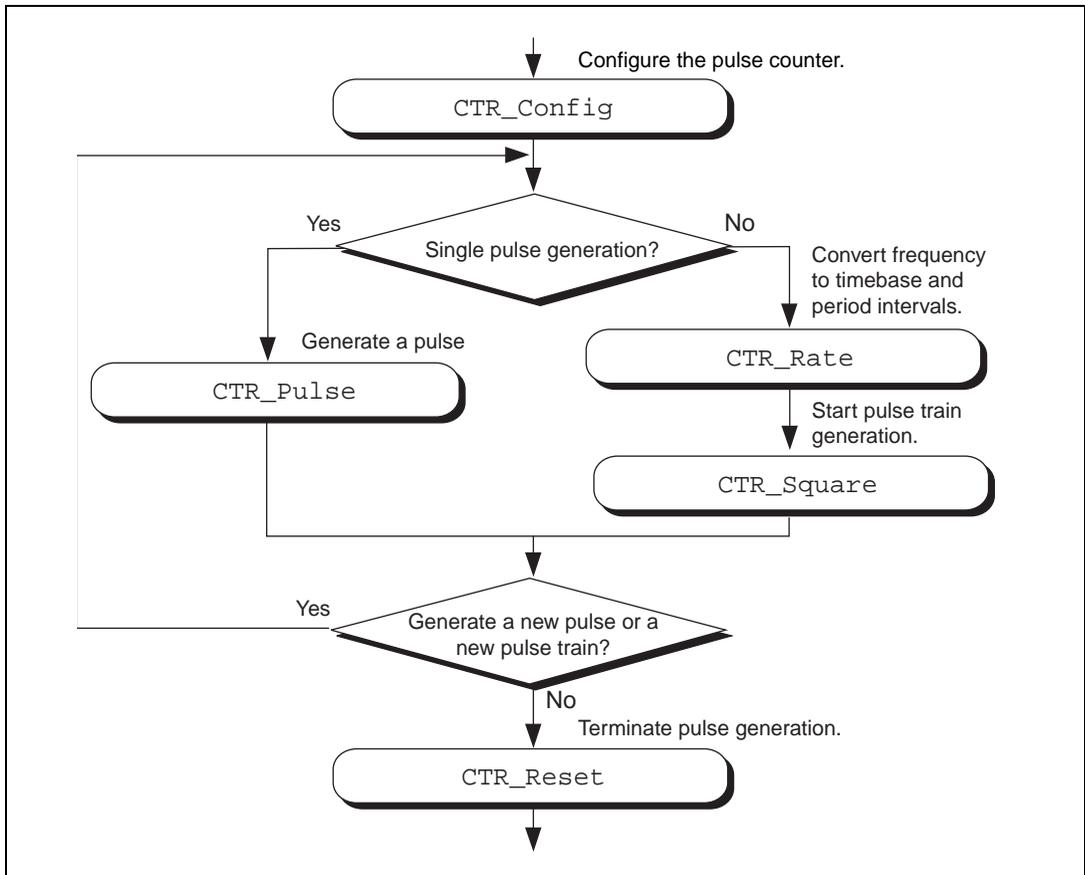


Figure 3-27. Pulse Generation

Another type of gated pulse generation can be called *retriggerable one-shot pulse*, where a signal pulse is produced in response to a hardware trigger. To do this, call `CTR_Config` and specify edge gating. Connect your trigger signal to the GATE input. Call `CTR_Square` to specify your pulse. Subsequently, each edge sent to the GATE input produces one cycle of the square wave.

Besides `CTR_Square`, you also can call `CTR_FOUT_Config` to generate a square wave. The advantage of using `CTR_FOUT_Config` is that it does not use a counter to generate the square wave. It uses a different built-in feature of the counter/timer chip. However, unlike `CTR_Square`, `CTR_FOUT_Config` can only generate a square wave with a 50 percent duty cycle.

NI-DAQ has a number of utility functions that give you more control over the counters. `CTR_State` is for checking the logic level of any counter output. `CTR_Reset` halts any operation on a counter and puts the counter output to a known state. `CTR_Stop` and `CTR_Restart` stop and restart any operation on a counter. `CTR_Simul_Op` simultaneously can start, stop, and restart any number of counters. Also, `CTR_Simul_Op` simultaneously can save all the current counter values to their hold registers, which you can read later, one at a time. See Figure 3-28 on how to incorporate `CTR_Simul_Op` with other counter functions like `CTR_EvCount` and `CTR_Pulse`.

Am9513-based MIO device counter configuration settings applied through `CTR_Config` persist when waveform generation functions use the same counter. It is possible, for example, to configure the gating mode of a counter that can be used for waveform generation later so that you can externally trigger the operation with a pulse to the counter's gate. See the `CTR_Config` function in the NI-DAQ Function Reference Manual for more details.

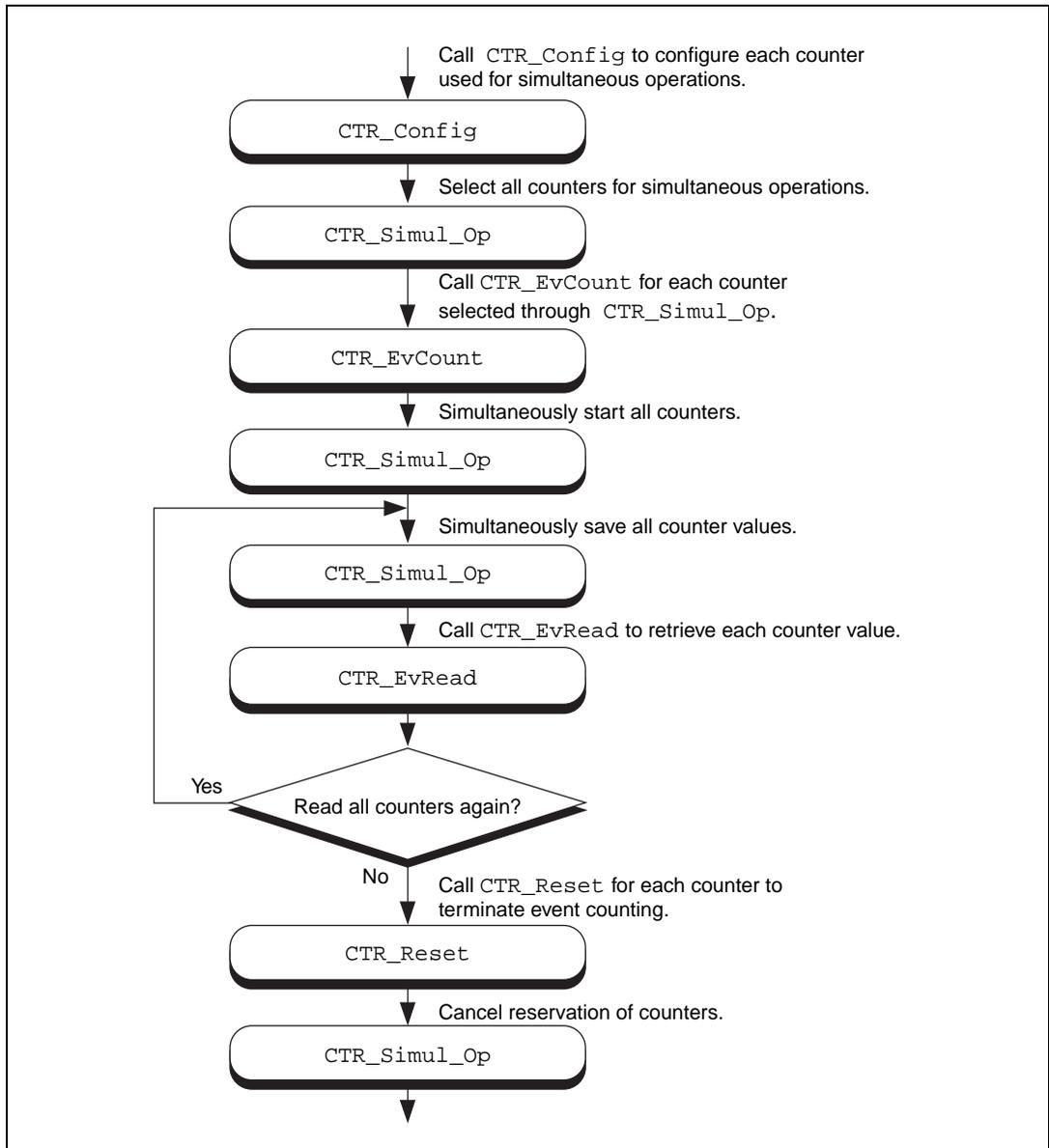


Figure 3-28. Simultaneous Counter Operation

Event-Counting Applications

CTR_EvCount and CTR_EvRead work with four types of event-counting/timing measurements—event counting, pulse-width measurement, time-lapse measurement, and frequency measurement. CTR_EvCount also supports the concatenation of counters so that you can obtain 32-bit or 48-bit resolution for these measurements.

For event-counting applications, the events counted are the signal transitions or edges of an input SOURCE signal; therefore, you should set **timebase** to a value from 6–10. NI-DAQ can count either low-to-high or high-to-low edges (this feature is selected by **edgeMode** in the CTR_Config function). In addition, you can use the various gating modes of CTR_Config to control counting. Figure 3-29 illustrates timer event counting.

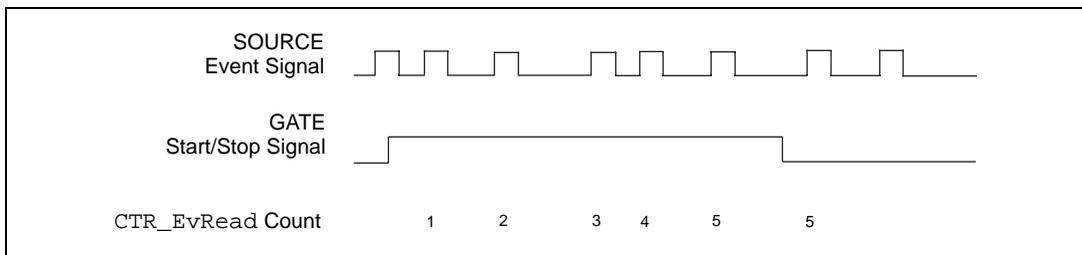


Figure 3-29. Timer Event Counting

For pulse-width measurement, configure a counter to count for the duration of a pulse. For this application, you can use any timebase, including an external clock connected to the counter SOURCE input. Use level gating modes for pulse-width measurements in which the pulse to be measured is connected to the counter GATE input. Pulse width is then equal to (event count) * (timebase period). Figure 3-30 shows a typical pulse-width measurement.

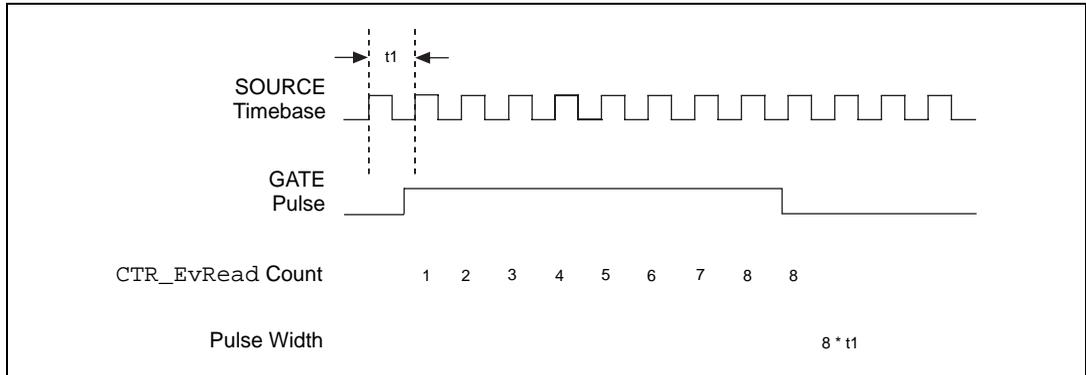


Figure 3-30. Pulse-Width Measurement

For time-lapse measurement, configure a counter to count from the occurrence of some event. For this application, you can use any timebase, including an external clock connected to the counter SOURCE input. You can use edge-triggered gating modes if a single counter performs the event counting and if **cont** = 0. In this case, the starting event is an edge applied to the GATE input of the counter. The time lapse from the edge is then equal to (event count) * (timebase period). If counters are to be concatenated for time-lapse measurement, use level gating where the GATE input signal goes active at the starting event and stays active.

Frequency measurement is a special case of event counting; that is, you can measure the frequency of an input signal by counting the number of signal edges that occur during a fixed amount of time. For this application, connect the signal to be measured to the SOURCE input of the counter and select the appropriate timebase (if **ctr** = 1, connect the signal to SOURCE1 and use **timebase** = 6). Count either low-to-high or high-to-low edges (this feature is selected by **edgeMode** in the **CTR_Config** function). Using level gating and applying a gate pulse of a known, fixed duration to the GATE input of the counter constrains event counting to a fixed amount of time. The average frequency of the incoming signal is then equal to (event count)/(gate pulse width). Another MIO-16 counter can supply the gating pulse for frequency measurement by connecting the OUT signal from the counter producing the gating pulse to the GATE input of the counter doing the counting (see the **CTR_Pulse** function in the NI-DAQ Function Reference Manual for more information). Figure 3-31 illustrates a frequency measurement.

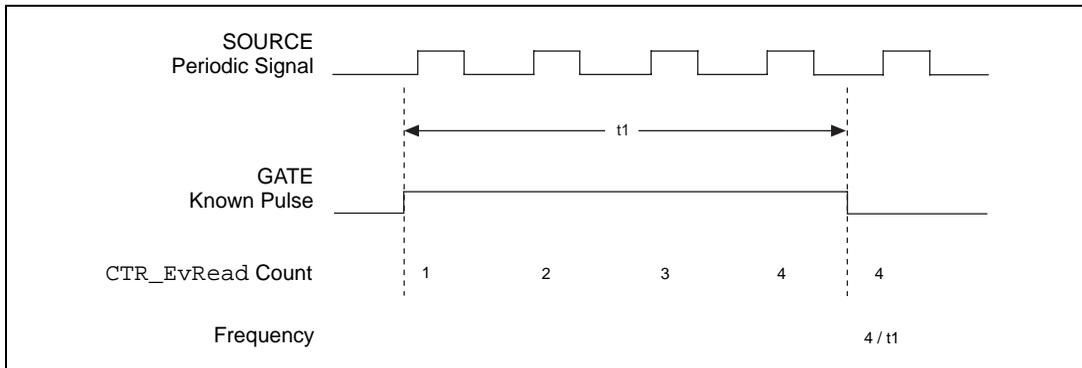


Figure 3-31. Frequency Measurement

For 16-bit resolution event counting and pulse-width, time-lapse, or frequency measurement, you only need one counter. Select **cont** = 0 so that you are notified if the counter overflows (see the `CTR_EvRead` function in the NI-DAQ Function Reference Manual). You can use any gating mode. In addition, select **TC** toggled output type and positive output polarity during the `CTR_Config` call so that overflow detection works properly.

For greater than 16-bit resolution, you can concatenate two or more counters. Configure a low-order counter to count the incoming edges or to measure the incoming pulse. Connect the **OUT** signal of the low-order counter to the **SOURCE** input of the next high-order counter by specifying a **timebase** of 0 for the next high-order counter. Configure the next high-order counter to count once every time the low-order counter rolls over. You can connect the **OUT** signal of the next high-order counter to the **SOURCE** input of an additional counter. The last counter (referred to as the high-order counter) will perform overflow detection. The lower-order counters increment continuously and generate output pulses when they roll over.

For 32-bit counting, use two counters. For 48-bit counting, use three counters, and so on. The counter configurations for concatenated event counting are as follows:

- Low-order counter configuration
 - gateMode:** either level gating or no gating
 - edgeMode:** any value
 - outType:** TC pulse output type
 - outPolarity:** positive polarity

- timebase:** any value

cont = 1: continuous counting
- Intermediate counter configuration

edgeMode: count rising edges (indicates that the low-order counter rolled over)

gateMode: no gating

outType: TC pulse output type

outPolarity: positive polarity

timebase = 0: counts lower-order counter output

cont = 1: continuous counting
- High-order counter configuration

edgeMode: count rising edges (indicates that the low-order counter rolled over)

gateMode: no gating

outType: TC-toggled output type (for proper overflow detection)

outPolarity: positive polarity

timebase = 0: counts lower-order counter output

cont = 0: counter stops on overflow

Period and Continuous Pulse-Width Measurement Applications

With the proper use of `CTR_Config`, `CTR_Period`, and `CTR_EvRead`, you can configure a counter to make period or continuous pulse-width measurements.

To make a period measurement, call `CTR_Config` with **gateMode** set to either rising or falling edge-triggered gating (3 or 4). With rising edge-triggered gating, a counter can measure the time interval (t_1 in Figure 3-31) between two rising edges of the gate signal. With falling edge-triggered gating, a counter can measure the time interval between two falling edges of the gate signal. After you call `CTR_Config` and apply the signal being measured to the appropriate gate, you can call `CTR_Period` to initiate period measurement. The specified counter starts counting on the first gate edge and latches the counter value to the onboard Hold Register after the counter detects a second gate edge. After each period measurement, the counter reloads itself with a 0 and

starts a new measurement. Figure 3-32 shows a continuous period measurement.

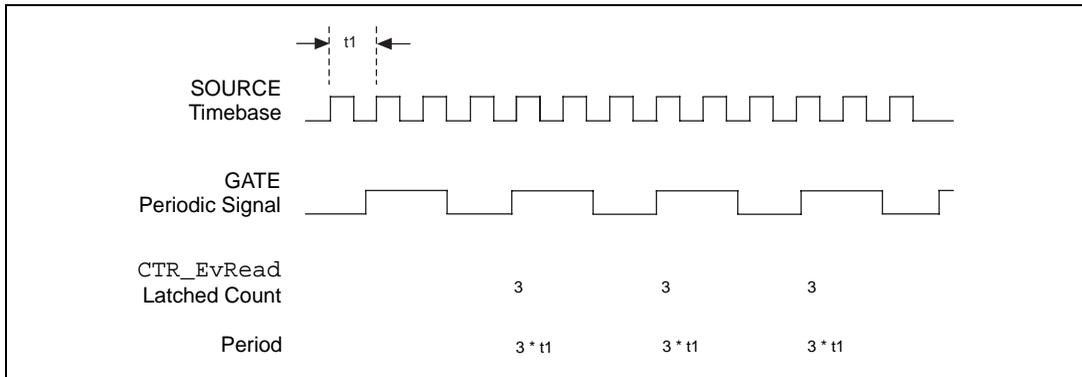


Figure 3-32. Continuous Period Measurement

While the measurement is occurring, call `CTR_EvRead` to retrieve the counter value saved in the Hold Register. The period is then equal to the value returned by `CTR_EvRead * timebase`.

If you choose an improper timebase frequency, `CTR_EvRead` retrieves a smaller count value. A small count indicates that the timebase frequency is either too low or too high compared to the gate signal. If the timebase frequency is too low, the counter can only count a few source edges. However, if the timebase frequency is too high, the counter counts too many source edges, causing counter overflow. In case of counter overflow, a small count (typically 1 or 2) is saved on the Hold Register, and the counter reloads itself with a zero and waits for a new gate trigger to make a new measurement.

For a pulse-width measurement, use the same NI-DAQ calls used for period measurement, except that you should set **gateMode** to high-level or low-level gating (1 or 2). With high-level gating, a counter can measure the duration of a positive pulse. With low-level gating, a counter can measure the duration of a negative pulse. After you call `CTR_Period`, the counter starts counting after the gate becomes active. When the gate becomes inactive, the counter value latches to the Hold Register. You then can call `CTR_EvRead` to retrieve the saved value. Pulse width is then equal to the value returned by `CTR_EvRead * timebase`. When the counter value is latched to the Hold Register, the counter reloads itself with a zero and waits for the gate to go active to begin a new measurement.

For measuring pulse-width, you need a rough estimate of the duration of the pulse being measured. When you configure a counter to measure pulse width, the counter continues counting in case of overflow. No counter value is latched to the Hold Register until the gate signal becomes inactive. To detect the counter overflow, feed the output of the pulse-width measurement counter to the source input of an event-counting counter. If the event-counting counter value is not zero after the pulse-width measurement, the pulse-width measurement is not correct.

The Interval Counter/Timer Functions

The Interval Counter/Timer functions perform interval timing I/O and counter operations on the 516 devices, DAQCard-500/700, Lab and 1200 devices, and LPM devices.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

ICTR_Read	Returns the current contents of the selected counter without disturbing the counting process and returns the count.
ICTR_Reset	Sets the output of the selected counter to the specified state.
ICTR_Setup	Configures the assigned counter to operate in the specified mode.

Interval Counter/Timer Operation for the ICTR Functions

Figure 3-33 shows the 16-bit counters on the 516 devices, DAQCard-500/700, Lab and 1200 devices, and LPM devices.

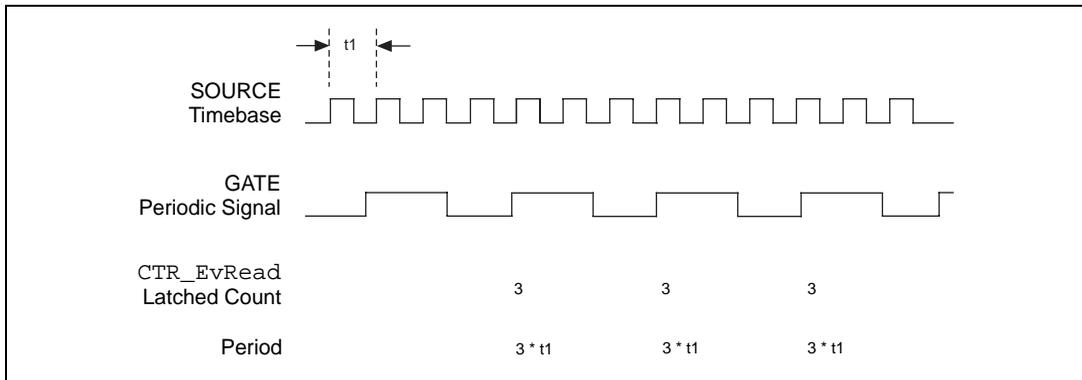


Figure 3-33. Interval Counter Block Diagram

Each counter has a clock input, a gate input, and an input signal output. Use a counter to count the falling edges of the signal applied to the CLK input. The counter gate input gates counting operations. If your device uses an 8253 or MSM82C54 chip, refer to the data sheet in your device-specific manual to see how the gate inputs affect the counting operation in different counting modes.

Interval Counter/Timer Application Hints

NI-DAQ interval counter functions interface to the six different counting modes of 8253 counter chips on these devices. To choose the mode of operation, call `ICTR_Setup`. Refer to the `ICTR_Setup` function description in the NI-DAQ Function Reference Manual for descriptions of all six different counter modes.

After a counter is armed with `ICTR_Setup`, call `ICTR_Read` to retrieve the current counter value. Furthermore, to halt any counter operation, call `ICTR_Reset`.

The General-Purpose Counter/Timer Functions

The General-Purpose Counter/Timer (GPCTR) functions perform counting and timing operations on the E Series and PCI-44xx devices.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

`GPCTR_Change_Parameter` Customizes the counter operation to fit the requirements of your application by selecting a specific parameter setting.

<code>GPCTR_Configure_Buffer</code>	Assigns the buffer that NI-DAQ uses for a buffered counter operation.
<code>GPCTR_Control</code>	Controls the operation of the general-purpose counter.
<code>GPCTR_Set_Application</code>	Selects the application for which you uses the general-purpose counter. The function description in the NI-DAQ Function Reference Manual contains many application hints.
<code>GPCTR_Watch</code>	Monitors the state of the general-purpose counter and its operation.

The General-Purpose Counter/Timer Application Hints

The General-Purpose Counter/Timer (GPCTR) functions perform a variety of event counting, time measurement, and pulse and pulse train generation operations, including buffered operations. To learn more about the GPCTR functions, read the introduction to the description of the `GPCTR_Set_Application` function in the *Function Reference* chapter of the NI-DAQ Function Reference Manual, and sections that pertain to the applications you want to perform with the counter. Then refer to other GPCTR function descriptions for details.

The RTSI Bus Trigger Functions

The Real-Time System Integration (RTSI) Bus Trigger functions connect and disconnect signals over the RTSI bus trigger lines.

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

<code>RTSI_Clear</code>	Disconnects all RTSI bus trigger lines from signals on the specified device.
<code>RTSI_Clock</code>	Connects or disconnects the system clock from the RTSI bus.
<code>RTSI_Conn</code>	Connects a device signal to the specified RTSI bus trigger line.

RTSI_DisConn	Disconnects a device signal from the specified RTSI bus trigger line.
Select_Signal	Connects or disconnects a device signal to a RTSI bus trigger line).

Refer to the *NI-DAQ Function Support* appendix in the NI-DAQ Function Reference Manual to determine if your device supports RTSI.

The RTSI Bus

The RTSI bus is implemented via a 34-pin ribbon cable connector on the AT, NEC, and PCI E Series devices. The RTSI bus is implemented on VXI-DAQ devices using the VXIbus trigger lines. On PXI DAQ devices, the RTSI bus is implemented using PXI trigger bus lines. The RTSI bus has a 7-wire trigger bus. Each device that works with a RTSI bus interface contains a number of useful signals that can be driven onto, or received from, the trigger lines. Each device is equipped with a switch with which an onboard signal is connected to any one of the RTSI bus trigger lines through software control. By programming one device to drive a particular trigger line and another device to receive from the same trigger line, you can hardware connect the two devices. Use the RTSI Bus Trigger functions described in this chapter for this type of programmable signal interconnection between devices.

Through the RTSI bus, you can trigger one device from another device, share clocks and signals between devices, and synchronize devices to the same signals. The RTSI bus also can connect signals on a single device.

To specify the signals on each device that you can connect to the RTSI bus trigger lines, each device signal is assigned a signal code number. Make all references to that signal by using the signal code number in the RTSI Bus Trigger function calls. The signal codes for each device that can use the RTSI bus trigger lines are outlined later in this section.

Each signal listed in this chapter also has a signal direction. If a signal is listed with a source direction, that signal can drive the trigger lines. If a signal is listed with a receiver direction, that signal must be received from the trigger lines. A bidirectional signal direction means that the signal can act as either a source or a receiver, depending on the application.

MIO-16/16D RTSI Connections

The MIO-16/16D devices contain nine signals that you can connect to the RTSI bus trigger lines. Table 3-8 shows these signals.

Table 3-8. MIO-16/16D RTSI Bus Signals

Signal Name	Signal Direction	Signal Code
EXTCONV*	Bidirectional	0
FOUT	Source	1
OUT2	Source	2
GATE1	Receiver	3
SOURCE5	Receiver	4
OUT5	Source	5
STOP TRIG	Receiver	6
OUT1	Source	7
START TRIG*	Bidirectional	8

The signals GATE1, SOURCE5, OUT1, OUT2, OUT5, and FOUT are input and output signals from the Am9513 Counter/Timer on the MIO-16 device. OUT1, OUT2, and OUT5 are outputs of counters 1, 2, and 5, respectively. FOUT is the Am9513 programmable frequency output. GATE1 is the gating signal for counter 1, and SOURCE5 is a counter source input. The counters and frequency output are programmed via the counter functions (see *The Counter/Timer Function Group* section earlier in this chapter for more information). GATE1, OUT1, OUT2, OUT5, and FOUT are also available on the device I/O connector.

The signals EXTCNV*, STOP TRIG, and START TRIG* are used for data acquisition timing. These signals are explained in the `DAQ_Config` and `DAQ_StopTrigger_Config` function descriptions in the *Function Reference* chapter, of the NI-DAQ Function Reference Manual.

MIO-F-5/16X RTSI Connections

The MIO-F-5/16X devices contain nine signals that you can connect to the RTSI bus trigger lines. Table 3-9 shows these signals.

Table 3-9. MIO-F-5/16X RTSI Bus Signals

Signal Name	Signal Direction	Signal Code
EXTCONV*	Bidirectional	0
FOUT	Source	1
OUT2	Source	2
GATE1	Receiver	3
SOURCE5	Bidirectional	4
OUT5	Source	5
DACUPTRIG*	Receiver	6
OUT1	Bidirectional	7
EXTTRIG*	Bidirectional	8

The signals GATE1, SOURCE5, OUT1, OUT2, OUT5, and FOUT are input and output signals from the Am9513 Counter/Timer on the device. OUT1, OUT2, and OUT5 are outputs of counters 1, 2, and 5, respectively. FOUT is the Am9513 programmable frequency output. GATE1 is the gating signal for counter 1, and SOURCE5 is a counter source input. Program the counters and frequency output via the counter functions (see *The Counter/Timer Function Group* section earlier in this chapter for more information). GATE1, OUT1, OUT2, OUT5, and FOUT are also available on the MIO-F-5/16X I/O connectors.

Use the signals EXTCNV* and EXTTRIG* for data acquisition timing. These signals are explained in *The Data Acquisition Functions* section earlier in this chapter. The DACUPTRIG* signal and one of the OUTx signals (usually OUT5) are for waveform generation.

E Series, DSA, and DAQArb RTSI Connections

For information regarding signals on the E Series, DSA, and 54xx devices that you can connect to the RTSI bus, refer to the `Select_Signal` function description in the *Function Reference* chapter of the NI-DAQ Function Reference Manual.

AT-AO-6/10 RTSI Connections

The AT-AO-6/10 contains six signals that you can connect to the RTSI bus trigger lines. Table 3-10 shows these signals.

Table 3-10. MIO-16/16D RTSI Bus Signals

Signal Name	Signal Direction	Signal Code
OUT0*	Source	0
GATE2	Receiver	1
EXTUPD*	Source	2
OUT2*	Source	3
OUT1*	Source	4
EXTUPDATE*	Bidirectional	5

The signals GATE2, OUT0*, OUT1*, and OUT2* are input and output signals from the MSM82C53 Counter/Timer on the AT-AO-6/10 device. OUT0*, OUT1*, and OUT2* are outputs of counters 0, 1, and 2, respectively. GATE2 is the gating signal for counter 2.

The signals EXTUPDATE* and EXTUPD* externally update selected DACs. The EXTUPDATE* signal is shared with the I/O connector. For more information about the AT-AO-6/10 signals, see the *AT-AO-6/10 User Manual*.

DIO-32F RTSI Connections

The DIO-32F contains four signals that you can connect to the RTSI bus trigger lines. Table 3-11 shows these signals.

Table 3-11. DIO-32F RTSI Bus Signals

Signal Name	Signal Direction	Signal Code
REQ1	Receiver	0
REQ2	Receiver	1
ACK1	Source	2
ACK2	Source	3

The signals REQ1 and REQ2 are request signals received from the I/O connector. An external device drives these signals during handshaking. ACK1 and ACK2 are supplied for handshaking with the DIO-32F over the RTSI bus. For more information about the DIO-32F signals, see the *AT-DIO-32F User Manual*.

DIO 6533 (DIO-32HS) RTSI Connections

The DIO-6533 devices (except for the DAQCard-6533) contain eight signals that you can connect to the RTSI bus trigger lines. Table 3-12 shows these signals.

The direction of each signal depends on the function you are performing. Some signals have a different direction when you enable pattern generation using `DIG_Block_PG_Config` than when you leave pattern generation disabled. Make sure that you do not configure a signal as a RTSI receiver when you use that signal as a device output. For example, do not configure the DIO 6533 device to receive the REQ1 line from the RTSI bus if you are using internal requests, or if you have made an external connection that drives the REQ1 pin on the I/O connector.

Table 3-12. DIO 6533 RTSI Bus Signals

Signal Name	Signal Direction (Pattern Direction)	Signal Direction (Handshaking, No Pattern Generation)	Signal Direction (No Handshaking)	Signal Code
REQ1	Receiver (external requests) or source (internal requests)	Receiver	Receiver	0
REQ2	Receiver (external requests) or source (internal requests)	Receiver	Receiver	1
ACK1	Receiver (STARTTRIG1)	Source	Source	2
ACK2	Receiver (STARTRIG2)	Source	Source	3
STOPTRIG1	Receiver	Unused	Receiver	4
STOPTRIG2	Receiver	Unused	Receiver	5
PCLK1	Unused	Source (internal clock) or receiver (external clock)	Source	6
PCLK2	Unused	Source (internal clock) or receiver (external clock)	Source	7

REQ1 and REQ2 are request signals generated internally or received from the I/O connector. ACK1 and ACK2 are acknowledge signals used for handshaking mode; in pattern-generation mode, they can carry start trigger signals instead. PCLK1 and PCLK2 are the peripheral clock lines for burst mode. STOPTRIG1 and STOPTRIG2 are used for data acquisition timing. For more information about the DIO 6533 signals, refer to the *DIO 6533 User Manual*. Find additional explanations of the

ACK1, ACK2, STOPTRIG1, and STOPTRIG2 signals in the DIG_Trigger_Config function in the *Function Reference* chapter of the NI-DAQ Function Reference Manual.

RTSI Bus Application Hints

This section gives a basic explanation of how to construct an application that uses RTSI bus NI-DAQ functions. Use the flowcharts as a quick reference for constructing potential applications from the NI-DAQ function calls.

An application that uses the RTSI bus has three basic steps.

1. Connect the signals from the device to the RTSI bus.
2. Execute the work of the application.
3. Disconnect the signals from the RTSI bus. Figure 3-34 illustrates the normal order of RTSI function calls.

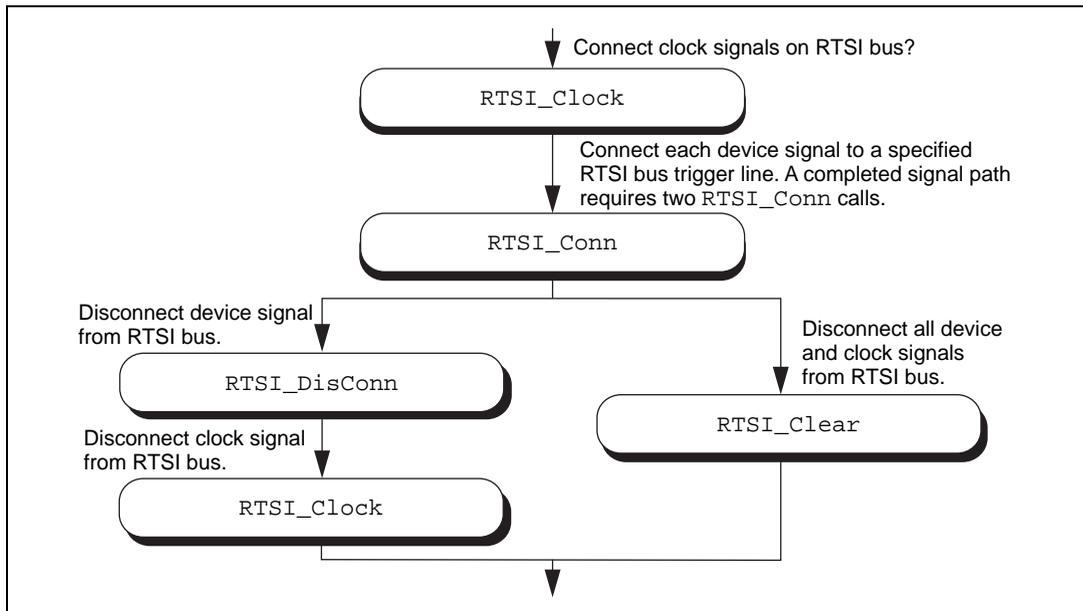


Figure 3-34. Basic RTSI Application Calls

Call `RTSI_Clock` and/or `RTSI_Conn` to connect the signals. Each completed signal path requires `RTSI_Conn` calls. The first call specifies the device signal to transmit onto a RTSI bus trigger line. The second call specifies the device signal that receives a RTSI bus trigger line.

After the signals are connected, you are ready to do the actual work of your application.

After you finish with the RTSI bus, disconnect the device from the bus. To do this, call `RTSI_DisConn` and or `RTSI_Clock` for each connection made. Alternatively, call `RTSI_Clear` to sever all connections from your device to the RTSI bus.

The SCXI Functions

Refer to the NI-DAQ Function Reference Manual to determine which functions your device supports.

<code>SCXI_AO_Write</code>	Sets the DAC channel on the SCXI-1124 module to the specified voltage or current output value. You also can use this function to write a binary value directly to the DAC channel, or to translate a voltage or current value to the corresponding binary value.
<code>SCXI_Cal_Constants</code>	Calculates calibration constants for the particular channel and range or gain using measured voltage/binary pairs. You can use this function with any SCXI analog input or analog output module. The constants can be stored and retrieved from NI-DAQ memory or the module EEPROM (if your module has an EEPROM). The driver uses the calibration constants to scale analog input data more accurately when you use the <code>SCXI_Scale</code> function and output data when you use <code>SCXI_AO_Write</code> .
<code>SCXI_Calibrate_Setup</code>	Grounds the amplifier inputs of an SCXI-1100, SCXI-1122, or SCXI-1141 so that you can determine the amplifier offset. You also can use this function to switch a shunt resistor across your bridge circuit to test the circuit. This

	function supports shunt calibration for the SCXI-1122 module or the SCXI-1121 module with the SCXI-1321 terminal block.
SCXI_Change_Chan	Selects a new channel of a multiplexed module that has previously been set up for a single-channel operation using the SCXI_Single_Chan_Setup function.
SCXI_Configure_Filter	Sets the specified channel to the assigned filter setting on any SCXI module with programmable filter settings.
SCXI_Get_Chassis_Info	Returns chassis configuration information.
SCXI_Get_Module_Info	Returns configuration information for the assigned SCXI chassis slot number.
SCXI_Get_State	Gets the state of a single channel or an entire port on any digital or relay module.
SCXI_Get_Status	Reads the data in the status register on the specified module. You can use this function with the SCXI-1160 or SCXI-1122 to determine if the relays have finished switching, with the SCXI-1124 to determine if the DACs have settled, or with the SCXI-1102/B/C to determine if the module has settled after changing gains.
SCXI_Load_Config	Loads the SCXI chassis configuration information that you established in the configuration utility. Sets the software states of the chassis and modules present to their default states. No changes are made to the hardware states of the SCXI chassis or modules.

<code>SCXI_ModuleID_Read</code>	Reads the Module ID register of the SCXI module in a given slot. The principal difference between this function and <code>SCXI_Get_Module_Info</code> is that <code>SCXI_ModuleID_Read</code> does a hardware read of the module. You can use this function to verify that your SCXI system is configured and communicating properly.
<code>SCXI_MuxCtr_Setup</code>	Enables or disables a DAQ device counter to be used as a multiplexer counter during SCXI channel scanning to synchronize the scan list with the module scan list that NI-DAQ has downloaded to Slot 0 of the SCXI chassis.
<code>SCXI_Reset</code>	Resets the specified module to its default state. You can also use <code>SCXI_Reset</code> to reset the Slot 0 scanning circuitry or to reset the entire chassis.
<code>SCXI_Scale</code>	Scales an array of binary data acquired from an SCXI channel to voltage.
<code>SCXI_SCAN_Setup</code>	Sets up the SCXI chassis for a multiplexed scanning data acquisition operation that the assigned DAQ device will perform. The function downloads a module scan list to Slot 0 that determines the sequence of scanned modules and how many channels on each module are scanned. This function can program each module with its given start channel, as well as resolve any contention on the SCXIBus.
<code>SCXI_Set_Config</code>	Changes the configuration of the SCXI chassis that you established in the configuration utility. Sets the software states of the chassis and modules

	specified to their default states. Does not change the SCXI chassis or module hardware states.
SCXI_Set_Gain	Sets the specified channel to the given filter setting on any SCXI module that works with programmable gain settings.
SCXI_Set_Input_Mode	Configures the SCXI-1122 for differential mode or 4-wire mode.
SCXI_Set_State	Sets the state of a single channel or an entire port on any digital or relay module.
SCXI_Set_Threshold	Used to set the high and low threshold values for the SCXI-1126 frequency to voltage module.
SCXI_Single_Chan_Setup	Sets up a multiplexed module for a single-channel analog-input operation to be performed by the given DAQ device. Sets the module channel, enables the module output, and routes the module output on the SCXIbus, if necessary. Resolves any contention on the SCXIbus by disabling the output of any module that was previously driving the SCXIbus. You also can use this function to set up to read the temperature sensor on a terminal block connected to the front connector of the module.
SCXI_Track_Hold_Control	Controls the SCXI-1140 module track/hold state that you set up for a single-channel operation.
SCXI_Track_Hold_Setup	Establishes the track/hold behavior of an SCXI-1140 module and sets up the module for either a single-channel or an interval-scanning operation.

SCXI Application Hints

There are three categories of SCXI applications—analogue input applications, analogue output applications, and digital applications.

Figure 3-35 shows the basic structure of an SCXI application.

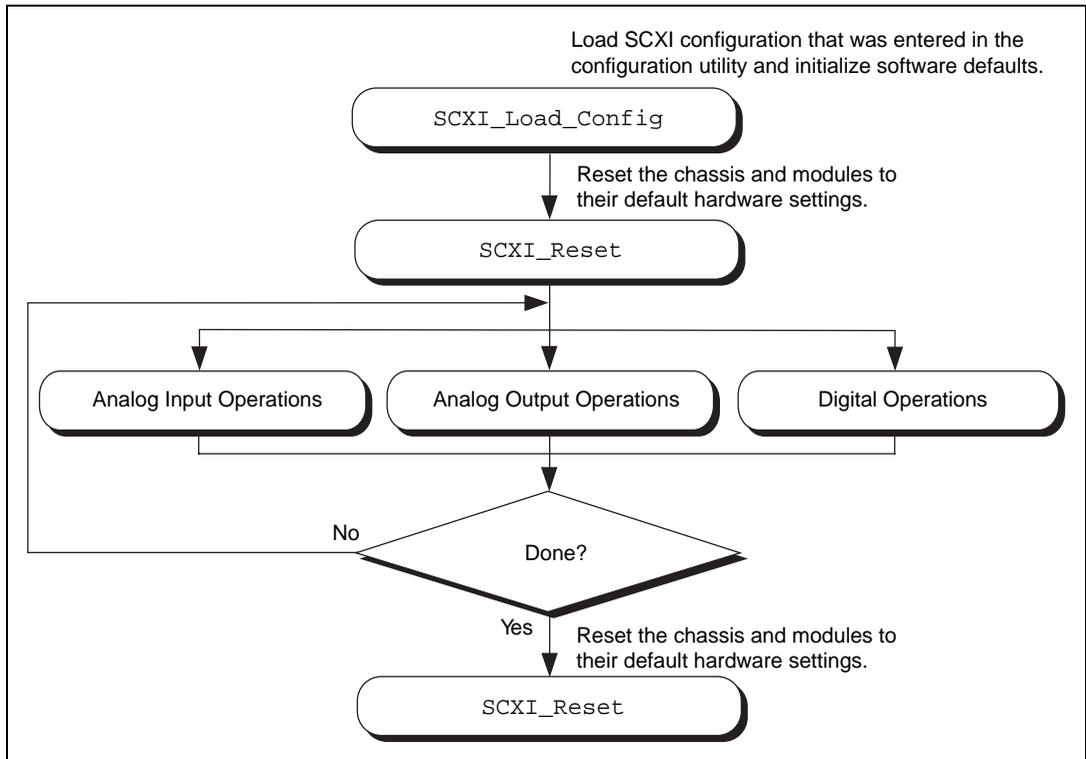


Figure 3-35. General SCXIbus Application

The figures in the following sections show the detailed call sequences for different types of SCXI operations. In effect, each of the remaining flowcharts in this section is an enlargement of the Analog Input Operations, the Analog Output Operations, or the Digital Operations node in Figure 3-35. Please refer to the function descriptions in the *Function Reference* chapter of the NI-DAQ Function Reference Manual for detailed information about each function used in the flowcharts.

You can divide the SCXI analog input applications further into two categories—single-channel applications and channel-scanning applications. The distinction between the two categories is simple—

single-channel applications do not involve automatic channel switching by the hardware during an analog input process; channel-scanning applications do.

After you have set up the SCXI system, single-channel applications use the `AI` or the `DAQ` class of functions described earlier in this chapter to acquire the input data. To acquire data from more than one channel, you need multiple `AI` or `DAQ` function calls, and you might need explicit SCXI function calls to change the selected SCXI channel; this specific type of single-channel application is called *software scanning*.

After you have set up the SCXI system, channel-scanning applications use the `SCAN` and `Lab_ISCAN` classes of functions described earlier in this chapter to acquire the input data.

Building Analog Input Applications in Multiplexed Mode

Multiplexed applications require the use of SCXI functions to select the multiplexed channels, select the programmable module features, route signals on the SCXIBus, and program Slot 0. After you have set up the SCXI chassis and modules, you can use the `AI`, `DAQ`, `SCAN`, and `Lab_ISCAN` functions to acquire the data either with a plug-in DAQ device or the SCXI-1200. The **channel** parameter that is passed to each of these functions is almost always 0 because the multiplexed output of a module is connected by default to analog input channel 0 of the DAQ device or SCXI-1200. If you are using a PXI DAQ device with an internal connection to the PXI-1010 SCXIBus, then `ND_PXI_SC` is the **channel** parameter. When you use multiple chassis, the modules in each chassis are multiplexed to a separate analog input channel. In that case, the **channel** parameters of the `AI`, `DAQ`, `SCAN`, and `Lab_ISCAN` functions should be the DAQ device channel that corresponds to the chassis you want for the operation. You cannot use the SCXI-1200 with multiple chassis.

Figure 3-36 shows the function call sequence of a single-channel or software-scanning application using an SCXI-1100, SCXI-1102/B/C, VXI-SC-1102/B/C, SCXI-1120/D, SCXI-1121, SCXI-1122, or SCXI-1141 module operating in Multiplexed mode.

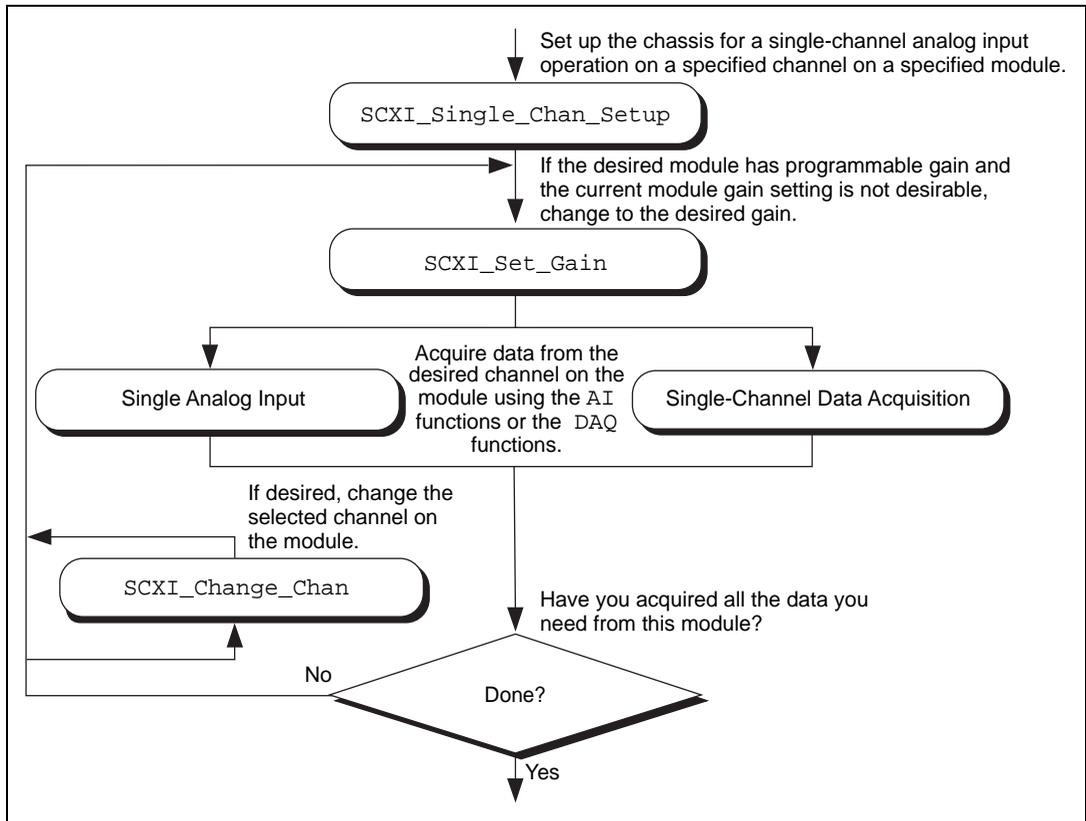


Figure 3-36. Single-Channel or Software-Scanning Operation Using the SCXI-1100, SCXI-1102/B/C, VXI-SC-1102/B/C, SCXI-1120/D, SCXI-1121, SCXI-1122, or SCXI-1141 in Multiplexed Mode

The `SCXI_Single_Chan_Setup` function selects the given channel to appear at the module output. If the given module is not directly cabled to the DAQ device, the function sends the module output on the SCXibus, and then configures the module that *is* cabled to the DAQ device to send the signal present on the SCXibus to the DAQ device.

The `SCXI_Set_Gain` function changes the gain of the SCXI-1100, SCXI-1102/B/C, VXI-SC-1102/B/C, SCXI-1122, or SCXI-1141 module. The module maintains this gain setting until you call the function again to change it. You can also do any other module-specific programming at this point, such as `SCXI_Configure_Filter` or `SCXI_Set_Input_Mode`.

To achieve software scanning, select a different channel on the module using the `SCXI_Change_Chan` function after acquiring data from the channel you want with the AI or DAQ functions. If you want a channel on a different module, call the `SCXI_Single_Chan_Setup` function again to enable the appropriate module outputs and manage the SCXIBus signal routing.

Figure 3-37 shows the function call sequence of a single channel or software-scanning application using an SCXI-1140 in Multiplexed mode.

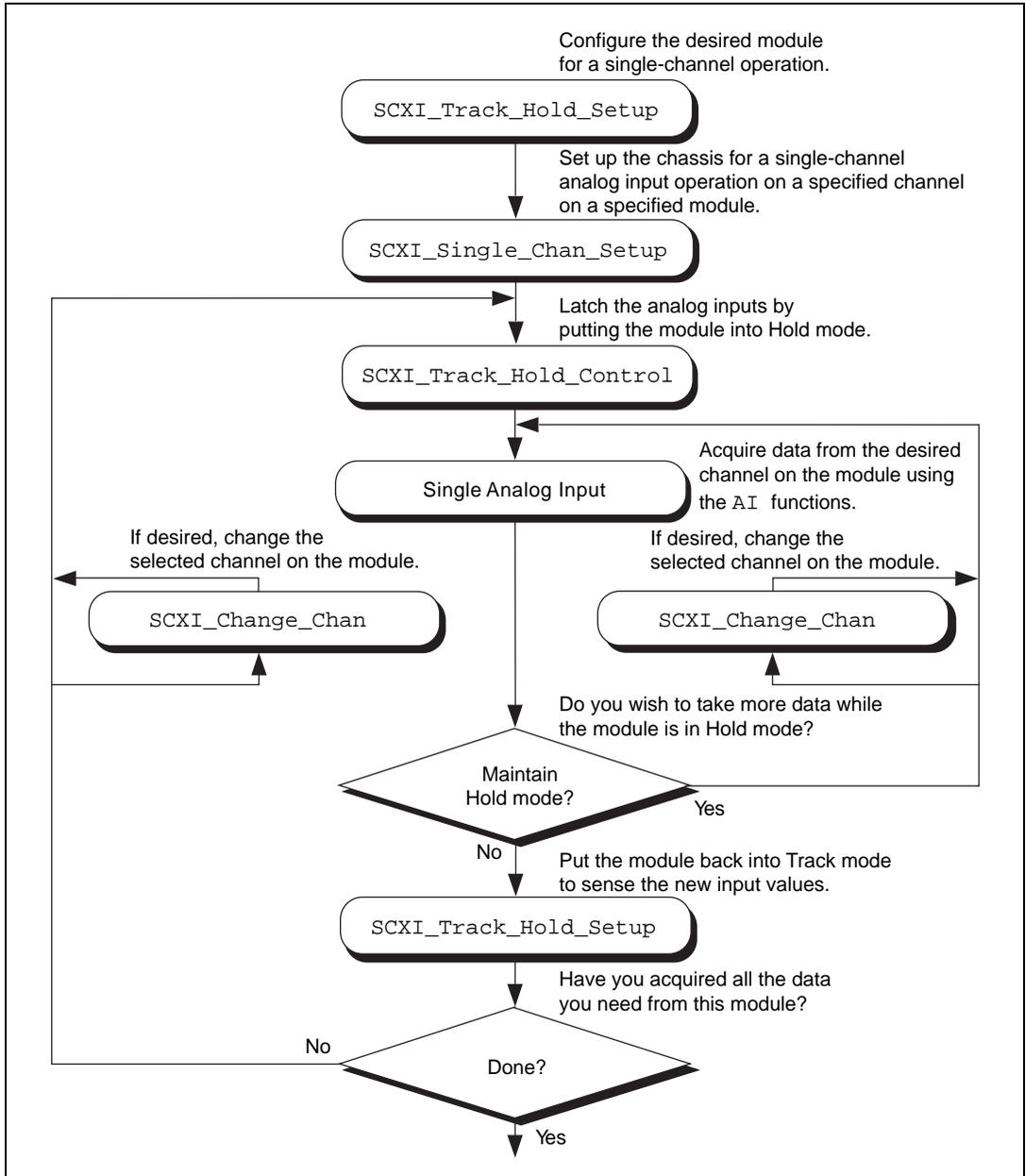


Figure 3-37. Single-Channel or Software-Scanning Operation Using the SCXI-1140 in Multiplexed Mode

Notice the similarities between Figure 3-36 and Figure 3-38, which shows the corresponding application in Parallel mode. The `SCXI_Track_Hold_Setup` calls and the `SCXI_Track_Hold_Control` calls are the same. In Multiplexed mode, however, an `SCXI_Single_Chan_Setup` call is required to select the multiplexed channel and appropriately route the output to the DAQ device or SCXI-1200 module. The `SCXI_Change_Chan` call can change the channel on the module either while the module is in Hold mode or after the module has been returned to Track mode.

Figure 3-38 shows the function call sequence of a channel-scanning application in Multiplexed mode. Remember that only the MIO and AI devices, the Lab-PC+, the SCXI-1200, and the DAQCard-1200 work with channel scanning in Multiplexed mode. You can use any combination of module types in a scanning operation. If any SCXI-1140 modules are to be scanned, use interval scanning; if you are using a plug-in DAQ device, the module directly connected to the DAQ device must be an SCXI-1140.

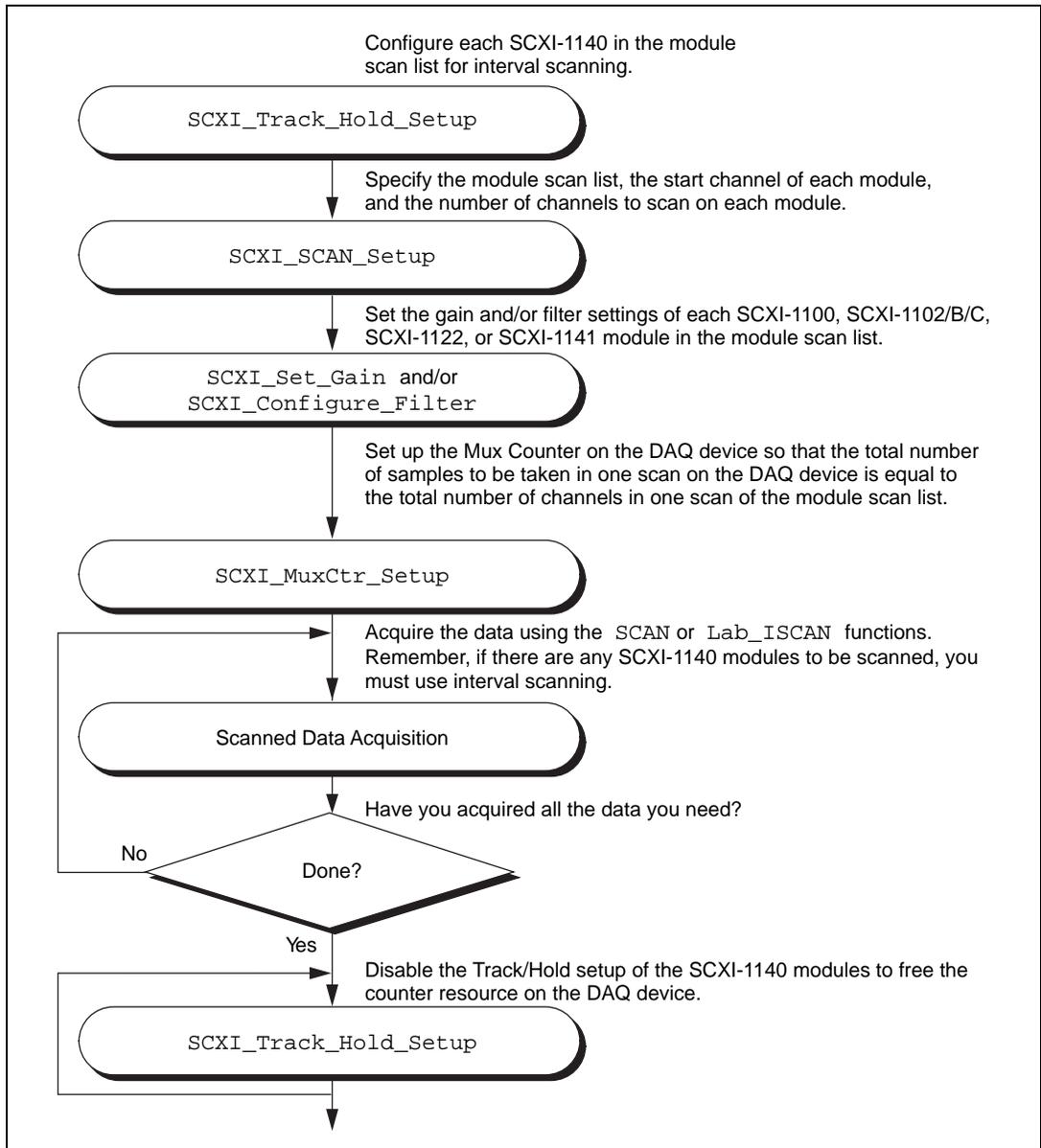


Figure 3-38. Channel-Scanning Operation Using Modules in Multiplexed Mode

If any of the modules to be scanned are SCXI-1140 modules, you must establish the Track/Hold setup of each one. To synchronize multiple SCXI-1140 modules, you can configure the module that is receiving the Track/Hold control signal to send the Track/Hold signal on the SCXIbus so that any other SCXI-1140 modules can use it. The Track/Hold signal can be from either the DAQ device counter or an external source.

The `SCXI_SCAN_Setup` call establishes the module scan list, which NI-DAQ downloads to Slot 0. Each module is programmed for automatic scanning starting at its given start channel. If you need the SCXIbus during the scan to route the outputs of multiple modules, this function resolves any contention. If you are using an SCXI-1200, you can include the SCXI-1200 in the module scan list.

In many of the data acquisition function descriptions in the *Function Reference* chapter of the NI-DAQ Function Reference Manual, the **count** parameter descriptions specify that **count** must be an integer multiple of the total number of channels scanned. In channel-scanning acquisitions in Multiplexed mode, the total number of channels scanned is the sum of all the elements in the **numChans** array in the `SCXI_SCAN_Setup` function call.

If any of the modules in the module scan list are SCXI-1100, SCXI-1102/B/C, VXI-SC-1102/B/C, SCXI-1122, or SCXI-1141 modules, you can use `SCXI_Set_Gain` to change the gain setting on each module. You also can use the `SCXI_Configure_Filter` function for the SCXI-1122 and SCXI-1141 and the `SCXI_Set_Input_Mode` function for the SCXI-1122.

The `SCXI_MuxCtr_Setup` call synchronizes the module scan list with the DAQ device or SCXI-1200 scan list. In most cases (especially when using interval scanning), it is best to ensure that the number of samples NI-DAQ takes in one pass through the module scan list is the same as the number of samples NI-DAQ takes in one pass through the DAQ device scan list. Please refer to the `SCXI_MuxCtr_Setup` function description in the NI-DAQ Function Reference Manual.

After you have set up the SCXI chassis and modules, you can perform more than one channel-scanning operation using the `SCAN` or `Lab_ISCAN` functions without reconfiguring the SCXI chassis or modules.

When you are using the SCXI-1200 to acquire the data, pass channel 0 to the `Lab_ISCAN` functions; the SCXI Slot 0 takes care of all the channel switching.

Building Analog Input Applications in Parallel Mode

When you operate the SCXI-1120/D, SCXI-1121, and SCXI-1141 modules in Parallel mode, you need no further SCXI function calls beyond those shown in Figure 3-38 to set up the modules for analog input operations. After you have initialized and reset the SCXI chassis and modules, you can use the `AI`, `DAQ`, `SCAN`, or `Lab_ISCAN` functions with the DAQ device. Remember that the **channel** and **gain** parameters of the `AI`, `DAQ`, `SCAN`, and `Lab_ISCAN` functions refer to the DAQ device channels and gains.

For example, to acquire a single reading from channel 0 on the module, call the `AI_Read` function with the **channel** parameter set to 0. The **gain** parameter refers to the DAQ device gain. You then can use the `SCXI_Scale` function to convert the binary reading to a voltage. The `AI_VRead` function call is not generally useful in SCXI applications because it does not take into account the gain applied at the SCXI module when scaling the binary reading.

To build a channel-scanning application using the SCXI-1120/D, SCXI-1121, or SCXI-1141 in Parallel mode, use the `SCAN` and `Lab_ISCAN` functions to scan the channels on the DAQ device that correspond to channels on the module you want. For example, to scan channels 0, 1, and 3 on the module using an MIO-16 device, call the `SCAN_Op` function with the **channel** vector set to {0, 1, 3}. The **gain** vector should contain the MIO and AI device channel gains. After the data is acquired, you can demultiplex it and send the data for each channel to the `DAQ_VScale` function. Remember to pass the *total gain* to the `DAQ_VScale` function to obtain the voltage read at the module input.

In many of the data acquisition function descriptions in the *Function Reference* chapter of the NI-DAQ Function Reference Manual, the **count** parameter descriptions specify that **count** must be an integer multiple of the total number of channels scanned. In channel-scanning acquisitions in Parallel mode, the total number of channels scanned is the **numChans** parameter in the `SCAN_Setup`, `SCAN_Op`, `SCAN_to_Disk`, `Lab_ISCAN_Start`, `Lab_ISCAN_Op`, or `Lab_ISCAN_to_Disk` function calls.

When you use the SCXI-1200 module in Parallel mode, you simply use the `AI`, `DAQ`, or `Lab_ISCAN` functions described earlier in this chapter with the logical device number you assigned in the configuration utility. You cannot use the SCXI-1200 to read channels from other analog input modules that are configured for Parallel mode.

The SCXI-1100, SCXI-1102/B/C, VXI-SC-1102/B/C, and SCXI-1122 operate in Multiplexed mode only.

The SCXI-1140 module requires the use of SCXI functions to configure and control the Track/Hold state of the module before you can use the `AI`, `DAQ`, `SCAN`, and `Lab_ISCAN` functions to acquire the data. Figure 3-39 shows the function call sequence of a single-channel (or software-scanning) operation using the SCXI-1140 module in Parallel mode.

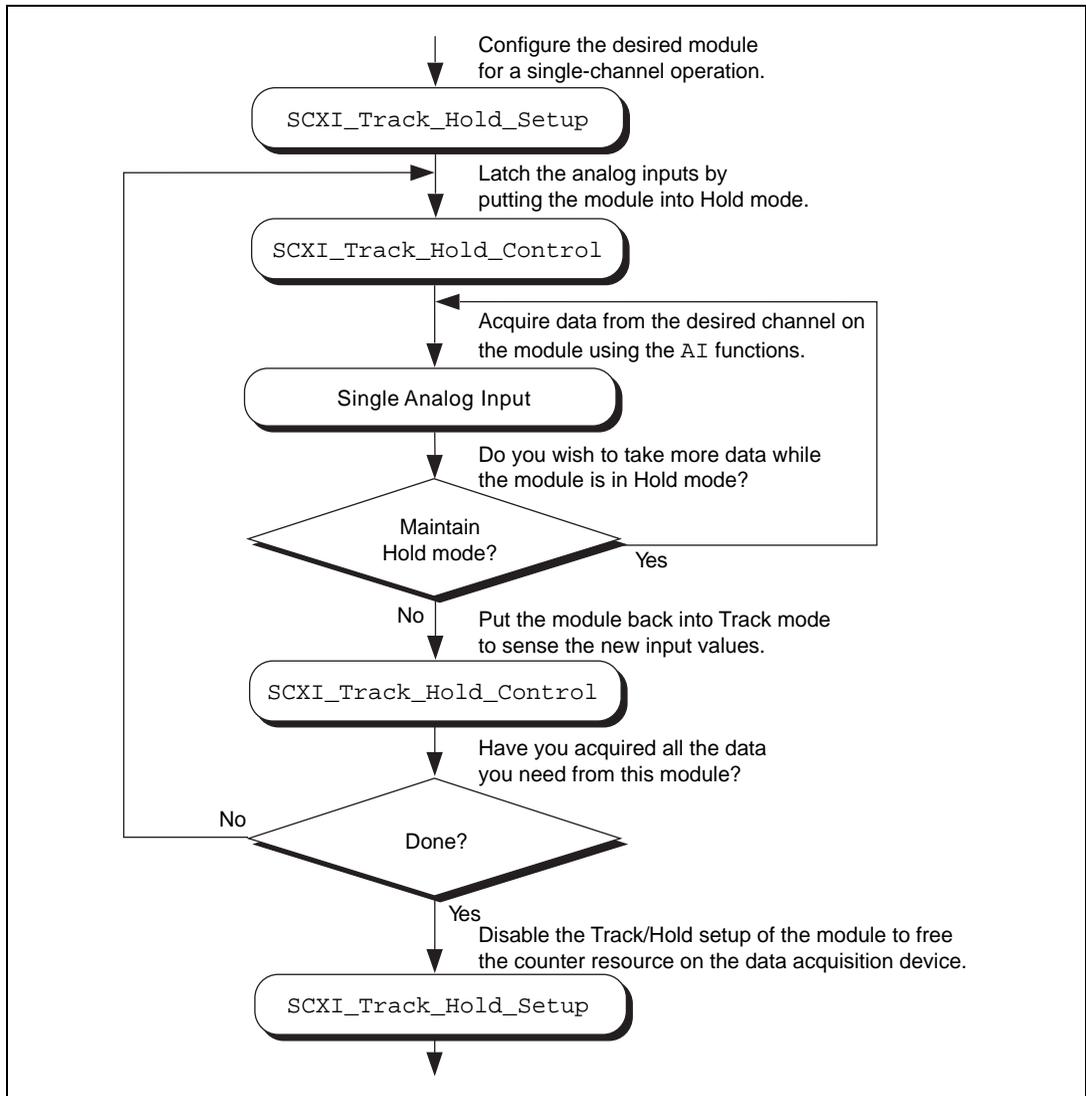


Figure 3-39. Single-Channel or Software-Scanning Operation Using the SCXI-1140 in Parallel Mode

The initial `SCXI_Track_Hold_Setup` call signals the driver that the module is used in a single-channel application, and puts the module into Track mode. The first `SCXI_Track_Hold_Control` call latches, or samples, all the module inputs; subsequent AI calls read the sampled voltages. It is important to realize that all AI operations that occur between the first `SCXI_Track_Hold_Control` call, which puts the

module into Hold mode, and the second control call, which puts the module into Track mode, acquire data that was sampled at the time of the first control call. One or more channels can be read while the module is in Hold mode. After you put the module back into Track mode, you can repeat the process to acquire new data.

Remember that the **channel** and **gain** parameters of the AI function calls refer to the DAQ device channels and gains. Simply use the data acquisition channels that correspond to the module channels you want, as described earlier in this section. Also be aware of the SCXI-1140 Track/Hold timing requirements described in the *SCXI-1140* section of the *SCXI Hardware* chapter in the *DAQ Hardware Overview Guide*.

Figure 3-40 shows the function call sequence of a channel-scanning application using the SCXI-1140 in Parallel mode.

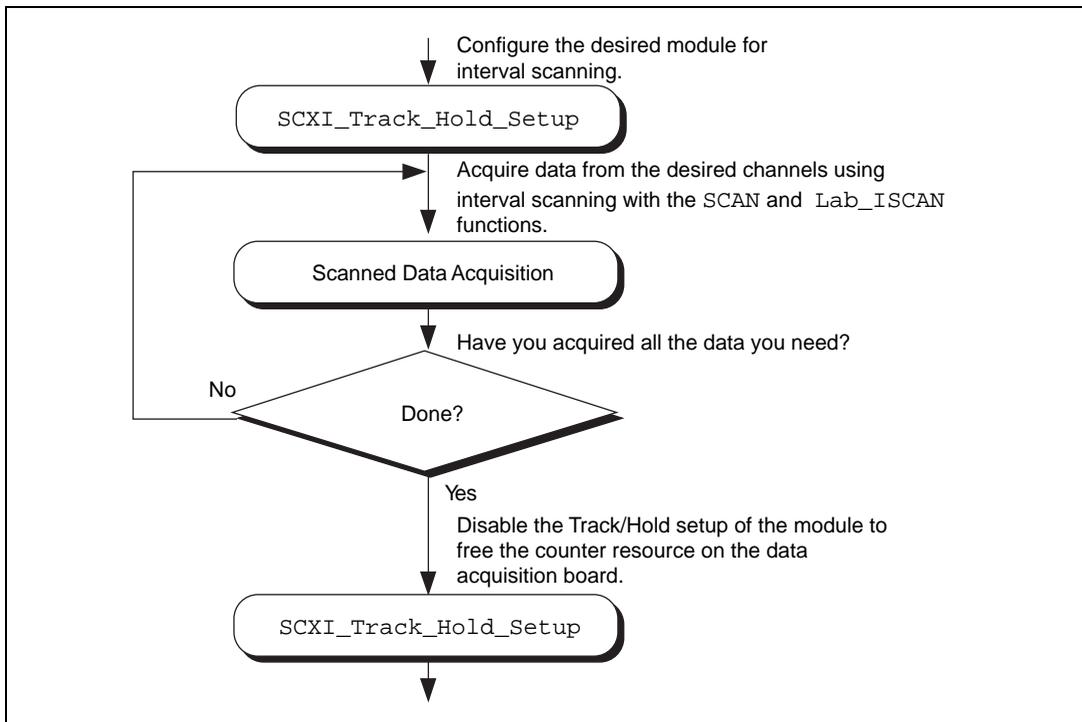


Figure 3-40. Channel-Scanning Operation Using the SCXI-1140 in Parallel Mode

The call sequence is much simpler because the scan interval timer automatically controls the Track/Hold state of the module during the interval-scanning operation. Remember that only the MIO and AI devices, Lab-PC+, PCI-1200, SCXI-1200, and DAQCard-1200 devices work with channel-scanning using the SCXI-1140 module.

SCXI Data Acquisition Rates

The settling time of the SCXI modules can affect the maximum data acquisition rates that your DAQ device can achieve. The settling times of the different SCXI modules at each gain setting are listed in Table 3-13 for three different DAQ devices.

The maximum data acquisition rate you can use will be the inverse of the settling time for your SCXI module and DAQ device. For example, if the settling time is listed as 7 μs , your maximum data acquisition rate will be $1/7 \mu\text{s} = 143 \text{ kS/s}$.

If you are using a DAQ device with a maximum acquisition rate faster than the AT-MIO-16E-2 (such as the AT-MIO-16E-1), you should use the settling times and corresponding maximum acquisition rates listed for the AT-MIO-16E-2.

If you are using a DAQ device with a maximum acquisition rate slower than the AT-MIO-16F-5 (such as the AT-MIO-16E-10), you should add 1 μs to the settling time of your DAQ device. The maximum acquisition rate for the AT-MIO-16E-10 would be $1/(10 \mu\text{s} + 1 \mu\text{s}) = 90.9 \text{ kS/s}$.

If you are using a DAQ device faster than the AT-MIO-16F-5 but slower than the AT-MIO-16E-2 (such as an AT-MIO-64E-3), you can interpolate between the settling times listed for these devices to calculate an appropriate settling time and corresponding maximum data acquisition rate.

Table 3-13. Maximum SCXI Module Settling Times

SCXI Module	Gain	Settling Time Using AT-MIO-16F-5 ¹	Settling Time Using AT-MIO-16E-2 ²	Settling Time Using AT-MIO-16X ($\pm 0.006\%$ Accuracy) ³	Settling Time Using AT-MIO-16X ($\pm 0.0015\%$ Accuracy) ³
SCXI-1100 (no filter)	1 to 100	7 μ s	4 μ s	10 μ s	32 μ s
	200	10 μ s	5.5 μ s	10 μ s	33 μ s
	500	16 μ s	12 μ s	25 μ s	40 μ s
	1,000	50 μ s	20 μ s	30 μ s	76 μ s
	2,000	50 μ s	25 μ s	30 μ s	195 μ s
SCXI-1102/B/C, VXI-SC-1102/B/C	all gains	7 μ s	3 μ s	10 μ s	—
SCXI-1120, SCXI-1120D	all gains	7 μ s	3 μ s	10 μ s	20 μ s
SCXI-1121	all gains	7 μ s	3 μ s	10 μ s	20 μ s
SCXI-1122	all gains	10 ms	10 ms	10 ms	10 ms
SCXI-1140	all gains	7 μ s	3 μ s	10 μ s	20 μ s
SCXI-1141	all gains	7 μ s	3 μ s	10 μ s	20 μ s
<p>¹ Includes effects of AT-MIO-16F-5 with 1 m SCXI cable assembly.</p> <p>² Includes effects of AT-MIO-16E-2 with 1 or 2 m SCXI cable assembly.</p> <p>³ Includes effects of AT-MIO-16X with 1 or 2 m SCXI cable assembly.</p> <p>Note: If you are using remote SCXI, the maximum data acquisition rate also depends on the serial baud rate used. For more information, see the <i>SCXI Chassis User Manual</i>.</p>					

Table 3-14. SCXI-1200 Module Settling Rates

Gain	Maximum Acquisition Rate	Settling Time
1	83.3 kS/s	12 μ s
2 to 50	55 kS/s	18 μ s
100	25 kS/s	40 μ s

The SCXI-1200 module acquisition rate is limited by the rate at which your PC can service interrupts from the parallel port. This is a machine-dependent rate.

The filter setting on the SCXI-1100 and the SCXI-1122 dramatically affects settling time. See the *Specifications* appendix in your SCXI module user manual for details.

**Note:**

The SCXI-1122 uses relays to switch the input channels; the module requires 10 ms to settle when the relays switch, so the sampling rate in a channel scanning operation cannot exceed 100 Hz. If you want to take many readings from each channel and average them to reduce noise, you should use the single-channel or software-scanning method shown in Figure 3-39 instead of the channel-scanning method shown in Figure 3-40. This means you select one channel on the module, acquire many samples on that channel using the DAQ functions, select the next channel, and so on. This increases the lifetime of your module relays. When you have selected a particular channel, you can use the fastest sample rate your DAQ device supports with the DAQ functions.

Analog Output Applications

Using the SCXI-1124 analog output module with the NI-DAQ functions is simple. Call the `SCXI_AO_Write` function to write the voltages you want to the module DAC channels. You can use the `SCXI_Get_Status` function to determine when the DAC channels have settled to their final analog output voltages.

To calculate new calibration constants for `SCXI_AO_Write` to use for the voltage to binary conversion instead of the factory calibration constants that are shipped in the module EEPROM, follow the procedure outlined in the `SCXI_Cal_Constants` function description.

Digital Applications

If you configured your digital or relay modules for Multiplexed mode, use the `SCXI_Set_State` and `SCXI_Get_State` functions to access your digital or relay channels.

If you are using the SCXI-1160 module, you might want to use the `SCXI_Get_Status` function after calling the `SCXI_Set_State` function. `SCXI_Get_Status` tells you when the SCXI-1160 relays have finished switching.

If you are using the SCXI-1162/HV module, `SCXI_Get_State` reads the module input channels. For the other digital and relay modules, `SCXI_Get_State` returns a software copy of the current state that NI-DAQ maintains. However, if you are using the SCXI-1163/R in Parallel mode, `SCXI_Get_State` reads the hardware states.

If you are using the SCXI-1162/HV or SCXI-1163/R in Parallel mode, you can use the SCXI functions as described above, or you can call the `DIG_In_Port` and `DIG_Out_Port` functions using the correct DAQ device port numbers that correspond to the SCXI module channels. The respective chapters on the DIO-96, DIO-24, AT-MIO-16D, and DIO-32F and DIO 6533 devices in the *DAQ Hardware Overview Guide* list the onboard port numbers used for each device type if the SCXI-1162/HV or SCXI-1163/R is configured for Parallel mode. The MIO and AI devices, Lab-PC+, and SCXI-1200 cannot use the SCXI-1162/HV or the SCXI-1163/R in Parallel mode.

The Transducer Conversion Functions

NI-DAQ includes source code for transducer conversion functions. The Transducer Conversion functions convert analog input voltages read from thermocouples, RTDs, thermistors, and strain gauges into temperature or strain units:

`RTD_Convert`

Supplied single-voltage and voltage-buffer routines convert voltages read from an RTD into resistance and then into temperature in units for Celsius, Fahrenheit, kelvin, or Rankine.

Strain_Convert	Supplied single-voltage and voltage-buffer routines convert voltages read from a strain gauge into measured strain using the appropriate formula for the strain gauge bridge configuration used.
Thermistor_Convert	Supplied single-voltage and voltage-buffer routines convert voltages read from thermistors into temperature.
Thermocouple_Convert	Supplied single-voltage and voltage-buffer routines convert voltages read from B-, E-, J-, K-, N-, R-, S-, or T-type thermocouples into temperature in Celsius, Fahrenheit, kelvin, or Rankine.

NI-DAQ installs the source files for these functions in the same directories as the example programs. You can cut and paste, include, or merge these conversion routines into your application source files in order to call the routines in your application.

The conversion routines are included in NI-DAQ as source files rather than driver function calls so that you have complete access to the conversion formulas. You can edit the conversion formulas or replace them with your own to meet your application's specific accuracy requirements. Comments in the conversion source code simplify only necessary editing.

A header file for each language (`convert.h` for C/C++, `convert.bns` for Visual Basic) contains the constant definitions used in the conversion routines. Include or merge this header file into your application program.

The transducer conversion routine descriptions apply to all languages.

Transducer Conversion Function Descriptions

RTD_Convert and RTD_Buf_Convert

Purpose

Converts a voltage or voltage buffer that NI-DAQ read from an RTD into temperature.

Parameter Discussion

The **convType** integer indicates whether to use the given conversion formula, or to use a user-defined formula that you have put into the routine.

- 0: Use the given conversion formula.
- 1: Use a user-defined formula that has been added to the routine.

Iex is the excitation current that was used with the RTD. If a 0 is passed in **Iex**, a default excitation current of 0.15 mA is assumed.

Ro is the RTD resistance at 0° C.

A and **B** are the coefficients of the Callendar Van-Dusen equation that fit your RTD.

The **TempScale** integer indicates which temperature units you want your return values to be. Constant definitions for each temperature scale are given in the conversion header file.

- 1: Celsius
- 2: Fahrenheit
- 3: kelvin
- 4: Rankine

The `RTD_Convert` routine has two remaining parameters—**RTDVolts** is the voltage that NI-DAQ read from the RTD, and **RTDTemp** is the return temperature value.

The `RTD_Buf_Convert` routine has three remaining parameters—**numPts** is the number of voltage points to convert, **RTDVoltBuf** is the array that contains the voltages that NI-DAQ read from the RTD, and **RTDTempBuf** is the return array that contains the temperatures.

Using This Function

The conversion routines first find the RTD resistance by dividing **RTDVolts** (or each element of **RTDVoltBuf**) by **Iex**. The function converts that resistance to a temperature using a solution to the Callendar Van-Dusen equation for RTDs:

$$R_t = R_0[1 + At + Bt^2 + C(t-100)t^3]$$

For temperatures above 0° C, the C coefficient is 0 and the equation reduces to a quadratic equation for which we have found the appropriate root. Thus, these conversion routines are accurate only for temperatures above 0° C.

Your RTD documentation should give you **R₀** and the **A** and **B** coefficients for the Callendar Van-Dusen equation. The most common RTDs are 100 Ω platinum RTDs that either follow the European temperature curve (also known as the DIN 43760 standard) or the American curve. The values for **A** and **B** are as follows:

- European Curve (DIN 43760):

$$\mathbf{A} = 3.90802 \times 10^{-3}$$

$$\mathbf{B} = -5.80195 \times 10^{-7}$$

$$(\alpha = 3.85 \times 10^{-3}; \partial = 1.492)$$

- American Curve:

$$\mathbf{A} = 3.9784 \times 10^{-3}$$

$$\mathbf{B} = -5.8408 \times 10^{-7}$$

$$(\alpha = 3.92 \times 10^{-3}; \partial = 1.492)$$

Some RTD documentation contains values for α and ∂ , from which you can calculate **A** and **B** using the following equations:

$$\mathbf{A} = \alpha(1 + \partial/100)$$

$$\mathbf{B} = -\alpha \partial/10,000100^2$$

where α is the temperature coefficient at $T = 0^\circ \text{C}$.

$$\mathbf{C} = -\alpha \beta/1,000,000$$

where β is a characteristic of your RTD similar to the α and ∂ equation coefficients.

Strain_Convert and Strain_Buf_Convert

Purpose

Converts a voltage or voltage buffer that NI-DAQ read from a strain gauge to units of strain.

Parameter Discussion

The **bridgeConfig** integer indicates in what type of bridge configuration the strain gauge is mounted. Figure 3-41 shows all the different bridge configurations and the corresponding values that you should pass in **bridgeConfig**.

Vex is the excitation voltage that you used. If the value of **Vex** is 0, a default excitation voltage of 3.333 V is assumed. The SCXI-1121 module provides excitation voltages of 10 V and 3.333 V. The SCXI-1122 module provides an excitation voltage of 3.333 V.

GF is the gauge factor of the strain gauge.

v is Poisson's Ratio (needed only in certain bridge configurations).

Rg is the strain gauge nominal value.

RL is the lead resistance. In many cases, the lead resistance is negligible and you can pass a value of 0 for **RL** to the routine. Otherwise, you can measure **RL** to be more accurate.

Vinit is the unstrained voltage of the strain gauge after it is mounted in its bridge configuration. Read this voltage at the beginning of your application and save it to pass to the strain gauge conversion routines.

The `Strain_Convert` routine has two remaining parameters—**strainVolts** is the voltage that NI-DAQ read from the strain gauge, and **strainVal** is the return strain value.

The `Strain_Buf_Convert` routine has three remaining parameters—**numPts** is the number of voltage points to convert, **strainVoltBuf** is the array that contains the voltages that NI-DAQ read from the strain gauge, and **strainValBuf** is the return array that contains the strain values.

Using This Function

The conversion formula used is based solely on the bridge configuration. Figure 3-41 shows the seven bridge configurations supported and the corresponding formulas. For all bridge configurations, NI-DAQ uses the following formula to obtain V_r :

$$V_r = (\text{strainVolts} - V_{\text{init}}) / V_{\text{ex}}$$

In the circuit diagrams shown in Figure 3-41, V_{OUT} is the voltage you measure and pass to the `Strain_Convert` function as the **strainVolts** parameter. In the quarter-bridge and half-bridge configurations, R_1 and R_2 are dummy resistors that are not directly incorporated into the conversion formula. The SCXI-1121 and SCXI-1122 modules provide R_1 and R_2 for a bridge-completion network, if needed. Refer to your *Getting Started with SCXI* manual for more information on bridge-completion networks and voltage excitation.

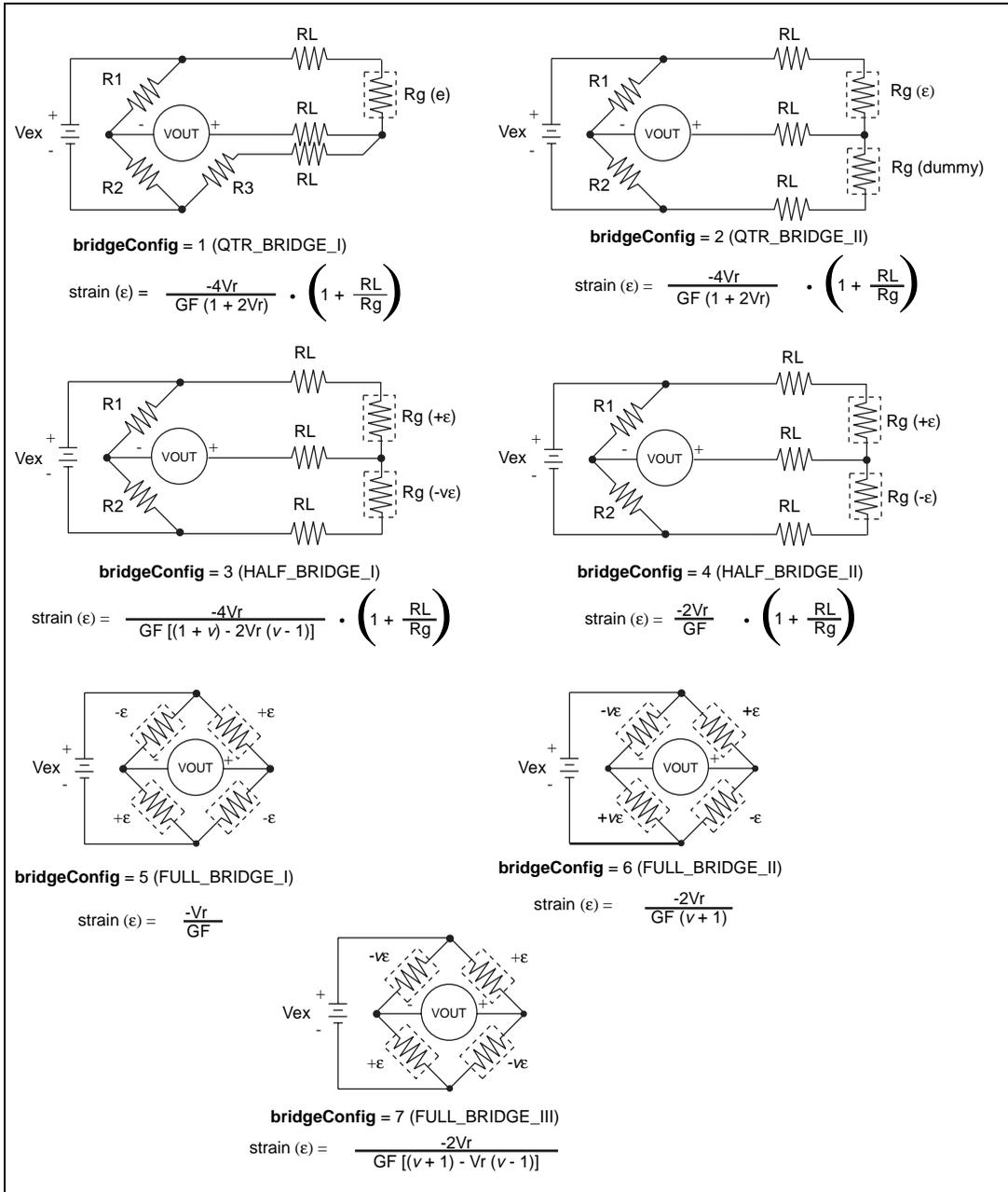


Figure 3-41. Strain Gauge Bridge Configuration

Thermistor_Convert and Thermistor_Buf_Convert

Purpose

Converts a voltage or voltage buffer that was read from a thermistor to temperature. Some SCXI terminal blocks have onboard thermistors that you can use to do cold-junction compensation.

Parameter Discussion

V_{ref} is the voltage reference you apply across the thermistor circuit (see Figure 3-42). The thermistor on the SCXI terminal blocks has a V_{ref} of 2.5 V.

R_1 is the value expressed in Ohms of the resistor in series with your thermistor (see Figure 3-42). The thermistor on the SCXI terminal blocks has an R_1 value of 5,000 Ω .

The **TempScale** integer indicates in which temperature unit you want your return values to be. Constant definitions for each temperature scale are assigned in the conversion header file.

- 1: Celsius
- 2; Fahrenheit
- 3: kelvin
- 4: Rankine

The `Thermistor_Convert` function has two remaining parameters—**Volts** is the voltage that you read from the thermistor, and **Temperature** is the return temperature value assigned in units determined by **TempScale**.

The `Thermistor_Buf_Convert` function has three remaining parameters—**numPts** is the number of voltage points to convert, **VoltBuf** is the array of voltages that you read from the thermistor, and **TempBuf** is the return array of temperature values assigned in units determined by **TempScale**.

Using This Function

The following equation expresses the relationship between **Volts** and **R_t**, the thermistor resistance (see Figure 3-42).

$$\mathbf{Volts} = \mathbf{V_{ref}} (\mathbf{R_t} / (\mathbf{R_1} + \mathbf{R_t}))$$

Solving the previous equation for **R_t**, we have:

$$\mathbf{R_t} = \mathbf{R_1} (\mathbf{Volts} / (\mathbf{V_{ref}} - \mathbf{Volts}))$$

Once this function calculates **R_t**, the function uses the following equation to convert **R_t**, the thermistor resistance, to temperature in kelvin. The function then converts the temperature to the temperature scale you want, if necessary.

$$T = 1 / (a + b(\ln R_t) + c(\ln R_t)^3)$$

The values used for **a**, **b**, and **c** are given below. If you are using a thermistor with different values for **a**, **b**, and **c** (consult your thermistor data sheet), you can edit the thermistor conversion routine to use your own **a**, **b**, and **c** values.

$$a = 1.295361E-3$$

The following equation expresses the relationship between **Volts** and **R_t**, the thermistor resistance (see Figure 3-42).

$$\mathbf{Volts} = \mathbf{V_{ref}} (R_t / (\mathbf{R_1} + R_t))$$

Solving the previous equation for **R_t**, you have:

$$R_t = \mathbf{R_1} (\mathbf{Volts} / (\mathbf{V_{ref}} - \mathbf{Volts}))$$

When you calculate **R_t**, you use the following equation to convert **R_t**, the thermistor resistance, to temperature in kelvin. We then convert the temperature to the temperature scale you want, if necessary.

$$T = 1 / (a + b(\ln R_t) + c(\ln R_t)^3)$$

The values used for **a**, **b**, and **c** are shown below. These values are correct for the thermistors provided on the SCXI terminal blocks. If you are using a thermistor with different values for **a**, **b**, and **c** (consult your thermistor data sheet), you can edit the thermistor conversion routine to use your own **a**, **b**, and **c** values.

$$a = 1.295361E-3$$

$$b = 2.343159E-4$$

$$c = 1.018703E-7$$

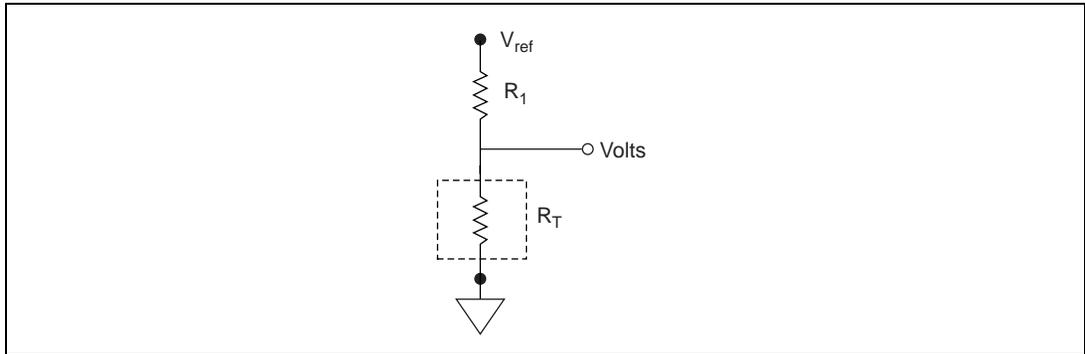


Figure 3-42. Circuit Diagram of a Thermistor in a Voltage Divider

Thermocouple_Convert

and

Thermocouple_Buf_Convert

Purpose

Converts a voltage or voltage buffer that NI-DAQ read from a thermocouple into temperature.

Parameter Discussion

The **TCType** integer indicates what type of thermocouple NI-DAQ used to read the temperature. Constant definitions for each thermocouple type are shown in the conversion header file. You can use the constants that have been defined, or you can pass integer values to the routine.

- 1: E
- 2: J
- 3: K
- 4: R
- 5: S
- 6: T
- 7: B
- 8: N

CJCTemp is the temperature in Celsius that NI-DAQ uses for cold-junction compensation of the thermocouple temperature. If you are using SCXI, most likely this is the temperature that NI-DAQ read from the temperature sensor on the SCXI terminal block. The AMUX-64T also has a temperature sensor that you can use for this purpose.

The **TempScale** integer indicates in which temperature unit you want your return values to be. Constant definitions for each temperature scale are shown in the conversion header file.

- 1: Celsius
- 2: Fahrenheit
- 3: kelvin
- 4: Rankine

The `Thermocouple_Convert` routine has two remaining parameters—**TCVolts** is the voltage that NI-DAQ read from the thermocouple, and **TCTemp** is the return temperature value.

The `Thermocouple_Buf_Convert` routine has three remaining parameters—**numPts** is the number of voltage points to convert, **TCVoltBuf** is the array that contains the voltages that NI-DAQ read from the thermocouple, and **TCTempBuf** is the return array that contains the temperatures.

Using This Function

These routines convert **TCVolts** (or each element of **TCVoltBuf**) into a corresponding temperature after performing the necessary cold-junction compensation. Cold-junction compensation is done by converting **CJCTemp** into an equivalent thermocouple voltage and adding it to **TCVolts**. The actual temperature-to-voltage conversion is done by choosing the appropriate reference equation that characterizes the correct temperature subrange for the specific **TCType**. The valid temperature range for a given **TCType** is divided into several subranges with each subrange characterized by a reference equation. The computed voltage is then added to **TCVolts** to perform the cold-junction correction. The conversion of **TCVolts** into a corresponding temperature is done by using inverse equations that are specified for a given **TCType** for different subranges. These inverse equations have an error tolerance as shown in Table 3-15. All the reference equations and inverse equations used in these routines are from *NIST Monograph 175*.

Table 3-15 shows the valid temperature ranges and accuracies for the inverse equations used for each thermocouple type. The errors listed in the table refer to the equations only; they do not take into consideration the accuracy of the thermocouple itself, the SCXI modules, or the DAQ device that is used to take the voltage reading.

Table 3-15. Temperature Error for Thermocouple Inverse Equations

Thermocouple Type	Temperature Range	Error
B	250° to 700° C 700° to 1,820° C	-0.02° to +0.03° C -0.01° to +0.02° C
E	-200° to 0° C 0° to 1,000° C	-0.01° to +0.03° C ±0.02° C
J	-210° to 0° C 0° to 760° C 760° to 1,200° C	-0.05° to +0.03° C ±0.04° C -0.04° to +0.03° C
K	-200° to 0° C 0° to 500° C 500° to 1,372° C	-0.02° to +0.04° C -0.05° to +0.04° C -0.05° to +0.06° C
N	-200° to 0° C 0° to 600° C 600° to 1,300° C	-0.02° to +0.03° C -0.02° to +0.03° C -0.04° to +0.02° C
R	-50° to 250° C 250° to 1,200° C 1,200° to 1,664.5° C 1,664.5° to 1,768.1° C	±0.02° C ±0.005° C -0.0005° to +0.001° C -0.001° to +0.002° C
S	-50° to 250° C 250° to 1,200° C 1,200° to 1,664.5° C 1,664.5° to 1,768.1° C	±0.02° C ±0.01° C ±0.0002° C ±0.002° C
T	-200° to 0° C 0° to 400° C	-0.02° to +0.04° C ±0.03° C

DMA and Programmed I/O Performance Limitations

Chapter

4

This chapter discusses data acquisition performance reductions caused by interrupt latency in the Windows programming environment.

DIG_Block, DAQ, SCAN, and WFM operations all input or output blocks of data to or from a plug-in DAQ device. For input operations, NI-DAQ must transfer the incoming data to a buffer in the computer memory. For output operations, NI-DAQ must transfer outgoing data from a buffer in the computer memory to the DAQ device. NI-DAQ uses two mechanisms to perform the data transfer. The first option, programmed I/O, transfers each data point through software. The second option is to use the DMA controller chip to perform a hardware transfer of the data. The speed of analog and digital input and output operations is limited by the transfer mechanism as well as by the computer, device, and operating system. This chapter explains the performance limitations for Windows applications.

Explanation of Programmed I/O and DMA Transfers

Programmed I/O is a software-intensive method for transferring data from computer memory to an I/O device, in this case a data acquisition plug-in device. For each data point, the CPU must execute code that transfers data to the device. Therefore, the CPU is tied up while data is being written to or read from the device. The CPU is free to execute other code, including applications, when it is not writing or reading data to or from the device.

NI-DAQ utilizes interrupt service routines to do background transfers to DAQ devices. The CPU is interrupted to do data transfers only when the device asserts an interrupt indicating it is ready for the next data point to be read or written.

In contrast, *DMA transfers* use hardware rather than software to transfer data between computer memory and the device. This is accomplished by programming the DMA controller chip. The DMA chip performs the transfers between memory and I/O devices independently of the CPU. As a result, the CPU is freed from having to execute code to transfer

each individual data point, making it available for executing your applications. Of course, the CPU and DMA share control of the same bus, so some decline in computer performance can occur even when using DMA transfers.

Programmed I/O or DMA

Whether NI-DAQ uses programmed I/O or DMA depends on the device and the transfer mode that you select. If you have an analog input and/or output device or a DIO-32, refer to the `Set_DAQ_Device_Info` function description in the *Function Reference* chapter of the NI-DAQ Function Reference Manual to find out the transfer mode you are using. Boards that use interrupts use programmed I/O.

Using DMA on AT Bus Computers

Page Boundaries in AT Bus Computers

On AT bus computers, the DMA controller organizes computer memory addresses into pages. When performing 16-bit data transfers, the DMA can access up to 128 KB of system memory between page boundaries. If a data buffer spans a DMA page boundary, you must reprogram the DMA controller to continue DMA transfers on the next memory page. On many of the data acquisition adapters, hardware FIFOs on the adapter serve as buffers, and allocate adequate time to reprogram the DMA controller without disrupting the acquisition. However, the lack of a hardware FIFO on the AT-MIO-16F-5 analog output prohibits the device from operating at the maximum rate if the data buffer contains one or more page boundaries. In this case, the time between each DMA transfer (for example, the update interval in waveform generation) must be more than the time needed for the reprogramming. A similar situation arises if you are using an AT-DIO-32F or AT-DIO-32HS, and you have selected the transfer mode so that group 1 and group 2 each has one DMA channel available for digital input/output. The problem is less severe in the case of the AT-DIO-32HS because this device has a small FIFO buffer.

When you call `WFM_Load` to perform waveform generation on an AT-MIO-16F-5 using DMA, the function checks if the waveform buffer contains any DMA page breaks. If so, it returns a **memPageError** warning.

When the DIO-32F is configured for a pattern generation, `DIG_Block_In` and `DIG_Block_Out` return the same warning if any DMA page breaks exist in the pattern-generation buffer.

Depending on your application requirement, choose one of the following approaches to deal with the possibility of page boundaries when using an AT-MIO-16F-5, AT-DIO-32F, or AT-DIO-32HS:

- Always treat a buffer as if it contains DMA page breaks, and limit the minimum update interval to be appropriate for buffers with page breaks. This approach ensures that you can use any buffers successfully.
- If you are using an AT-MIO-16F-5 or AT-DIO-32F, prepare the buffers so that the data does not cross any DMA boundaries. The `Align_DMA_Buffer` function can shift the data to a region within the buffer without DMA page breaks. `Align_DMA_Buffer` tries to perform the alignment as long as the buffer size is greater than the amount of data in the buffer. However, to guarantee a successful alignment, the buffer size should be at least twice as large as the data set. Realigning a buffer allows maximum speed performance but limits the size of the waveform or pattern to half of the largest allocatable buffer size. There is no restriction on using both aligned and unaligned buffers in the same application.
- If you are using an AT-DIO-32F and want to use group 1 for digital input/output, you can set the transfer mode so that both DMA channels are available to group 1.
- If you are using an AT-DIO-32HS and want to optimize one group for high-speed transfers, set the transfer mode for that group so the group uses both DMA channels. If you use the transfer mode for the other group, set it to interrupt mode.

Using Physical Memory above 16 MB on ISA Bus Computers

NI-DAQ can use DMA to transfer data to and from buffers above 16 MB of physical memory on an ISA bus computer under Windows and Windows NT environments. Typically, this is a limitation because the DMA controller on ISA bus computers cannot transfer data to physical memory above the 16 MB address range. NI-DAQ uses an intermediate (mirror) buffer to transfer data to and from the DAQ device and then copy data to the user buffer above 16 MB.

You can have single or multiple devices doing multiple DMA transfers at the same time to or from memory above 16 MB. You do not need to change your application to use this feature.

NI-DAQ allocates 4 KB-long physically contiguous mirror buffers below 16 MB of physical memory for each DMA channel in the system. In Windows, this happens at Windows startup time, and in Windows NT, when Windows NT boots. This increases the possibility of successfully allocating a mirror buffer.

When doing DMA at run time, if NI-DAQ finds any part of the user buffer crossing the 16 MB DMA boundary, it does DMA into the mirror buffer associated with the DMA channel already in use. If no mirror buffer can be allocated for that particular DMA channel at startup time, NI-DAQ returns a **memLockError** to your application. NI-DAQ then copies data from the mirror buffer into the user buffer when using DMA to transfer data into the system memory from your device, and from user buffer to mirror buffer when using DMA to transfer data from the system memory to your device. Because of this copying, there might be a drop in performance when NI-DAQ is trying to use DMA to transfer data into memory above 16 MB on ISA bus computers.

Use two DMA channels when possible to take advantage of this feature and still achieve maximum performance. The mirror buffers are not used when the user buffer lies below 16 MB of physical memory.

General Windows Performance Considerations

Interrupt latency in Windows can impose performance limitations on data acquisition. The magnitude of the performance reduction depends on the device and the method used to acquire the data (programmed I/O versus DMA).

Interrupt latency is the delay between the time hardware asserts an interrupt and when the interrupt service routine is activated. In Windows, system software transfers control to the interrupt service routine, imposing a software delay. The transfer software delay makes up the majority of the time spent in servicing an interrupt, not the interrupt service routine itself.

Programmed I/O Performance in Windows

Interrupt latency hampers programmed I/O acquisition because of the additional delay it imposes before data can be input or output to or from a device by the interrupt service routine. The delay length is directly dependent on the computer speed.

Generally, individual computer performance governs the maximum programmed I/O rate that you can achieve. As your computer approaches the limit of programmed I/O performance, the CPU spends the majority of time servicing interrupts. As a result, the Windows user-interface performance becomes sluggish.

DMA Performance in Windows

Buffers Requiring Reprogramming

Interrupt latency can slow data acquisition that uses ISA DMA when DMA reprogramming is required. NI-DAQ might have to reprogram the DMA controller for four reasons:

- The DMA controllers for AT bus computers organize memory addresses into 64 KB word pages. If a data buffer spans one of the page boundaries, the DMA controller must be reprogrammed to continue the DMA transfer on the next memory page.
- In addition, large buffers on any platform might require reprogramming caused by limitations on the transfer counts that can be written to the DMA controllers. On AT bus computers, the DMA transfer count is limited to 16 bits, or 64 KB. EISA bus computers allow counts of 24 bits or 16 MB, which should be sufficient to avoid the problem in most cases.
- Reprogramming might be required because of the virtual memory management system used in Windows. When a buffer is locked into physical memory in preparation for a data acquisition operation, the buffer might be fragmented if the memory manager cannot find a large enough contiguous space in memory. Each separate piece of the buffer requires DMA reprogramming.

Why Reprogramming Limits Performance

Reprogramming the DMA controller limits performance because it can cause significant pauses between data transfer requests from the DMA controller. Pauses during high-speed input operations can cause acquisition boards to miss or overwrite data points. For output

operations, pauses might result in glitches in waveform or pattern generations (time lapses greater than the programmed period between data points). The maximum pause length is equal to the interrupt latency plus the time to reprogram the DMA controller.

Results of Performance Limitation

DMA performance limitations manifest themselves in different ways:

- DMA reprogramming for analog input and digital pattern generation input might cause a FIFO overflow error. FIFO overflows occur when an input device is forced to overwrite unretrieved data in the FIFO. This happens during DMA reprogramming when there is a pause between DMA transfer requests to the device.
- DMA reprogramming for analog waveform generation and digital pattern generation output might cause update errors. Update errors occur when the output device cannot update the output data because the DMA controller has not transferred the next data point to the device. Again, the reason for this delay is the pause in DMA transfer requests caused by reprogramming.
- With digital input and output boards that use DMA, transfers using full handshaking are not affected by the DMA reprogramming, aside from possibly causing the transfer to be slower. On the other hand, DMA reprogramming affects digital pattern generation.
- The AT-DIO-32F does not detect overflow or update errors; NI-DAQ cannot explicitly warn you when DMA reprogramming is causing a performance problem during pattern generation with these boards. For this reason, the `DIG_Block_In` and `DIG_Block_Out` functions return a warning (**memPageError**) when DMA reprogramming is required.

Methods for Eliminating Performance Limitations

You can eliminate performance limitations caused by DMA reprogramming several ways:

- A FIFO on a DAQ device can buffer data during reprogramming. However, high-speed acquisitions can easily overflow a small onboard buffer during reprogramming if the interrupt latency is significant.
- Another way to avoid DMA performance limitations is to use a specialized DMA reprogramming method such as chaining or channel switching. These methods effectively eliminate the

reprogramming problem most of the time. For EISA bus computers, NI-DAQ uses chaining in all but two cases, and therefore experiences no performance limitations (exceptions are double-buffered digital I/O, and analog waveform generation with partial transfers enabled).

- NI-DAQ minimizes interrupt latency by intercepting interrupts at the Windows kernel level. Therefore, DMA can be reprogrammed as soon as possible to minimize the possibility of FIFO overflow errors.
- If you are using an AT-DIO-32F or AT-DIO-32HS, you can set the transfer mode so that both DMA channels are available to a single group. In the case of the AT-DIO-32F, this group must be group 1.

NI-DAQ Double Buffering

Chapter

5

This chapter describes using double-buffered data acquisition with NI-DAQ.

Overview

Conventional data acquisition software techniques, such as single-buffered data acquisition, work well for most applications. However, more sophisticated applications involving larger amounts of data input or output at higher rates require more advanced techniques for managing the data. One such technique is double buffering. National Instruments uses double-buffering techniques in its driver software for continuous, uninterrupted input or output of large amounts of data.

This chapter discusses the fundamentals of double buffering, including specific information on how the NI-DAQ double-buffered functions work.



Note: *Input and output refer to both digital and analog operations in this chapter.*

Single-Buffered Versus Double-Buffered Data

The most common method of data buffering found in conventional driver software is single buffering. In single-buffered input operations, a fixed number of samples are acquired at a specified rate and transferred into computer memory. After the memory buffer stores the data, the computer can analyze, display, or store the data to the hard disk for later processing. Single-buffered output operations output a fixed number of samples from computer memory at a specified rate. After the data is output, the buffer can be updated with new or freed data.

Single-buffered operations are relatively simple to implement, can usually take advantage of the full hardware speed of the DAQ device, and are very useful for many applications. The major disadvantage of single-buffered operation is that the amount of data that can be input or

output at any one time is limited to the amount of free memory available in the computer.

In double-buffered operations, the data buffer is configured as a circular buffer. For input operations, the DAQ device fills the circular buffer with data. When the end of the buffer is reached, the device returns to the beginning of the buffer and fills it with data again. This process continues *ad infinitum* until it is interrupted by a hardware error or cleared by a function call.

Double-buffered output operations also use a circular buffer. In this case, however, the DAQ device retrieves data from the circular buffer for output. When the end of the buffer is reached, the device begins retrieving data from the beginning of the buffer again. As for input, the process continues *ad infinitum* until it is interrupted by a hardware error or cleared by a function call.

Unlike single-buffered operations, double-buffered operations reuse the same buffer and are therefore able to input or output an infinite number of data points without requiring an infinite amount of memory. However, for double buffering to be useful, there must be a means by which to access the data for updating, storage, and processing. The next two sections explain how to access the data for double-buffered input and output operations.

Double-Buffered Input Operations

The data buffer for double-buffered input operations is configured as a circular buffer. In addition, NI-DAQ logically divides the buffer into two equal halves (no actual division exists in the buffer). By dividing the buffer into two halves, NI-DAQ can coordinate user access to the data buffer with the DAQ device. The coordination scheme is simple—NI-DAQ copies data from the circular buffer in sequential halves to a transfer buffer you create. You can process or store the data in the transfer buffer however you choose.

Figure 5-1 illustrates a series of sequential data transfers.

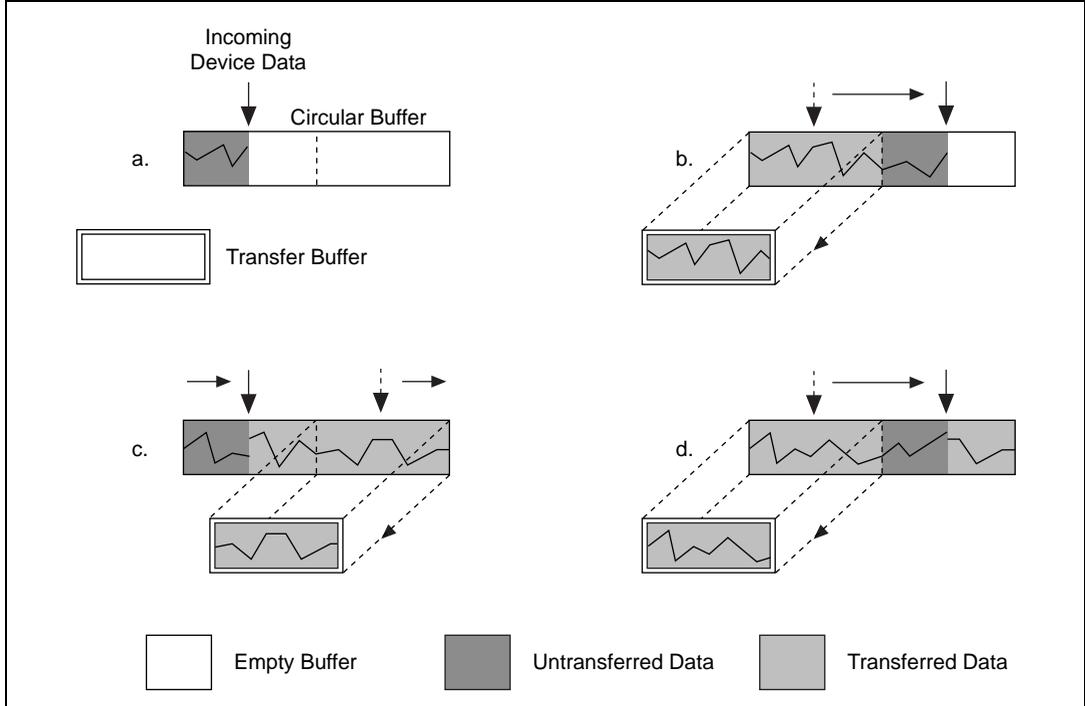


Figure 5-1. Double-Buffered Input with Sequential Data Transfers

The double-buffered input operation begins when the DAQ device starts writing data into the first half of the circular buffer (Figure 5-1a). After the device begins writing to the second half of the circular buffer, NI-DAQ can copy the data from the first half into the transfer buffer (Figure 5-1b). You can then store the data in the transfer block to disk or process it according to your application needs. After the input device has filled the second half of the circular buffer, the device returns to the first half buffer and overwrites the old data. NI-DAQ can now copy the second half of the circular buffer to the transfer buffer (Figure 5-1c). The data in the transfer buffer is again available for use by your application. The process can be repeated endlessly to produce a continuous stream of data to your application. Notice that Figure 5-1d is equivalent to the step in Figure 5-1b and is the start of a two-step cycle.

Potential Setbacks

The double-buffered coordination scheme is not flawless. An application might experience two possible problems with double-buffered input. The first is the possibility of the DAQ device overwriting data before NI-DAQ has copied it to the transfer buffer. This situation is illustrated by Figure 5-2.

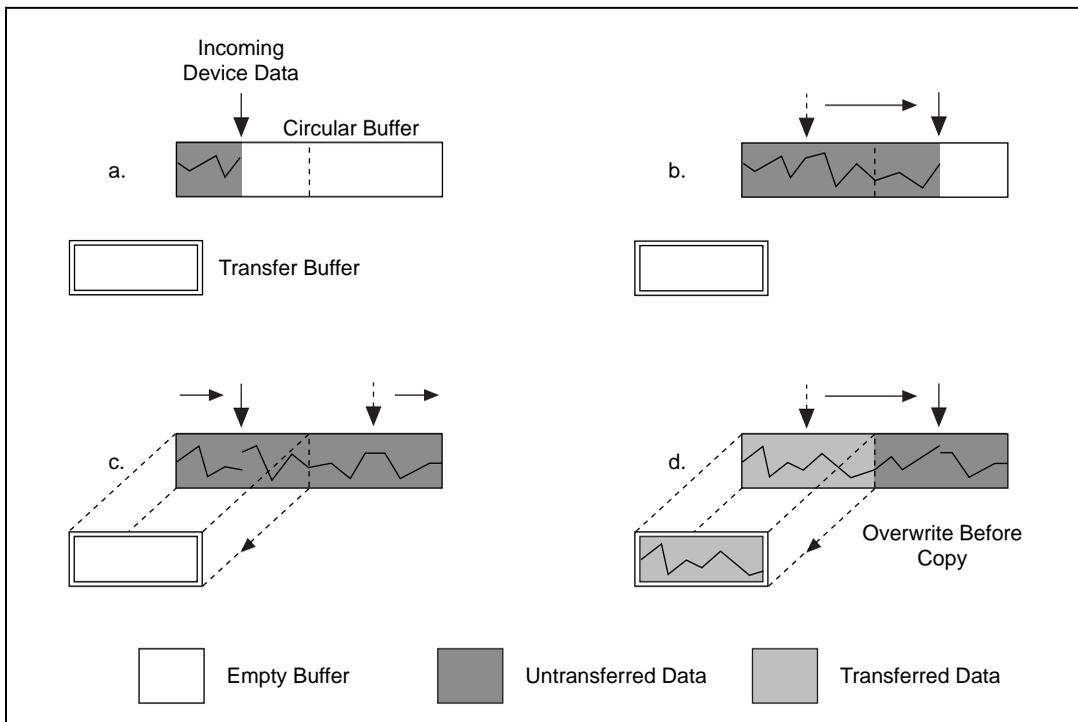


Figure 5-2. Double-Buffered Input with an Overwrite Before Copy

Notice that in Figure 5-2b, NI-DAQ has missed the opportunity to copy data from the first half of the circular buffer to the transfer buffer while the DAQ device is writing data to the second half. As a result, the DAQ device begins overwriting the data in the first half of the circular buffer before NI-DAQ has copied it to the transfer buffer (Figure 5-2c). To guarantee uncorrupted data, NI-DAQ must wait until the device finishes overwriting data in the first half before copying the data into the transfer buffer. After the device has begun to write to the second half, NI-DAQ copies the data from the first half of the circular buffer to the transfer buffer (Figure 5-2d).

For the previously described situation, NI-DAQ returns an overwrite before copy warning (**overWriteError**). This warning indicates that the data in the transfer buffer is valid, but some earlier input data has been lost. Subsequent transfers will not return the warning as long as they keep pace with the DAQ device as in Figure 5-1.

The second potential problem occurs when an input device overwrites data that NI-DAQ is simultaneously copying to the transfer buffer. NI-DAQ returns an overwrite error (**overWriteError**) when this occurs. The situation is presented in Figure 5-3.

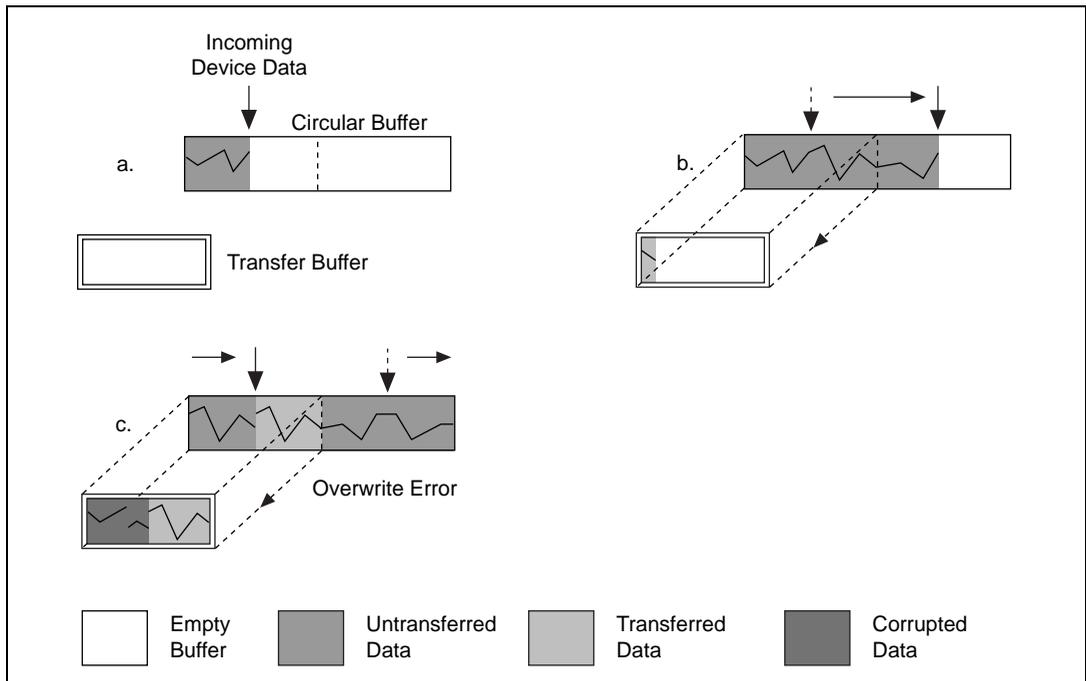


Figure 5-3. Double-Buffered Input with an Overwrite

In Figure 5-3b, NI-DAQ has started to copy data from the first half of the circular buffer into the transfer buffer. However, NI-DAQ is unable to copy the entire half before the DAQ device begins overwriting data in the first half buffer (Figure 5-3c). Consequently, data copied into the transfer buffer might be corrupted; that is, it might contain both old and new data points. Future transfers will execute normally as long as neither of the problem conditions re-occur.

Double-Buffered Output Operations

Double-buffered output operations are similar to input operations. The circular buffer is again logically divided into two halves. By dividing the buffer into two halves, NI-DAQ can coordinate user access to the data buffer with the DAQ device. The coordination scheme is simple—NI-DAQ copies data from a transfer buffer you create to the circular buffer in sequential halves. The data in the transfer buffer can be updated between transfers.

Figure 5-4 illustrates a series of sequential data transfers.

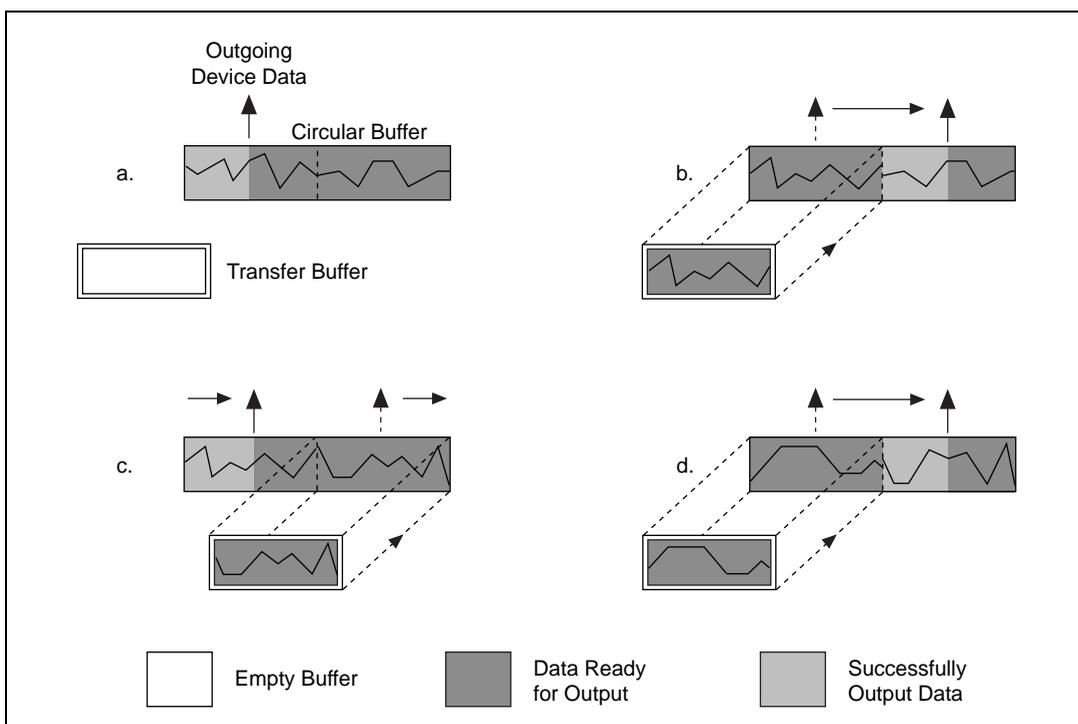


Figure 5-4. Double-Buffered Output with Sequential Data Transfers

The double-buffered output operation begins when the output device begins outputting data from the first half of the circular buffer (Figure 5-4a). After the device begins retrieving data from the second half of the circular buffer, NI-DAQ can copy the prepared data from the transfer buffer to the first half of the circular buffer (Figure 5-4b). Your application can then update the data in the transfer buffer. After the

output device is finished with the second half of the circular buffer, the device returns to the first half buffer and begins outputting updated data from the first half. NI-DAQ can now copy the transfer buffer to the second half of the circular buffer (Figure 5-4c). The data in the transfer buffer is again available for update by your application. The process can be repeated endlessly to produce a continuous stream of output data from your application. Notice that Figure 5-4d is equivalent to the step in Figure 5-4b and is the start of a two-step cycle.

Potential Setbacks

Like double-buffered input, double-buffered output has two potential problems. The first is the possibility of the output device retrieving and outputting the same data before NI-DAQ has updated the circular buffer with new data from the transfer buffer. This situation is illustrated by Figure 5-5.

Notice in Figure 5-5b, NI-DAQ has missed the opportunity to copy data from the transfer buffer to the first half of the circular buffer while the output device is retrieving data from the second half. As a result, the device begins to output the original data in the first half of the circular buffer before NI-DAQ has updated it with data from the transfer buffer (Figure 5-5c). To guarantee uncorrupted output data, NI-DAQ is forced to wait until the device finishes retrieving data from the first half before copying the data from the transfer buffer. After the device has begun to output the second half, NI-DAQ copies the data from the transfer buffer to the first half of the circular buffer (Figure 5-5d).

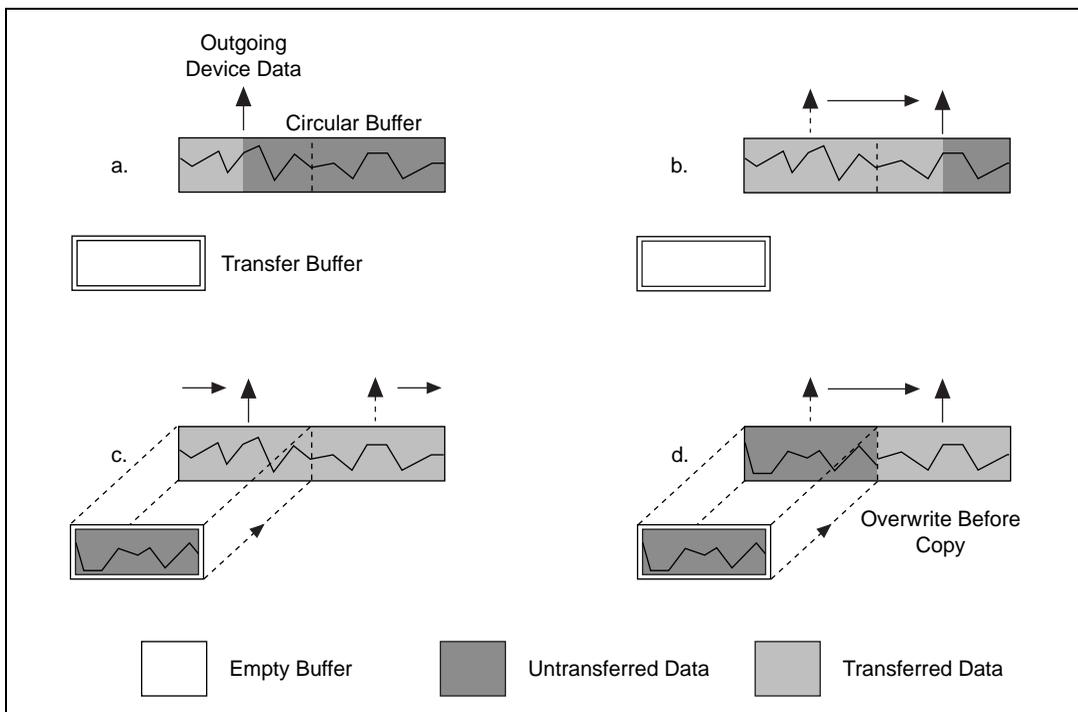


Figure 5-5. Double-Buffered Output with an Overwrite Before Copy

For this situation, NI-DAQ returns an overwrite before a copy warning (**overWriteError**). This warning indicates that the device has output old data but the data was uncorrupted during output. Subsequent transfers will not return the warning as long as they keep pace with the output device as in Figure 5-4.

The second potential problem is when an output device retrieves data that NI-DAQ is simultaneously overwriting with data from the transfer buffer. NI-DAQ returns an overwrite error (**overWriteError**) when this occurs. The situation is presented in Figure 5-6.

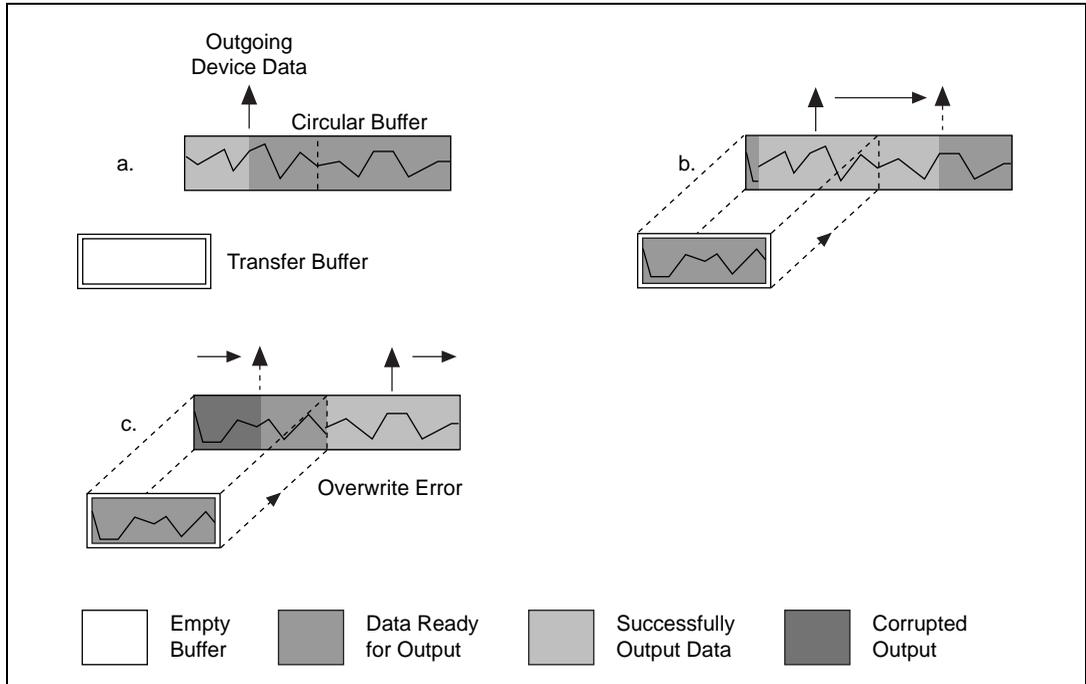


Figure 5-6. Double-Buffered Output with an Overwrite

In Figure 5-6b, NI-DAQ has started to copy data from the transfer buffer to the first half of the circular buffer. However, NI-DAQ is unable to copy all of the data before the output device begins retrieving data from the first half (Figure 5-6c). Consequently, device data output might be corrupted; it might contain both old and new data points. Future transfers will execute normally as long as neither of these problem conditions occur again.

Double-Buffered Functions

Double-buffered functions exist for analog input (DAQ), analog output (WFM), and digital input and output (DIG) operations. The functions and the order in which your application should call them is nearly identical for all four operations. This section explains what each of the functions do and the order in which you should call them.

DB_Config Functions

The `DB_Config` functions enable and disable double buffering for input and output operations, and you can select double-buffering options if any are available.

The configuration functions are as follows:

- `DAQ_DB_Config`
- `WFM_DB_Config`
- `DIG_DB_Config`

For analog input operations, call `DAQ_DB_Config` prior to calling `DAQ_Start`, or a `SCAN_Start` to enable or disable double buffering. For waveform operations, call `WFM_DB_Config` prior to calling `WFM_Load` to enable or disable double buffering. For digital block input and output operations, call `DIG_DB_Config` prior to calling `DIG_Block_In`, or `DIG_Block_Out` to enable or disable double buffering.

DB_Transfer Functions

After a double-buffered operation begins, the `DB_Transfer` functions transfer data to or from a circular buffer. The direction of the transfer depends on the direction of the double-buffered operations. Along with copying data, the `DB_Transfer` functions also check for possible errors during the transfer.

For input operations, `DB_Transfer` copies data from alternating halves of the circular input buffer to the transfer buffer. For output operations, `DB_Transfer` copies data from the buffer passed to the function to alternating halves of the circular output buffer. The function might return an overwrite before a copy warning or an overwrite error (**overWriteError**) if a problem occurs during the transfer.



Note: *Waveform transfer functions do not detect overwrite before copy or overwrite errors.*

The `DB_Transfer` functions are synchronous for both input and output operations. In other words, when your application calls these functions, NI-DAQ does not return control to your application until the transfer is complete. As a result, your application might crash if NI-DAQ cannot complete the transfer. To avoid this situation, call the `Timeout_Config` function prior to starting a double-buffered operation. The timeout

configuration function sets the maximum time allocated to complete a synchronous function call for a device.

The transfer functions are as follows:

- DAQ_DB_Transfer
- WFM_DB_Transfer
- DIG_DB_Transfer

For analog input operations, call `DAQ_DB_Transfer` after starting a double-buffered analog acquisition to perform a double-buffered transfer. For waveform operations, call `WFM_DB_Transfer` after starting a double-buffered waveform generation to perform a double-buffered transfer. For digital block input and output operations, call `DIG_DB_Transfer` after starting a double-buffered digital operation to perform a double-buffered transfer.

DB_HalfReady Functions

With the `DB_HalfReady` functions, applications can avoid the delay possible when calling the `DB_Transfer` function. When you call either of the transfer functions, NI-DAQ waits until the transfer to or from the circular buffer can be made; that is, the DAQ device is operating on the opposite half of the circular buffer.

The `DB_HalfReady` functions check if a `DB_Transfer` can be completed immediately. If the call to `DB_HalfReady` indicates a transfer cannot be made, your application can do other work and try again later.

The `HalfReady` functions are as follows:

- DAQ_DB_HalfReady
- WFM_DB_HalfReady
- DIG_DB_HalfReady

For analog input operations, call `DAQ_DB_HalfReady`, after starting a double-buffered analog acquisition but prior to calling `DAQ_DB_Transfer`, to check the transfer status of the operation.

For analog output problems, call `WFM_DB_HalfReady`, after starting a double-buffered waveform generation but prior to calling `WFM_DB_Transfer`, to check the transfer status of the operation.

For digital block input and output operations, call `DIG_DB_HalfReady`, after starting a double-buffered digital operation but prior to calling `DIG_DB_Transfer`, to check the transfer status of the operation.

Conclusion

Double buffering is a data acquisition software technique for continuously inputting or outputting large amounts of data with limited available system memory. However, double buffering might not be practical for high-speed input or output applications. The throughput of a double-buffered operation is typically limited by the ability of the CPU to process the data within a given period of time. Specifically, data must be processed by the application at least as fast as the rate at which the device is writing or reading data. For many applications, this requirement depends on the speed and efficiency of the computer system and programming language.

Customer Communication

For your convenience, this appendix contains forms to help you gather the information necessary to help us solve your technical problems and a form you can use to comment on the product documentation. When you contact us, we need the information on the Technical Support Form and the configuration form, if your manual contains one, about your system configuration to answer your questions as quickly as possible.

National Instruments has technical assistance through electronic, fax, and telephone systems to quickly provide the information you need. Our electronic services include a bulletin board service, an FTP site, a fax-on-demand system, and e-mail support. If you have a hardware or software problem, first try the electronic support systems. If the information available on these systems does not answer your questions, we offer fax and telephone support through our technical support centers, which are staffed by applications engineers.

Electronic Services

Bulletin Board Support

National Instruments has BBS and FTP sites dedicated for 24-hour support with a collection of files and documents to answer most common customer questions. From these sites, you can also download the latest instrument drivers, updates, and example programs. For recorded instructions on how to use the bulletin board and FTP services and for BBS automated information, call 512 795 6990. You can access these services at:

United States: 512 794 5422

Up to 14,400 baud, 8 data bits, 1 stop bit, no parity

United Kingdom: 01635 551422

Up to 9,600 baud, 8 data bits, 1 stop bit, no parity

France: 01 48 65 15 59

Up to 9,600 baud, 8 data bits, 1 stop bit, no parity

FTP Support

To access our FTP site, log on to our Internet host, `ftp.natinst.com`, as anonymous and use your Internet address, such as `joesmith@anywhere.com`, as your password. The support files and documents are located in the `/support` directories.

Fax-on-Demand Support

Fax-on-Demand is a 24-hour information retrieval system containing a library of documents on a wide range of technical information. You can access Fax-on-Demand from a touch-tone telephone at 512 418 1111.

E-Mail Support (Currently USA Only)

You can submit technical support questions to the applications engineering team through e-mail at the Internet address listed below. Remember to include your name, address, and phone number so we can contact you with solutions and suggestions.

support@natinst.com

Telephone and Fax Support

National Instruments has branch offices all over the world. Use the list below to find the technical support number for your country. If there is no National Instruments office in your country, contact the source from which you purchased your software to obtain support.

Country	Telephone	Fax
Australia	03 9879 5166	03 9879 6277
Austria	0662 45 79 90 0	0662 45 79 90 19
Belgium	02 757 00 20	02 757 03 11
Brazil	011 288 3336	011 288 8528
Canada (Ontario)	905 785 0085	905 785 0086
Canada (Quebec)	514 694 8521	514 694 4399
Denmark	45 76 26 00	45 76 26 02
Finland	09 725 725 11	09 725 725 55
France	01 48 14 24 24	01 48 14 24 14
Germany	089 741 31 30	089 714 60 35
Hong Kong	2645 3186	2686 8505
Israel	03 6120092	03 6120095
Italy	02 413091	02 41309215
Japan	03 5472 2970	03 5472 2977
Korea	02 596 7456	02 596 7455
Mexico	5 520 2635	5 520 3282
Netherlands	0348 433466	0348 430673
Norway	32 84 84 00	32 84 86 00
Singapore	2265886	2265887
Spain	91 640 0085	91 640 0533
Sweden	08 730 49 70	08 730 43 70
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Prefix	Meaning	Value
μ -	micro-	10^{-6}
m-	milli-	10^{-3}
k-	kilo-	10^3
M-	mega-	10^6

Numbers/Symbols

β	coefficient
∂	coefficient
$^{\circ}$	degree
-	minus
Ω	ohm
%	percent
+	plus
\pm	plus or minus
ϵ	strain
α	temperature coefficient at $T = 0^{\circ} \text{C}$

A

AC	alternating current
ACK	acknowledge
A/D	analog-to-digital
ADC	A/D converter. An electronic device, often an integrated circuit, that converts an analog voltage to a digital number.
ADC resolution	The resolution of the ADC, which is measured in bits. An ADC with 16 bits has a higher resolution, and thus a higher degree of accuracy, than a 12-bit ADC.
AI	analog input
AMD	Advanced Micro Devices
analog trigger	A trigger that occurs at a user-selected point on an incoming analog signal. Triggering can be set to occur at a specific level on either an increasing or a decreasing signal (positive or negative slope). Analog triggering can be implemented either in software or in hardware. When implemented in software (LabVIEW), all data is collected, transferred into system memory, and analyzed for the trigger condition. When analog triggering is implemented in hardware, no data is transferred to system memory until the trigger condition has occurred.
API	application programming interface
ARB	Pertaining to arbitrary waveform generation (DAQArb 5411 devices only).
asynchronous	(1) Hardware—A property of an event that occurs at an arbitrary time, without synchronization to a reference clock. (2) Software—A property of a function that begins an operation and returns prior to the completion or termination of the operation.

B

background acquisition	Data is acquired by a DAQ system while another program or processing routine is running without apparent interruption.
base address	A memory address that serves as the starting address for programmable registers. All other addresses are located by adding to the base address.
BCD	binary-coded decimal
BIOS	basic input/output system
bipolar	A signal range that includes both positive and negative values (for example, -5 V to $+5\text{ V}$).
bit	One binary digit, either 0 or 1.
block-mode	A high-speed data transfer in which the address of the data is sent followed by a specified number of back-to-back data words.
bus	The group of conductors that interconnect individual circuitry in a computer. Typically, a bus is the expansion vehicle to which I/O or other devices are connected. Examples of PC buses are the PCI bus, AT bus, and EISA bus.
byte	Eight related bits of data, an 8-bit binary number. Also used to denote the amount of memory required to store one byte of data.

C

C	Celsius
CI	computing index
cold-junction compensation	A method of compensating for inaccuracies in thermocouple circuits.
compiler	A software utility that converts a source program in a high-level programming language, such as C/C++, Visual Basic (version 5.0), or Borland Delphi, into an object or compiled program in machine language. Compiled programs run 10 to 1,000 times faster than interpreted programs.

conversion time	The time required, in an analog input or output system, from the moment a channel is interrogated (such as with a read instruction) to the moment that accurate data is available.
counter/timer	A circuit that counts external pulses or clock pulses (timing).
coupling	The manner in which a signal is connected from one location to another.
CPU	central processing unit

D

D/A	digital-to-analog
DAC	D/A converter. An electronic device, often an integrated circuit, that converts a digital number into a corresponding analog voltage or current.
DAQ	Data acquisition. (1) Collecting and measuring electrical signals from sensors, transducers, and test probes or fixtures and inputting them to a computer for processing. (2) Collecting and measuring the same kinds of electrical signals with A/D and/or DIO boards plugged into a PC, and possibly generating control signals with D/A and/or DIO boards in the same PC.
DC	direct current
DDS	Direct Digital Synthesis
device	Device is used to refer to a DAQ device inside your computer or attached directly to your computer via a parallel port. Plug-in boards, PCMCIA cards, and devices such as the DAQPad-1200, which connects to your computer parallel port, are all examples of DAQ devices. SCXI modules are distinct from devices, with the exception of the SCXI-1200 and SCXI-2400, which are hybrids.
differential input	An analog input consisting of two terminals, both of which are isolated from computer ground, whose difference is measured.
digital port	<i>See</i> port.
DIN	Deutsche Industrie Norme
DIO	digital I/O

dithering	The addition of Gaussian noise to the analog input signal.
DLL	Dynamic-link library. A software module in Microsoft Windows containing executable code and data that can be called or used by Windows applications or other DLLs. Functions and data in a DLL are loaded and linked at run time when they are referenced by a Windows application or other DLLs.
DMA	Direct memory access. A method by which data can be transferred to/from computer memory from/to a device or memory on the bus while the processor does something else. DMA is the fastest method of transferring data to/from computer memory.
driver	Software that controls a specific hardware device such as a DAQ board or a GPIB interface board.
DSP	digital signal processing

E

EEPROM	Electrically erasable programmable read-only memory. ROM that can be erased with an electrical signal and reprogrammed.
EGA	enhanced graphics adapter
EISA	Extended Industry Standard Architecture
external trigger	A voltage pulse from an external source that triggers an event such as A/D conversion.

F

FIFO	A first-in first-out memory buffer; the first data stored is the first data sent to the acceptor. FIFOs are often used on DAQ devices to temporarily store incoming or outgoing data until that data can be retrieved or output. For example, an analog input FIFO stores the results of A/D conversions until the data can be retrieved into system memory, a process that requires the servicing of interrupts and often the programming of the DMA controller. This process can take several milliseconds in some cases. During this time, data accumulates in the FIFO for future retrieval. With a larger FIFO, longer latencies can be tolerated. In the case of analog output, a FIFO permits faster update
------	--

rates, because the waveform data can be stored on the FIFO ahead of time. This again reduces the effect of latencies associated with getting the data from system memory to the DAQ device.

G

gain	The factor by which a signal is amplified, sometimes expressed in decibels.
group	A collection of digital ports, combined to form a larger entity for digital input and/or output.
GUI	graphical user interface

H

Hz	hertz
----	-------

I

ID	identification
IDE	Integrated Development Environment
IEEE	Institute of Electrical and Electronics Engineers
interrupt	A computer signal indicating that the CPU should suspend its current task to service a designated activity.
interrupt latency	The delay between the time hardware asserts an interrupt and when the interrupt service routine is activated.
I/O	input/output
IRQ	interrupt request
ISA	Industry Standard Architecture
iterations	repetitions of the buffer

K

kS	1,000 samples
Kword	1,024 words of memory

L

library	A file containing compiled object modules, each comprised of one of more functions, that can be linked to other object modules that make use of these functions. <code>NIDAQMSC.LIB</code> is a library that contains NI-DAQ functions. The NI-DAQ function set is broken down into object modules so that only the object modules that are relevant to your application are linked in, while those object modules that are not relevant are not linked.
linker	A software utility that combines object modules (created by a compiler) and libraries, which are collections of object modules, into an executable program.
LSB	least significant bit

M

MB	megabytes of memory
MIO	multifunction I/O
MS	million samples
multirate scanning	scanning different channels at different rates
mux	Multiplexer; a switching device with multiple inputs that sequentially connects each of its inputs to its output, typically at high speeds, in order to measure several signals with a single analog input channel.

N

NC	normally closed
NO	normally open

O

output settling time The amount of time required for the analog output voltage to reach its final value within specified limits.

P

paging A technique used for extending the address range of a device to point into a larger address space.

PC personal computer

port A digital port, consisting of four or eight lines of digital input and/or output.

posttriggering The technique used on a DAQ board to acquire a programmed number of samples after trigger conditions are met.

pretriggering The technique used on a DAQ board to keep a continuous buffer filled with data, so that when the trigger conditions are met, the sample includes the data leading up to the trigger condition.

programmed I/O The standard method a CPU uses to access an I/O device—each byte of data is read or written by the CPU.

pts points

PXI Stands for PCI eXtensions for Instrumentation. PXI is an open specification that builds off the CompactPCI specification by adding instrumentation-specific features.

R

RAM random-access memory

Remote SCXI An SCXI configuration in which a serial port cable is connected to an SCXI-2000 chassis or an SCXI-100X chassis with an SCXI-2400 remote communications module. Multiple Remote SCXI units can be connected to one serial port in a PC by using RS-485. You can use either an RS-485 interface card in your PC or an RS-485 converter on the RS-232 port.

REQ request

resolution	The smallest signal increment that can be detected by a measurement system. Resolution can be expressed in bits, in proportions, or in percent of full scale. For example, a system has 12-bit resolution, one part in 4,096 resolution, and 0.0244% of full scale.
ROM	read-only memory
RTD	Resistive temperature detector. A metallic probe that measures temperature based upon its coefficient of resistivity.
RTSI	Real-Time System Integration (bus). The National Instruments timing bus that connects DAQ devices directly, by means of connectors on top of the boards, for precise synchronization of functions.
S	
s	seconds
S	samples
Sample-and-Hold (S/H)	A circuit that acquires and stores an analog voltage on a capacitor for a short period of time.
SCXI	Signal Conditioning eXtensions for Instrumentation; the National Instruments product line for conditioning low-level signals within an external chassis near sensors.
SDK	Software Development Kit
self-calibrating	A property of a DAQ device that has an extremely stable onboard reference and calibrates its own A/D and D/A circuits without manual adjustments by the user.
sequence list	(54XX boards only) A list of entries used in staging-based waveform generation for linking, looping, and generating multiple waveforms stored in the onboard memory.
Single-Ended (SE) Inputs	An analog input that is measured with respect to a common ground.
software trigger	A programmed event that triggers an event such as data acquisition.
S/s	Samples per second; used to express the rate at which a DAQ device samples an analog signal.

stage	(54XX boards only) An entry in a sequence list.
STC	System Timing Controller
synchronous	(1) Hardware—A property of an event that is synchronized to a reference clock. (2) Software—A property of a function that begins an operation and returns only when the operation is complete.

T

TC	terminal count
throughput rate	The data, measured in bytes/s, for a given continuous operation, calculated to include software overhead. $\text{Throughput Rate} = \text{Transfer Rate} - \text{Software Overhead Factor}$.
transfer rate	The rate, measured in bytes/s, at which data is moved from source to destination after software initialization and set up operations; the maximum rate at which the hardware can operate.
TSR	terminate-and-stay resident

U

unipolar	A signal range that is always positive (for example, 0 to +10 V).
----------	---

V

V	volts
VDC	volts direct current
VPICD	Virtual Programmable Interrupt Controller Device
VXI	VMEbus eXtensions for Instrumentation

X

XMS	extended memory specification
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Numbers

1200 Series devices. *See* Lab and 1200 Series devices.

A

ACK1 signal

DAQDIO 6533 RTSI connections
(table), 3-101

DIO-32F RTSI connections (table), 3-100

ACK2 signal

DAQDIO 6533 RTSI connections
(table), 3-101

DIO-32F RTSI connections (table), 3-100

AI devices, terminology for (table), *xvii-xix*

AI_Change_Parameter function, 3-17

AI_Check function, 3-17

AI_Clear function, 3-17

AI_Configure function, 3-17

AI_Mux_Config function, 3-17 to 3-18

AI_Read function, 3-18

AI_Read_Scan function, 3-18

AI_Read_VScan function, 3-18

AI_Setup function, 3-18

AI_VRead function, 3-18

AI_VScale function, 3-18

Align_DMA_Buffer function, 3-2

Am9513-based MIO devices

gating modes in Am9513, 3-81 to 3-82
timebases, 3-81

AMUX-64T external multiplexer support, 3-26

Analog Alarm Event custom control, 3-11
to 3-14

analog input functions. *See* data acquisition
functions; one-shot analog input functions.

analog output application hints, 3-38 to 3-40
equivalent analog output calls (figure), 3-38
SCXI applications, 3-121
simple application, 3-39
software update application, 3-39 to 3-40

analog output functions, 3-37 to 3-38. *See also*
waveform generation functions.

AO_Change_Parameter, 3-37

AO_Configure, 3-37

AO_Update, 3-37

AO_VScale, 3-37 to 3-38

AO_VWrite, 3-38

AO_Write, 3-38

Analog Trigger Event custom control, 3-10
to 3-11

AO_Calibrate function, 3-3

AO_Change_Parameter function, 3-37

AO_Configure function, 3-37

AO_Update function, 3-37

AO_VScale function, 3-37 to 3-38

AO_VWrite function, 3-38

AO_Write function, 3-38

applications for Windows. *See* Windows.

arbitrary waveform generation, staging-based,
3-51 to 3-59

counter usage, 3-57 to 3-58

DMA waveform generation with
AT-MIO-16F-5, 3-55 to 3-56

external triggering, 3-59

FIFO lag effect, 3-58 to 3-59

flow chart, 3-53

minimum update intervals, 3-55

- reference voltages for analog output devices
 - bipolar output polarity (table), 3-54 to 3-55
 - unipolar output polarity (table), 3-54
- restrictions on use of delay rate, 3-58
- steps in, 3-51 to 3-53
- AT bus computers. *See* ISA bus computers.
- AT-AO-6/10
 - counter usage in waveform generation, 3-58
 - FIFO lag effect, 3-58 to 3-59
 - RTSI bus connections, 3-99
- AT-DIO-32F. *See* DIO-32F.
- AT-MIO-16D
 - counter usage in waveform generation, 3-57
 - groups of ports, 3-62
 - RTSI bus connections, 3-97
- AT-MIO-16DE-10, groups of ports, 3-62
- AT-MIO-16F-5
 - counter usage in waveform generation, 3-57
 - DMA waveform generation, 3-55 to 3-56
 - RTSI bus connections, 3-98
- AT-MIO-16X
 - counter usage in waveform generation, 3-57
 - FIFO lag effect, 3-58 to 3-59
 - restrictions on use of delay rate, 3-58
 - RTSI bus connections, 3-98
- AT-MIO-64F-5
 - FIFO lag effect, 3-58 to 3-59
 - restrictions on use of delay rate, 3-58
 - RTSI bus connections, 3-98

B

- board configuration. *See* device configuration.
- board-specific functions. *See* software-calibration and device-specific functions.
- Borland C++ Windows applications, 2-2 to 2-3
 - example programs, 2-2
- Borland Delphi, 2-7 to 2-8
- buffer allocation in Windows applications
 - Borland C++, 2-3
 - Microsoft Visual Basic, 2-6 to 2-7
- building Windows applications. *See* Windows.
- bulletin board support, A-1

C

- C applications
 - Borland C++ Windows applications, 2-2 to 2-3
 - Microsoft Visual C++, 2-3 to 2-5
- Calibrate_1200 function, 3-3 to 3-4
- Calibrate_DSA function, 3-4
- Calibrate_E_Series function, 3-4
- calibration functions. *See* software-calibration and device-specific functions.
- Config_Alarm_Deadband function, 3-5
- Config_ATrig_Event_Message function, 3-5
- Config_DAQ_Event_Message function, 3-5
- configuration. *See* device configuration.
- configuration functions. *See also* initialization and general-configuration functions.
 - AI_Change_Parameter, 3-17
 - AI_Configure, 3-17
 - AI_Mux_Config, 3-17 to 3-18
 - AI_Setup, 3-18
 - AO_Configure, 3-37
 - Config_Alarm_Deadband, 3-5
 - Config_ATrig_Event_Message, 3-5
 - Config_DAQ_Event_Message, 3-5
 - Configure_HW_Analog_Trigger, 3-4
 - CTR_Config, 3-79

- CTR_FOUT_Config, 3-79
- DAQ_Config, 3-23
- DAQ_DB_Config, 3-25, 5-10
- DAQ_StopTrigger_Config, 3-24
- DIG_Block_PG_Config, 3-64
- DIG_DB_Config, 3-65, 5-10
- DIG_Grp_Config, 3-65
- DIG_Line_Config, 3-64
- DIG_Prt_Config, 3-64
- DIG_SCAN_Setup, 3-65
- DIG_Trigger_Config, 3-65
- MIO_Config, 3-4
- SCXI_Configure_Filter, 3-104
- SCXI_Load_Config, 3-104
- SCXI_MuxCtr_Setup, 3-105
- SCXI_SCAN_Setup, 3-105
- SCXI_Set_Config, 3-105 to 3-106
- SCXI_Set_Gain, 3-106
- SCXI_Set_Input_Mode, 3-106
- SCXI_Set_State, 3-106
- SCXI_Set_Threshold, 3-106
- SCXI_Single_Chan_Setup, 3-106
- SCXI_Track_Hold_Control, 3-106
- SCXI_Track_Hold_Setup, 3-106
- Timeout_Config, 3-3
- WFM_DB_Config, 3-42
- WFM_Group_Setup, 3-42
- Configure_HW_Analog_Trigger function, 3-4
- counter usage, in waveform generation, 3-57 to 3-58
- counter/timer application hints, 3-84 to 3-93
 - counter configuration for concatenated event counting, 3-90 to 3-91
 - event counting, 3-88 to 3-91
 - event counting flow chart (figure), 3-84
 - frequency measurement, 3-89 to 3-90
 - general-purpose counter/timer functions, 3-95
 - interval counter/timer functions, 3-94
 - period and continuous pulse-width measurement, 3-91 to 3-93
 - pulse generation (figure), 3-85
 - pulse width measurement, 3-88 to 3-89
 - simultaneous counter operations (figure), 3-87
 - time-lapse measurement, 3-89
 - timer event counting (figure), 3-88
- counter/timer functions, 3-78 to 3-80. *See also* counter/timer operation.
 - CTR_Config, 3-79
 - CTR_EvCount, 3-79
 - CTR_EvRead, 3-79
 - CTR_FOUT_Config, 3-79
 - CTR_Period, 3-79
 - CTR_Pulse, 3-79
 - CTR_Rate, 3-79 to 3-80
 - CTR_Reset, 3-80
 - CTR_Restart, 3-80
 - CTR_Simul_Op, 3-80
 - CTR_Square, 3-80
 - CTR_State, 3-80
 - CTR_Stop, 3-80
 - device support, 3-78 to 3-79
 - general-purpose counter/timer functions
 - application hints, 3-95
 - GPCTR_Change_Parameter, 3-94
 - GPCTR_Configure_Buffer, 3-95
 - GPCTR_Control, 3-95
 - GPCTR_Set_Application, 3-95
 - GPCTR_Watch, 3-95
 - interval counter/timer functions
 - application hints, 3-94
 - ICTR_Read, 3-93
 - ICTR_Reset, 3-93
 - ICTR_Setup, 3-93
 - interval counter/timer block diagram, 3-94

counter/timer operation. *See also* counter/timer functions; interval counter/timer operation.

- Am9513-based MIO devices
 - gating modes in Am9513, 3-81 to 3-82
 - timebases, 3-81
- CTR function operation, 3-80 to 3-83
 - counter block diagram, 3-80
 - counter timing and output types (figure), 3-83
 - programmable frequency output operation, 3-83
- data acquisition function application hints, 3-26

- CTR_Config function, 3-79
- CTR_EvCount function, 3-79
- CTR_EvRead function, 3-79
- CTR_FOUT_Config function, 3-79
- CTR_Period function, 3-79
- CTR_Pulse function, 3-79
- CTR_Rate function, 3-79 to 3-80
- CTR_Reset function, 3-80
- CTR_Restart function, 3-80
- CTR_Simul_Op function, 3-80
- CTR_Square function, 3-80
- CTR_State function, 3-80
- CTR_Stop function, 3-80
- customer communication, *xx*, A-1 to A-2

D

- DACUPTRIG* signal (table), 3-98
- DAQ system, setting up, 1-2 to 1-3
- DAQArb 5411 devices, waveform generation using. *See* arbitrary waveform generation, staging-based.
- DAQCard-500 and DAQCard-700
 - data acquisition application hints, 3-26
 - interval counter/timer operation, 3-93 to 3-94

- DAQ_Check function, 3-23
- DAQ_Clear function, 3-23
- DAQ_Config function, 3-23
- DAQ_DB_Config function, 3-25, 5-10
- DAQ_DB_HalfReady function, 3-25, 5-11
- DAQ_DB_Transfer function, 3-25, 5-11
- DAQ_Monitor function, 3-23
- DAQ_Op function, 3-21 to 3-22
- DAQ_Rate function, 3-23
- DAQ_Set_Clock function, 3-23
- DAQ_Start function, 3-23
- DAQ_StopTrigger_Config function, 3-24
- DAQ_to_Disk function, 3-22
- DAQ_VScale function, 3-24
- data acquisition application hints, 3-26 to 3-36
 - basic building blocks, 3-27
 - building block 1: configuration functions, 3-27 to 3-28
 - building block 2: start functions, 3-29 to 3-31
 - building block 3: check functions, 3-32 to 3-33
 - building block 4: cleaning up, 3-33
- DAQCard-500/700, 516 devices, and LPM device counter/timer signals, 3-26
- double-buffered data acquisition, 3-33 to 3-34
- external multiplexer support (AMUX-64T), 3-26
- Lab and 1200 device counter/timer signals, 3-26
- data acquisition functions
 - high-level data acquisition functions, 3-21 to 3-22
 - DAQ_Op, 3-21 to 3-22
 - DAQ_to_Disk, 3-22
 - Lab_ISCAN_Op, 3-22
 - Lab_ISCAN_to_Disk, 3-22
 - SCAN_Op, 3-22
 - SCAN_to_Disk, 3-22

- low-level data acquisition functions, 3-23 to 3-25
 - DAQ_Check, 3-23
 - DAQ_Clear, 3-23
 - DAQ_Config, 3-23
 - DAQ_Monitor, 3-23
 - DAQ_Rate, 3-23
 - DAQ_Set_Clock, 3-23
 - DAQ_Start, 3-23
 - DAQ_StopTrigger_Config, 3-24
 - DAQ_VScale, 3-24
 - Lab_ISCAN_Check, 3-24
 - Lab_ISCAN_Start, 3-24
 - SCAN_Demux, 3-24
 - SCAN_Sequence_Demux, 3-24, 3-35
 - SCAN_Sequence_Retrieve, 3-24, 3-35
 - SCAN_Sequence_Setup, 3-25, 3-35
 - SCAN_Setup, 3-25
 - SCAN_Start, 3-25
- low-level double-buffered data acquisition functions, 3-25
 - DAQ_DB_Config, 3-25, 5-10
 - DAQ_DB_HalfReady, 3-25, 5-11
 - DAQ_DB_Transfer, 3-25, 5-11
- multirate scanning, 3-34 to 3-36
- data acquisition rates, SCXI modules, 3-119 to 3-121
- DB_Config functions, 5-10
- DB_HalfReady functions, 5-11 to 5-12
- delay rate usage, restrictions on, 3-58
- device configuration, 1-6 to 1-11
 - NI-DAQ hardware support (table), 1-4 to 1-5
 - non-plug and play devices on ISA (PC AT/XT) or EISA computers, 1-11
 - parallel port DAQ devices, 1-8
 - PC (PCMCIA) cards, 1-7 to 1-8
 - plug and play devices, 1-8 to 1-11
 - using NI-DAQ Configuration Utility, 1-11
- devices, generic and series names for (table), *xvii-xix*
- DIG_Block_Check function, 3-64
- DIG_Block_Clear function, 3-64
- DIG_Block_In function, 3-64
- DIG_Block_Out function, 3-64
- DIG_Block_PG_Config function, 3-64
- DIG_DB_Config function, 3-65, 5-10
- DIG_DB_HalfReady function, 3-65, 5-11
- DIG_DB_Transfer function, 3-66, 5-11
- DIG_Grp_Config function, 3-65
- DIG_Grp_Mode function, 3-65
- DIG_Grp_Status function, 3-65
- DIG_In_Grp function, 3-65
- DIG_In_Line function, 3-63
- DIG_In_Port function, 3-63
- digital I/O application hints, 3-66 to 3-78
 - digital double-buffered group block I/O, 3-73 to 3-75
 - digital group block I/O, 3-71 to 3-73
 - digital group I/O, 3-70 to 3-71
 - digital line I/O, 3-68 to 3-69
 - digital port I/O applications, 3-66 to 3-68
 - double-buffered I/O, 3-77 to 3-78
 - handshaking *versus* no-handshaking
 - digital I/O, 3-66
 - pattern generation I/O with DIO-32F and DIO 6533 (DIO-32HS), 3-76 to 3-77
 - SCXI applications, 3-122
- digital I/O functions, 3-63 to 3-65
 - DIG_In_Line, 3-63
 - DIG_In_Port, 3-63
 - DIG_Line_Config, 3-64
 - DIG_Out_Line, 3-64
 - DIG_Out_Port, 3-64
 - DIG_Prt_Config, 3-64
 - DIG_Prt_Status, 3-64
 - double-buffered digital I/O functions, 3-65 to 3-66
 - DIG_DB_Config, 3-65
 - DIG_DB_HalfReady, 3-65, 5-11

- DIG_DB_Transfer, 3-66, 5-11
- group digital I/O functions, 3-64 to 3-65
 - DIG_Block_Check, 3-64
 - DIG_Block_Clear, 3-64
 - DIG_Block_In, 3-64
 - DIG_Block_Out, 3-64
 - DIG_Block_PG_Config, 3-64
 - DIG_Grp_Config, 3-65
 - DIG_Grp_Mode, 3-65
 - DIG_Grp_Status, 3-65
 - DIG_In_Grp, 3-65
 - DIG_Out_Grp, 3-65
 - DIG_SCAN_Setup, 3-65
 - DIG_Trigger_Config, 3-65
- groups of ports
 - DIO-24, AT-MIO-16D, AT-MIO-16DE-10, PC-DIO-96, and Lab and 1200 Series, 3-62
 - DIO-32F, 3-62 to 3-63
- mapping of byte to digital I/O lines (table), 3-60
- overview, 3-59 to 3-61
- DIG_Line_Config function, 3-64
- DIG_Out_Grp function, 3-65
- DIG_Out_Line function, 3-64
- DIG_Out_Port function, 3-64
- DIG_Prt_Config function, 3-64
- DIG_Prt_Status function, 3-64
- DIG_SCAN_Setup function, 3-65
- DIG_Trigger_Config function, 3-65
- DIO-24 groups of ports, 3-62
- DIO-32F
 - groups of ports, 3-62 to 3-63
 - pattern generation, 3-76 to 3-77
 - RTSI bus connections, 3-100
- DIO-32HS. *See* DIO 6533 (DIO-32HS).
- DIO-96 groups of ports, 3-62
- DIO 6533 (DIO-32HS)
 - groups of ports, 3-62 to 3-63
 - pattern generation, 3-76 to 3-77
 - RTSI connections, 3-100 to 3-102
- DMA transfers
 - AT bus computers, 4-2 to 4-4
 - definition, 4-1 to 4-2
 - devices using DMA transfers, 4-2
 - page boundaries in AT bus computers, 4-2 to 4-3
 - physical memory above 16 MB on ISA bus computers, 4-3 to 4-4
 - programmed I/O compared with, 4-2
 - Windows performance, 4-5 to 4-7
 - buffers requiring reprogramming, 4-5
 - DMA performance limitations, 4-6 to 4-7
 - eliminating DMA performance limitations, 4-6 to 4-7
 - limitations caused by reprogramming, 4-5 to 4-6
- DMA waveform generation with AT-MIO-16F-5, 3-55 to 3-57
 - counter usage, 3-57 to 3-58
 - FIFO lag effect, 3-58 to 3-59
 - restrictions on use of delay rate, 3-58
- documentation
 - conventions used in manual, *xiv-xvii*
 - how to use NI-DAQ manual set, *xiii*
 - National Instruments documentation, *xix-xx*
 - organization of manual, *xiii-xiv*
 - related documentation, *xx*
- double-buffered configuration functions, 5-9 to 5-12
 - DAQ_DB_Config, 3-25, 5-10
 - DIG_DB_Config, 3-65, 5-10
 - WFM_DB_Config, 5-10
- double-buffered data acquisition, 5-1 to 5-12
 - application hints, 3-33 to 3-34
 - input operations, 5-2 to 5-5
 - problem situations, 5-4 to 5-5
 - output operations, 5-6 to 5-9
 - problem situations, 5-7 to 5-9
 - overview, 5-1

single-buffered *versus* double-buffered data, 5-1 to 5-2

double-buffered data acquisition functions. *See also* low-level double-buffered data acquisition functions.

- DB_Config functions, 5-10
- DB_HalfReady functions, 5-11 to 5-12
- DB_Transfer function, 5-10 to 5-11

double-buffered digital I/O functions

- applications
 - double-buffered I/O, 3-77 to 3-78
 - group block I/O applications, 3-71 to 3-73
- DIG_DB_Config, 3-65, 5-10
- DIG_DB_HalfReady, 3-65, 5-11
- DIG_DB_Transfer, 3-66, 5-11

double-buffered waveform generation

- applications, 3-49 to 3-50

E

E series devices

- Calibrate_E_Series function, 3-4
- FIFO lag effect, 3-58 to 3-59
- list, xviii-xix
- RTSI bus connections, 3-99

EISA computer configuration, 1-11

electronic support services, A-1 to A-2

e-mail support, A-2

event counting, 3-88 to 3-91

- concatenated event counting, 3-90 to 3-91
- CTR_EvCount function, 3-79
- CTR_EvRead function, 3-79
- flow chart, 3-84
- frequency measurement, 3-89 to 3-90
- overview, 3-84
- pulse width measurement (figure), 3-89
- time-lapse measurement, 3-89
- timer event counting (figure), 3-88

event message functions. *See also* NI-DAQ events in Visual Basic for Windows.

- application hints, 3-5 to 3-6
- Config_Alarm_Deadband, 3-5
- Config_ATrig_Event_Message, 3-5
- Config_DAQ_Event_Message, 3-5
- example programs, 2-2, 2-5, 2-6, 2-8

EXTCONV* signal

- MIO-16/16D RTSI connections (table), 3-97
- MIO-F-5/16X RTSI connections (table), 3-98

external multiplexer support (AMUX-64T), 3-26

external triggering of waveform generation, 3-59

EXTTRIG* signal (table), 3-98

EXTUPD* signal (table), 3-99

EXTUPDATE* signal (table), 3-99

F

fax and telephone support numbers, A-2

Fax-on-Demand support, A-2

FIFO lag effect on MIO series, E series, AT-AO-6/10, AT-MIO-16X, and AT-MIO-64F-5, 3-58 to 3-59

FOUT signal

- MIO-16/16D RTSI connections (table), 3-97
- MIO-F-5/16X connections (table), 3-98

frequency measurement, 3-89 to 3-90

frequency output, counter/timer functions, 3-83

FTP support, A-1

functions

- analog input functions
 - one-shot analog input functions, 3-16 to 3-18
 - single-channel analog input application hints, 3-18 to 3-21
 - single-channel analog input functions, 3-16 to 3-18

- analog output functions
 - application hints, 3-38 to 3-40
 - list of functions, 3-37 to 3-38
 - counter/timer functions
 - application hints, 3-84 to 3-93
 - counter/timer operation, 3-80 to 3-83
 - device support, 3-78 to 3-79
 - list of functions, 3-79 to 3-80
 - programmable frequency output operation, 3-83
 - data acquisition functions
 - application hints, 3-26 to 3-36
 - double-buffered data acquisition
 - application hints, 3-33 to 3-34
 - high-level data acquisition functions, 3-21 to 3-22
 - low-level data acquisition functions, 3-23 to 3-25
 - low-level double-buffered data acquisition functions, 3-25
 - digital I/O function group, 3-59 to 3-66
 - application hints, 3-66 to 3-78
 - digital I/O functions, 3-63 to 3-64
 - digital line I/O applications, 3-68 to 3-69
 - DIO-24, AT-MIO-16D, AT-MIO-16DE-10, PC-DIO-96, and Lab and 1200 Series groups, 3-62
 - DIO-32 groups, 3-62 to 3-63
 - double-buffered digital I/O functions, 3-65 to 3-66
 - group digital I/O functions, 3-64 to 3-65
 - mapping of byte to digital I/O lines (table), 3-60
 - overview, 3-59 to 3-61
 - event message functions
 - application hints, 3-5 to 3-6
 - list of functions, 3-5
 - NI-DAQ events in Visual Basic for Windows, 3-6 to 3-16
 - initialization and general configuration functions, 3-2 to 3-3
 - interval counter/timer functions
 - application hints, 3-94
 - interval counter/timer operation, 3-93 to 3-94
 - list of functions, 3-93
 - list of function groups, 3-1 to 3-2
 - RTSI bus trigger functions
 - application hints, 3-102 to 3-103
 - AT-AO-6/10 RTSI connections, 3-99
 - devices with interface to RTSI bus trigger lines, 3-96
 - DIO-32F RTSI connections, 3-100
 - E series, 3-99
 - list of functions, 3-95 to 3-96
 - MIO-16/16D RTSI connections, 3-97
 - MIO-F-5/16X connections, 3-98
 - SCXI functions
 - application hints, 3-107 to 3-121
 - list of functions, 3-103 to 3-106
 - software-calibration and device-specific functions, 3-3 to 3-5
 - transducer conversion functions
 - function descriptions, 3-124 to 3-133
 - list of functions, 3-122 to 3-123
 - overview, 3-122 to 3-123
 - waveform generation functions
 - application hints, 3-43 to 3-50
 - high-level waveform generation functions, 3-41
 - low-level waveform generation functions, 3-41 to 3-43
- G**
- GATE1 signal
 - MIO-16/16D RTSI connections (table), 3-97

- MIO-F-5/16X connections (table), 3-98
- GATE2 signal (table), 3-99
- gating modes, Am9513-based MIO devices, 3-81 to 3-82
- General DAQ Event custom controls, 3-7 to 3-10
 - control properties (table), 3-8
 - examples, 3-14 to 3-16
- general-purpose counter/timer functions
 - application hints, 3-95
 - GPCTR_Change_Parameter, 3-94
 - GPCTR_Configure_Buffer, 3-95
 - GPCTR_Control, 3-95
 - GPCTR_Set_Application, 3-95
 - GPCTR_Watch, 3-95
- Get_DAQ_Device_Info function, 3-2
- Get_NI_DAQ_Version function, 3-2
- GPCTR_Change_Parameter function, 3-94
- GPCTR_Configure_Buffer function, 3-95
- GPCTR_Control function, 3-95
- GPCTR_Set_Application function, 3-95
- GPCTR_Watch function, 3-95
- group digital I/O applications
 - digital double-buffered group block I/O, 3-73 to 3-75
 - digital group block I/O, 3-71 to 3-73
 - digital group I/O, 3-70 to 3-71
- group digital I/O functions, 3-64 to 3-65
 - DIG_Block_Check, 3-64
 - DIG_Block_Clear, 3-64
 - DIG_Block_In, 3-64
 - DIG_Block_Out, 3-64
 - DIG_Block_PG_Config, 3-64
 - DIG_Grp_Config, 3-65
 - DIG_Grp_Mode, 3-65
 - DIG_Grp_Status, 3-65
 - DIG_In_Grp, 3-65
 - DIG_Out_Grp, 3-65
 - DIG_SCAN_Setup, 3-65
 - DIG_Trigger_Config, 3-65
- groups of ports

- DIO-24, AT-MIO-16D, AT-MIO-16DE-10, PC-DIO-96, and Lab and 1200 Series, 3-62
- DIO-32F, 3-62 to 3-63

H

- handshaking mode, 3-61
- handshaking *versus* no-handshaking digital I/O, 3-66
- hardware support (table), 1-4 to 1-5
- high-level data acquisition functions, 3-21 to 3-22
 - application hints. *See* data acquisition application hints.
 - DAQ_Op, 3-21 to 3-22
 - DAQ_to_Disk, 3-22
 - Lab_ISCAN_Op, 3-22
 - Lab_ISCAN_to_Disk, 3-22
 - SCAN_Op, 3-22
 - SCAN_to_Disk, 3-22
- high-level waveform generation functions, 3-41
 - WFM_from_Disk, 3-41
 - WFM_Op, 3-41

I

- ICTR_Read function, 3-93
- ICTR_Reset function, 3-93
- ICTR_Setup function, 3-93
- Init_DA_Brds function, 3-2
- initialization and general-configuration functions
 - Align_DMA_Buffer, 3-2
 - Get_DAQ_Device_Info, 3-2
 - Get_NI_DAQ_Version, 3-2
 - Init_DA_Brds, 3-2
 - Set_DAQ_Device_Info, 3-2
 - Timeout_Config, 3-3

- installation. *See also* device configuration.
 - before device configuration, 1-6 to 1-7
 - flowchart for setting up your system, 1-3
 - setting up your DAQ system, 1-2 to 1-3
 - interrupt latency in Windows
 - definition, 4-4
 - DMA performance, 4-5
 - programmed I/O performance, 4-5
 - interval counter/timer functions, 3-93 to 3-94
 - application hints, 3-94
 - device support, 3-78 to 3-79
 - ICTR_Read, 3-93
 - ICTR_Reset, 3-93
 - ICTR_Setup, 3-93
 - interval counter/timer operation, 3-93 to 3-94
 - See also* counter/timer operation.
 - block diagram, 3-94
 - ICTR functions, 3-93 to 3-94
 - application hints, 3-94
 - ISA bus computers
 - configuring, 1-11
 - page boundaries in AT bus computers, 4-2 to 4-3
 - using physical memory above 16 MB, 4-3 to 4-4
 - ISA devices, configuring, 1-9
- L**
- Lab and 1200 Series devices
 - counter usage in waveform generation, 3-57
 - data acquisition application hints, 3-26
 - groups of ports, 3-62
 - interval counter/timer operation, 3-93 to 3-94
 - Lab_ISCAN_Check function, 3-24
 - Lab_ISCAN_Op function, 3-22
 - Lab_ISCAN_Start function, 3-24
 - Lab_ISCAN_to_Disk function, 3-22
 - languages supported by NI-DAQ, 1-6
 - libraries, NI-DAQ, 2-1 to 2-2
 - low-level data acquisition functions, 3-23 to 3-25
 - application hints. *See* data acquisition application hints.
 - DAQ_Check, 3-23
 - DAQ_Clear, 3-23
 - DAQ_Config, 3-23
 - DAQ_Monitor, 3-23
 - DAQ_Rate, 3-23
 - DAQ_Set_Clock, 3-23
 - DAQ_Start, 3-23
 - DAQ_StopTrigger_Config, 3-24
 - DAQ_VScale, 3-24
 - Lab_ISCAN_Check, 3-24
 - Lab_ISCAN_Start, 3-24
 - SCAN_Demux, 3-24
 - SCAN_Sequence_Demux, 3-24, 3-35
 - SCAN_Sequence_Retrieve, 3-24, 3-35
 - SCAN_Sequence_Setup, 3-25, 3-35
 - SCAN_Setup, 3-25
 - SCAN_Start, 3-25
 - low-level double-buffered data acquisition functions, 3-25
 - application hints. *See* data acquisition application hints.
 - DAQ_DB_Config, 3-25, 5-10
 - DAQ_DB_HalfReady, 3-25, 5-11
 - DAQ_DB_Transfer, 3-25, 5-11
 - low-level waveform generation functions, 3-41 to 3-43
 - WFM_Chan_Control, 3-41, 3-58 to 3-59
 - WFM_Check, 3-41, 3-59
 - WFM_ClockRate, 3-42
 - WFM_DB_Config, 3-42
 - WFM_DB_HalfReady, 3-42, 5-11
 - WFM_DB_Transfer, 3-42, 5-11
 - WFM_Group_Control, 3-42
 - WFM_Group_Setup, 3-42
 - WFM_Load, 3-42 to 3-43
 - WFM_Rate, 3-43

WFM_Scale, 3-43
 WFM_Set_Clock, 3-43
 LPM devices. *See* PC-LPM-16.
 LPM16_Calibrate function, 3-4

M

manual. *See* documentation.
 memory above 16 MB on ISA bus computers,
 4-3 to 4-4
 Microsoft Visual Basic for Windows
 building Windows applications, 2-5 to 2-7
 buffer allocation, 2-6 to 2-7
 example programs, 2-6
 parameter passing, 2-7
 procedure, 2-5 to 2-6
 string passing, 2-7
 NI-DAQ events, 3-6 to 3-16
 Analog Alarm Event custom control,
 3-11 to 3-14
 Analog Trigger Event custom
 control, 3-10 to 3-11
 custom controls, 3-6 to 3-7
 General DAQ Event custom controls,
 3-7 to 3-10
 General DAQ Event example, 3-14
 to 3-16
 multiple controls, 3-13 to 3-14
 using multiple controls, 3-13 to 3-14
 special considerations, 2-6 to 2-7
 Microsoft Visual C++
 building Windows applications, 2-3 to 2-5
 example programs, 2-5
 MIO devices. *See also* Am9513-based MIO
 devices; specific AT-MIO devices.
 FIFO lag effect, 3-58 to 3-59
 generic terms for (table), *xvii-xix*
 MIO-16/16D
 counter usage in waveform
 generation, 3-57
 RTSI bus connections, 3-97

MIO-F-5/16X connections
 counter usage in waveform
 generation, 3-57
 RTSI bus connections, 3-98
 MIO_Calibrate function, 3-4
 MIO_Config function, 3-4
 MIO-E series devices. *See* E series devices.
 Multiplexed mode applications, SCXI, 3-108
 to 3-115
 multiplexer device (AMUX-64T), 3-26
 multiplex scanning
 flow chart for, 3-36
 functions for, 3-35
 purpose and use, 3-34 to 3-35

N

NI-DAQ Configuration Utility, 1-11
 NI-DAQ double buffering. *See*
 double-buffered data acquisition.
 NI-DAQ events in Visual Basic for Windows,
 3-6 to 3-16
 Analog Alarm Event custom control, 3-11
 to 3-14
 Analog Trigger Event custom control,
 3-10 to 3-11
 custom controls, 3-6 to 3-7
 General DAQ Event custom controls, 3-7
 to 3-10
 General DAQ Event example, 3-14
 to 3-16
 multiple controls, 3-13 to 3-14
 using multiple controls, 3-13 to 3-14
 NI-DAQ installation. *See* installation.
 NI-DAQ libraries for Windows, 2-1 to 2-2
 NI-DAQ software
 features, 1-1 to 1-2
 hardware support (table), 1-4 to 1-5
 language support, 1-6
 overview, 1-4 to 1-6
 NIDAQ32.DLL (note), 2-1

no-handshaking mode, 3-61
 non-plug and play devices, configuring, 1-11

O

one-shot analog input functions, 3-16 to 3-18
 AI_Change_Parameter, 3-17
 AI_Check, 3-17
 AI_Clear, 3-17
 AI_Configure, 3-17
 AI_Mux_Config, 3-17 to 3-18
 AI_Read, 3-18
 AI_Read_Scan, 3-18
 AI_Read_VScan, 3-18
 AI_Setup, 3-18
 AI_VRead, 3-18
 AI_VScale, 3-18
 application hints, 3-18 to 3-21
 one-shot analog output functions
 AO_Change_Parameter, 3-37
 AO_Configure, 3-37
 AO_Update, 3-37
 AO_VScale, 3-37 to 3-38
 AO_VWrite, 3-38
 AO_Write, 3-38
 application hints, 3-38 to 3-40
 OUT0* signal (table), 3-99
 OUT1 signal
 MIO-16/16D RTSI connections
 (table), 3-97
 MIO-F-5/16X connections (table), 3-98
 OUT1* signal (table), 3-99
 OUT2 signal
 MIO-16/16D RTSI connections
 (table), 3-97
 MIO-F-5/16X connections (table), 3-98
 OUT2* signal (table), 3-99
 OUT5 signal
 MIO-16/16D RTSI connections
 (table), 3-97
 MIO-F-5/16X connections (table), 3-98

P

page boundaries in AT bus computers, 4-2
 to 4-3
 Parallel mode applications, SCXI modules,
 3-115 to 3-119
 parallel port DAQ devices, configuring, 1-8
 parameter passing in Windows applications
 Borland C++, 2-3
 Microsoft Visual Basic, 2-7
 pattern generation I/O with DIO-32F and
 DAQDIO 6533 (DIO-32HS), 3-76 to 3-77
 PC AT/XT computers, configuring, 1-11
 PC (PCMCIA) cards, configuring, 1-7 to 1-8
 Windows 95, 1-8
 Windows NT 4.0, 1-7 to 1-8
 PC-DIO-24 groups of ports, 3-62
 PC-DIO-96 groups of ports, 3-62
 PCI/PXI devices, configuring, 1-9
 PCLK1 signal (table), 3-101
 PCLK2 signal (table), 3-101
 PC-LPM-16
 counter/timer signals, 3-26
 interval counter/timer operation, 3-93
 to 3-94
 LPM16_Calibrate function, 3-4
 PCMCIA cards, configuring, 1-7 to 1-8
 performance considerations, 4-1 to 4-7
 DMA on AT bus computers
 page boundaries in AT bus
 computers, 4-2 to 4-3
 using physical memory above 16 MB
 on ISA bus computers, 4-3 to 4-4
 programmed I/O performance, 4-2
 Windows, 4-4 to 4-7
 buffers requiring DMA
 reprogramming, 4-5
 DMA performance, 4-5 to 4-7
 eliminating DMA performance
 limitations, 4-6 to 4-7
 limitations caused by DMA
 reprogramming, 4-5 to 4-6

- programmed I/O performance, 4-5
- period and continuous pulse-width
 - measurement applications, 3-91 to 3-93
- plug and play devices, configuring, 1-8 to 1-11
 - Windows 95, 1-10
 - Windows NT 4.0
 - ISA devices, 1-9
 - PCI/PXI devices, 1-9
- programmable frequency output
 - operation, 3-83
- programmed I/O
 - definition, 4-1
 - devices using programmed I/O, 4-2
 - DMA compared with, 4-2
 - Windows performance, 4-5
- pulse generation
 - application hints, 3-84 to 3-85
 - CTR_Pulse function, 3-79
 - flow chart, 3-85
 - retriggerable one-shot pulse, 3-85
- pulse width measurement
 - event-counting application, 3-88 to 3-91
 - period and continuous pulse-width
 - measurement applications, 3-91 to 3-93

R

- reprogramming DMA. *See* DMA transfers.
- REQ1 signal
 - DIO-32F RTSI connections (table), 3-100
 - DIO 6533 RTSI connections
 - (table), 3-101
- REQ2 signal
 - DIO-32F RTSI connections (table), 3-100
 - DIO 6533 RTSI connections
 - (table), 3-101
- retriggerable one-shot pulse, 3-85
- RTD_Buf_Convert function, 3-124 to 3-125
- RTD_Convert function
 - definition, 3-122
 - purpose and use, 3-124 to 3-125

- RTSI bus
 - application hints, 3-102 to 3-103
 - description, 3-96
- RTSI bus connections, 3-97 to 3-102
 - AT-AO-6/10, 3-99
 - devices with interface for, 3-96
 - DIO-32F, 3-100
 - DIO 6533 (DIO-32HS), 3-100 to 3-102
 - E series, 3-99
 - MIO-16/16D devices, 3-97
 - MIO-F-5/16X, 3-98
- RTSI bus trigger functions
 - RTSI_Clear, 3-95
 - RTSI_Clock, 3-95
 - RTSI_Conn, 3-95
 - RTSI_DisConn, 3-96
 - Select_Signal, 3-96

S

- SCAN_Demux function, 3-24
- SCAN_Op function, 3-22
- SCAN_Sequence_Demux function, 3-24, 3-35
- SCAN_Sequence_Retrieve function, 3-24, 3-35
- SCAN_Sequence_Setup function, 3-25, 3-35
- SCAN_Setup function, 3-25
- SCAN_Start function, 3-25
- SCAN_to_Disk function, 3-22
- SCXI application hints, 3-107 to 3-121
 - analog output applications, 3-121
 - data acquisition rates, 3-119 to 3-121
 - digital applications, 3-122
 - general SCXIBus application
 - flowchart, 3-107
 - Multiplexed mode, 3-108 to 3-115
 - Parallel mode, 3-115 to 3-119
 - settling rates (table), 3-121
 - settling times (table), 3-120

- SCXI functions, 3-103 to 3-106
 - SCXI_AO_Write, 3-103
 - SCXI_Cal_Constants, 3-103
 - SCXI_Calibrate_Setup, 3-103 to 3-104
 - SCXI_Change_Chan, 3-104
 - SCXI_Configure_Filter, 3-104
 - SCXI_Get_Chassis_Info, 3-104
 - SCXI_Get_Module_Info, 3-104
 - SCXI_Get_State, 3-104
 - SCXI_Get_Status, 3-104
 - SCXI_Load_Config, 3-107
 - SCXI_ModuleID_Read, 3-105
 - SCXI_MuxCtr_Setup, 3-105
 - SCXI_Reset, 3-105
 - SCXI_Scale, 3-105
 - SCXI_SCAN_Setup, 3-105
 - SCXI_Set_Config, 3-105 to 3-106
 - SCXI_Set_Gain, 3-106
 - SCXI_Set_Input_Mode, 3-106
 - SCXI_Set_State, 3-106
 - SCXI_Set_Threshold, 3-106
 - SCXI_Single_Chan_Setup, 3-106
 - SCXI_Track_Hold_Control, 3-106
 - SCXI_Track_Hold_Setup, 3-106
- Select_Signal function, 3-4 to 3-5, 3-96
- sequence list, in staging-based arbitrary waveform generation, 3-51
- Set_DAQ_Device_Info function, 3-2
- setting up DAQ systems. *See* device configuration; installation.
- simultaneous counter operations (figure), 3-87
- single-buffered *versus* double-buffered data, 5-1 to 5-2
- single-channel analog input functions, 3-16 to 3-18
 - AI_Change_Parameter, 3-17
 - AI_Check, 3-17
 - AI_Clear, 3-17
 - AI_Configure, 3-17
 - AI_Mux_Config, 3-17 to 3-18
 - AI_Read, 3-18
 - AI_Read_Scan, 3-18
 - AI_Read_VScan, 3-18
 - AI_Setup, 3-18
 - AI_VRead, 3-18
 - AI_VScale, 3-18
 - application hints, 3-18 to 3-21
- software-calibration and device-specific functions, 3-3 to 3-5
 - AO_Calibrate, 3-3
 - Calibrate_1200, 3-3 to 3-4
 - Calibrate_DSA, 3-4
 - Calibrate_E_Series, 3-4
 - Configure_HW_Analog_Trigger, 3-4
 - LPM16_Calibrate, 3-4
 - MIO_Calibrate, 3-4
 - MIO_Config, 3-4
 - SCXI_Cal_Constants, 3-103
 - SCXI_Calibrate_Setup, 3-103 to 3-104
 - Select_Signal, 3-4 to 3-5
- SOURCE5 signal
 - MIO-16/16D RTSI connections (table), 3-97
 - MIO-F-5/16X connections (table), 3-98
- square wave generation functions, 3-85 to 3-86
- staging-based arbitrary waveform generation, 3-51 to 3-59
 - counter usage, 3-57 to 3-58
 - DMA waveform generation with AT-MIO-16F-5, 3-55 to 3-56
 - external triggering, 3-59
 - FIFO lag effect, 3-58 to 3-59
 - flow chart, 3-53
 - minimum update intervals, 3-55
 - reference voltages for analog output devices
 - bipolar output polarity (table), 3-54 to 3-55
 - unipolar output polarity (table), 3-54
 - restrictions on use of delay rate, 3-58
 - steps in, 3-51 to 3-53
- START TRIG* signal (table), 3-97

STOP TRIG signal (table), 3-97
 STOPTRIG1 signal (table), 3-101
 STOPTRIG2 signal (table), 3-101
 Strain_Buf_Convert function, 3-126 to 3-128
 Strain_Convert function
 definition, 3-123
 purpose and use, 3-126 to 3-128
 string passing in Windows applications
 Borland C++, 2-3
 Microsoft Visual Basic, 2-7

T

technical support, A-1 to A-2
 telephone and fax support numbers, A-2
 Thermistor_Buf_Convert function, 3-129 to 3-131
 Thermistor_Convert function
 definition, 3-123
 purpose and use, 3-129 to 3-131
 Thermocouple_Buf_Convert function, 3-129 to 3-131
 Thermocouple_Convert function
 definition, 3-123
 purpose and use, 3-131 to 3-133
 time-lapse measurement, 3-89
 Timeout_Config function, 3-3
 transducer conversion functions, 3-122 to 3-133
 overview, 3-122 to 3-123
 RTD_Buf_Convert, 3-124 to 3-125
 RTD_Convert, 3-122, 3-124 to 3-125
 Strain_Buf_Convert, 3-126 to 3-128
 Strain_Convert, 3-123, 3-126 to 3-128
 Thermistor_Buf_Convert, 3-129 to 3-131
 Thermistor_Convert, 3-123, 3-129 to 3-131
 Thermocouple_Buf_Convert, 3-131 to 3-133
 Thermocouple_Convert, 3-123, 3-131 to 3-133

V

Visual Basic. *See* Microsoft Visual Basic for Windows.

W

waveform generation application hints, 3-43 to 3-50
 basic applications, 3-43 to 3-45
 basic waveform generation with pauses, 3-46 to 3-48
 counter usage, 3-57 to 3-58
 DMA waveform generation with AT-MIO-16F-5, 3-55 to 3-56
 double-buffered applications, 3-49 to 3-50
 external triggering, 3-59
 FIFO lag effect, 3-58 to 3-59
 minimum update intervals, 3-55
 reference voltages for analog output devices (table), 3-54 to 3-55
 restrictions on use of delay rate, 3-58
 staging-based arbitrary waveform generation, 3-51 to 3-59
 counter usage, 3-57 to 3-58
 DMA waveform generation with AT-MIO-16F-5, 3-55 to 3-56
 external triggering, 3-59
 FIFO lag effect, 3-58 to 3-59
 flow chart, 3-53
 minimum update intervals, 3-55
 reference voltages for analog output devices
 bipolar output polarity (table), 3-54 to 3-55
 unipolar output polarity (table), 3-54
 restrictions on use of delay rate, 3-58
 steps in, 3-51 to 3-53

- waveform generation functions, 3-41 to 3-43
 - high-level waveform generation functions, 3-41
 - WFM_from_Disk, 3-41
 - WFM_Op, 3-41
 - low-level waveform generation functions, 3-41 to 3-43
 - WFM_Chan_Control, 3-41, 3-58 to 3-59
 - WFM_Check, 3-41, 3-59
 - WFM_ClockRate, 3-42
 - WFM_DB_Config, 3-42, 5-10
 - WFM_DB_HalfReady, 3-42, 5-11
 - WFM_DB_Transfer, 3-42, 5-11
 - WFM_Group_Control, 3-42
 - WFM_Group_Setup, 3-42
 - WFM_Load, 3-42 to 3-43
 - WFM_Rate, 3-43
 - WFM_Scale, 3-43
 - WFM_Set_Clock, 3-43
- WFM_Chan_Control function, 3-41, 3-58 to 3-59
- WFM_Check function, 3-41, 3-59
- WFM_ClockRate function, 3-42
- WFM_DB_Config function, 3-42, 5-10
- WFM_DB_HalfReady function, 3-42, 5-11
- WFM_DB_Transfer function, 3-42, 5-11
- WFM_from_Disk function, 3-41
- WFM_Group_Control function, 3-42
- WFM_Group_Setup function, 3-42
- WFM_Load function, 3-42 to 3-43
- WFM_Op function, 3-41
- WFM_Rate function, 3-43
- WFM_Scale function, 3-43
- WFM_Set_Clock function, 3-43

Windows

- building applications, 2-1 to 2-9
 - Borland C++, 2-2 to 2-3
 - Microsoft Visual Basic, 2-5 to 2-7
 - Microsoft Visual C++, 2-3 to 2-5
 - NI-DAQ examples, 2-8 to 2-9
 - NI-DAQ libraries, 2-1 to 2-2
- PC Card configuration
 - Windows 95, 1-8
 - Windows NT 4.0, 1-7 to 1-8
- performance considerations
 - DMA performance, 4-5 to 4-7
 - eliminating DMA performance limitations, 4-6 to 4-7
 - general performance considerations, 4-4 to 4-7
 - limitations caused by DMA reprogramming, 4-5 to 4-6
 - programmed I/O performance, 4-5
 - results of DMA performance limitation, 4-6
- plug and play device configuration
 - Windows 95, 1-10
 - Windows NT 4.0
 - ISA devices, 1-9
 - PCI/PXI devices, 1-9